



the
abdus salam
international centre for theoretical physics

ICTP 40th Anniversary

SMR 1564 - 35

SPRING COLLEGE ON SCIENCE AT THE NANOSCALE
(24 May - 11 June 2004)

SEMICONDUCTORS; DEVICES

Cherie R. KAGAN
I.B.M. Thomas J. Watson Research Centre
Yorktown Heights, NY, U.S.A.

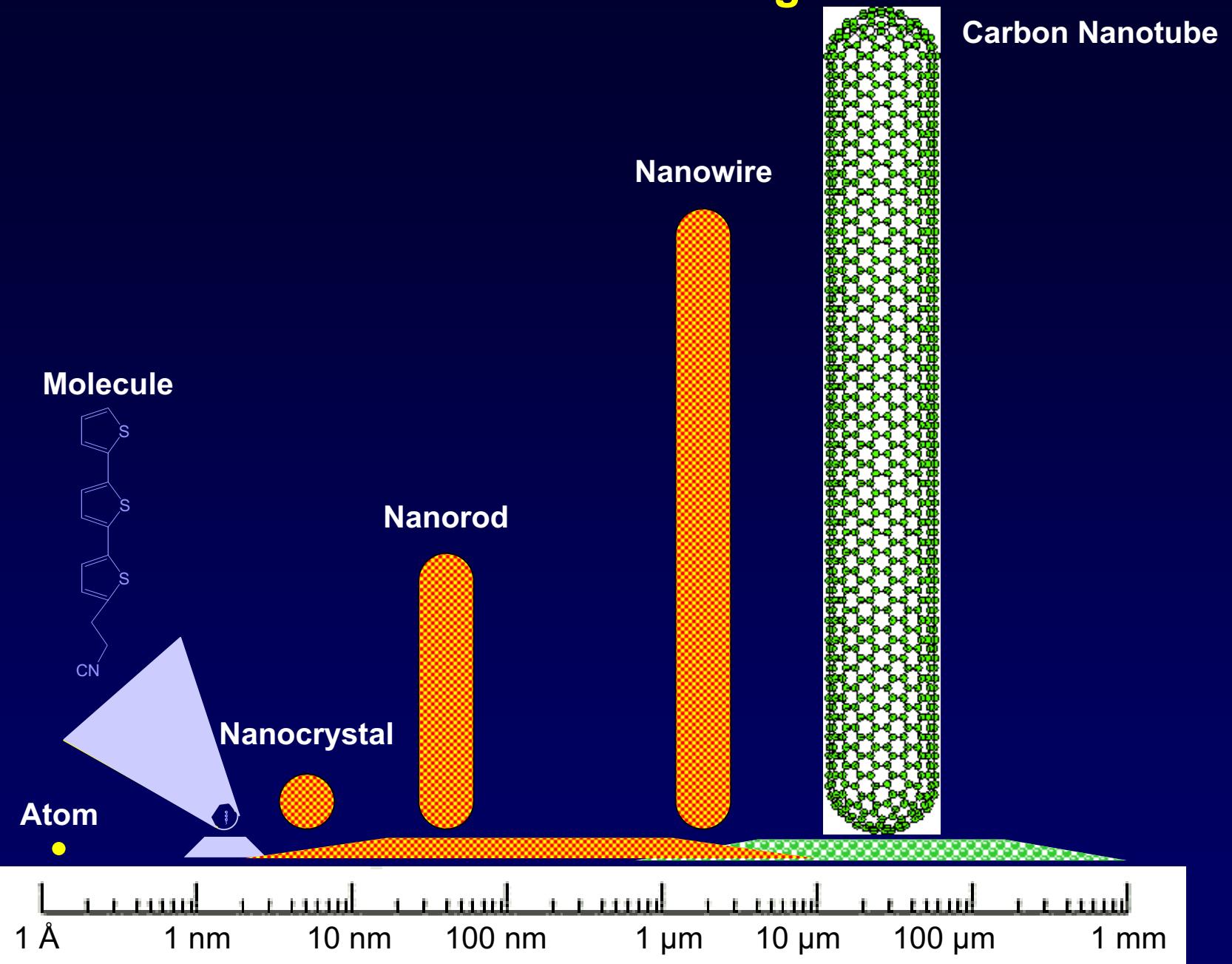
These are preliminary lecture notes, intended only for distribution to participants.

Making Electrical Contact to Molecules

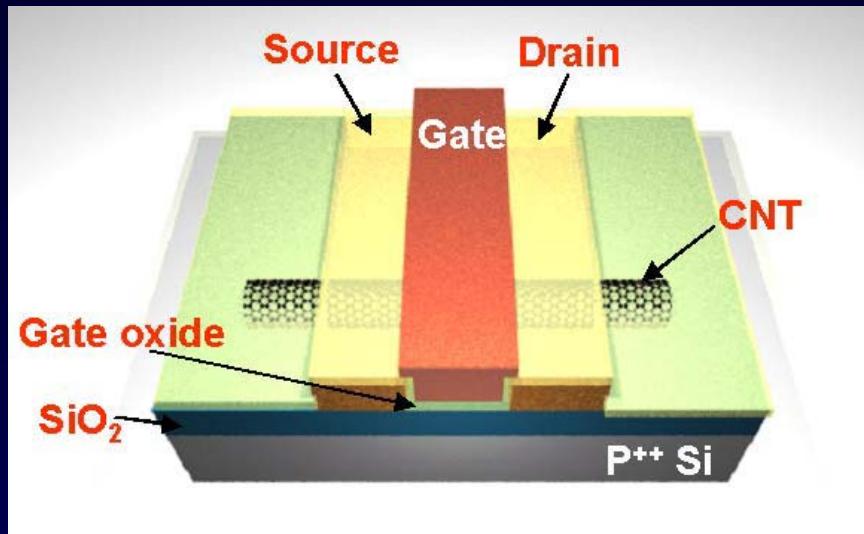
Cherie R. Kagan

**IBM T. J. Watson Research Center
Yorktown Heights, NY**

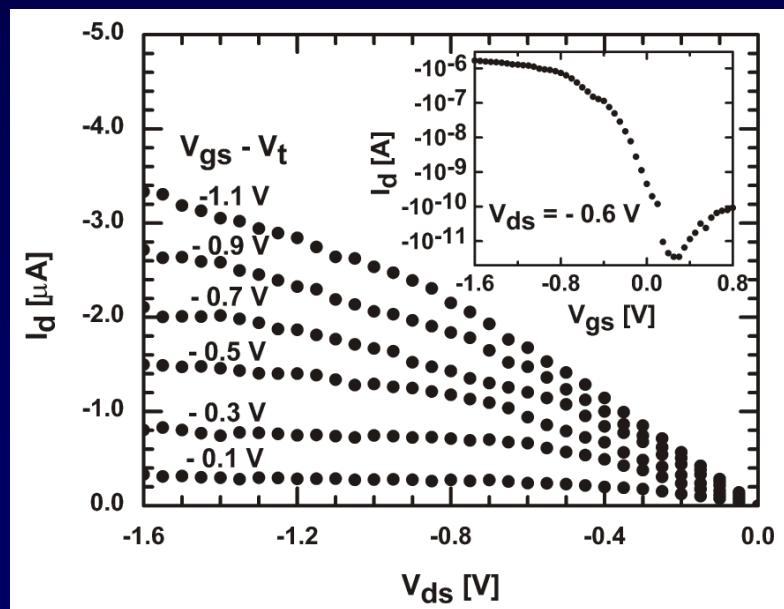
On The Size of Things



Carbon Nanotube Transistor



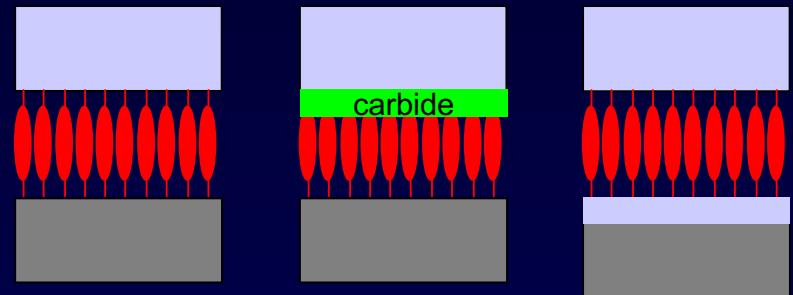
- Channel Length is 300 nm
- Oxide fabricated on top of CNT



S.J. Wind, J. Appenzeller, R. Martel, and Ph. Avouris, *Appl. Phys. Lett.* **80** 3817 (2002).

Challenges in Fabricating Molecular Junctions Vertical Structures

Local Challenges

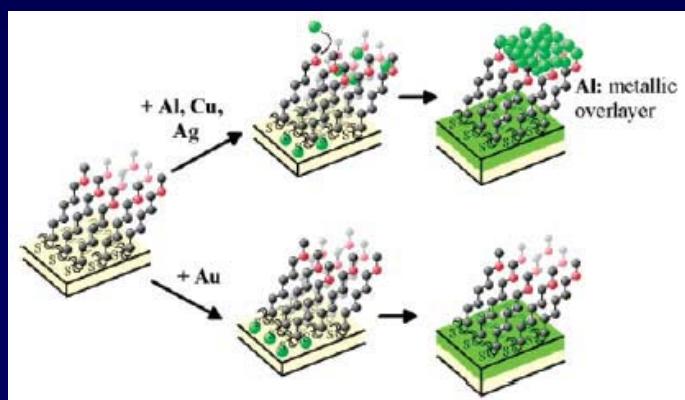


Idealized Structure

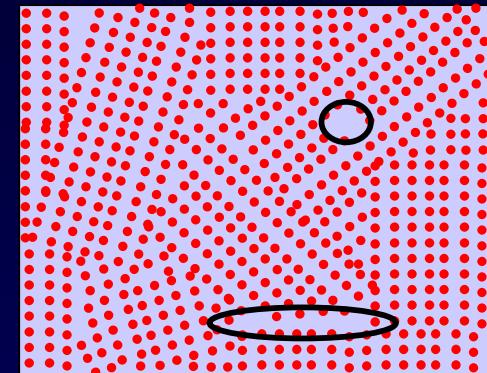
Reactive Metal
(Ti)

Middle of the
road Metal
Al, Cu, Ag

Unreactive Metal
(Au)



Global Challenges



Metal penetration
through defects in
monolayers

- domain boundaries
- voids

A. V. Walker, T. B. Tighe, O. M. Cabarcos, M. D. Reinard, B. C. Haynie, S. Uppili, N. Winograd, D. L. Allara, *J. Am. Chem. Soc.* **126**, 3954 (2004).

Challenges in Fabricating Molecular Junctions: Lateral Geometry



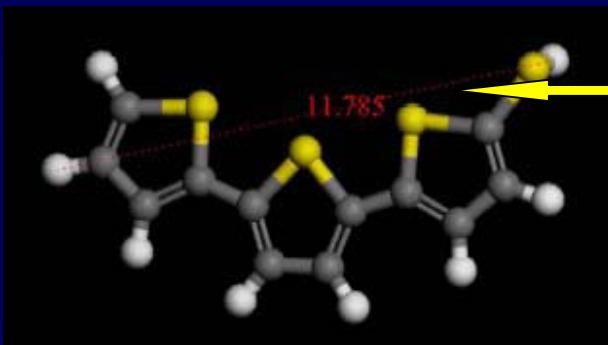
α -terthiophene thiol

rotated



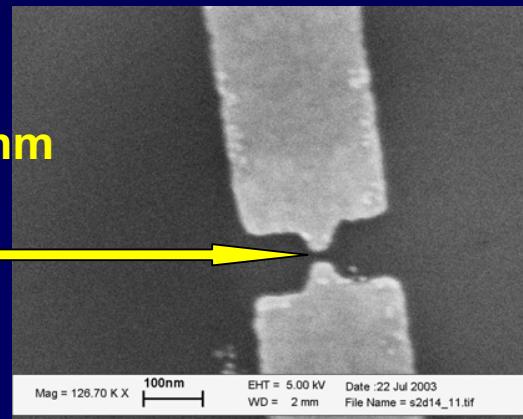
molecule's planarity provides:
good π -overlap, conductivity
rigidity, reducing solubility

distance



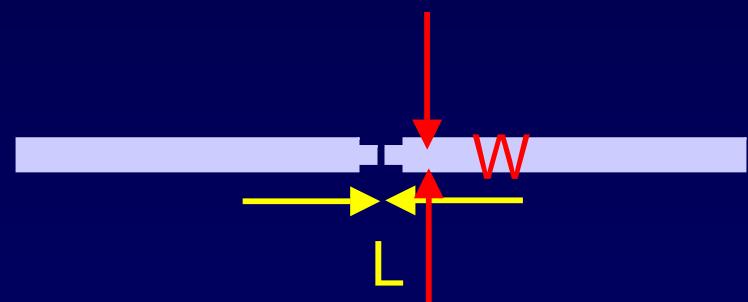
~ 1.2 nm
 ~ 17 nm

Limits length of molecule



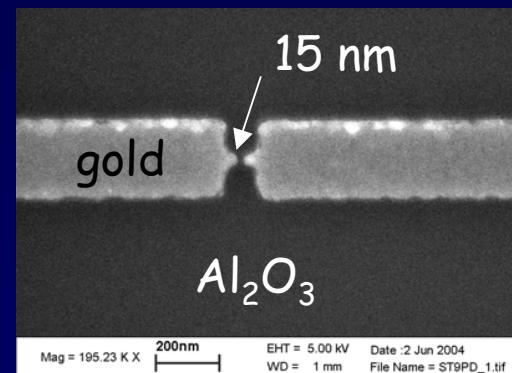
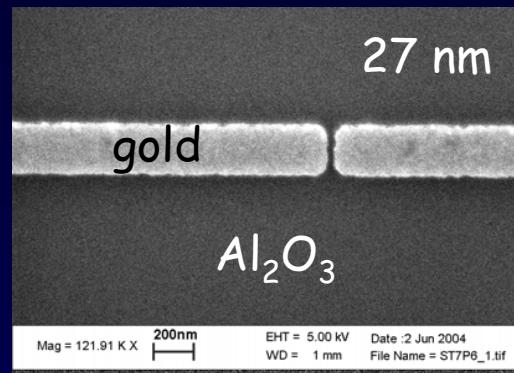
Limitations of e-beam Lithography

Design



As L is narrowed, W must be reduced to achieve lift-off

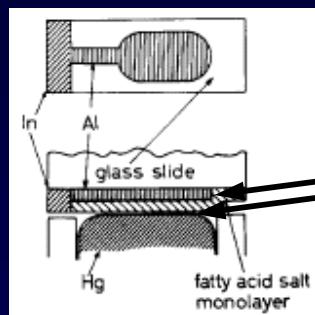
Product



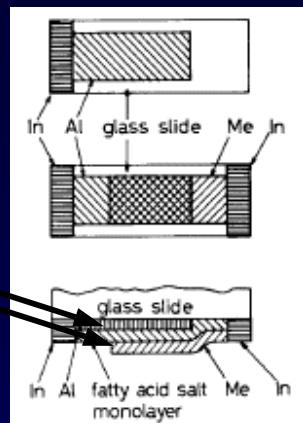
First Examples of Transport Measurements in Molecular Junctions

Kuhn – 1971

Tunneling through Fatty Acids



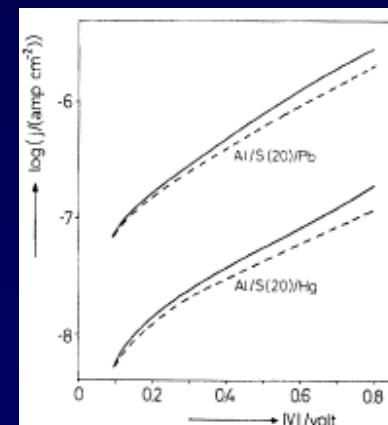
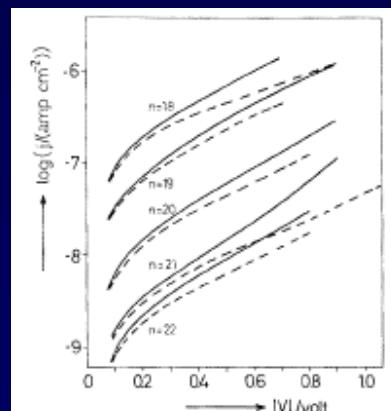
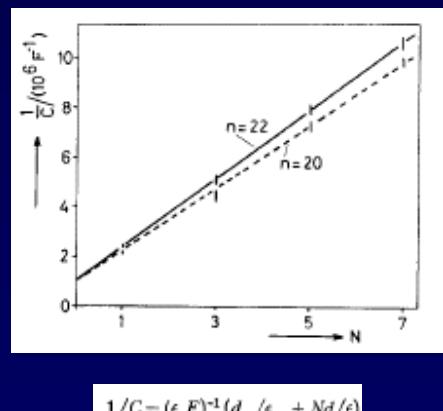
native oxide layer



Fatty acids: $\text{CH}_3(\text{CH}_2)_n\text{COOH}$

Metal Salts, example:
 $[\text{CH}_3(\text{CH}_2)_n\text{COOH}]_2\text{Cd}$

Metal: Pb, Al, Ag, Au



$$\sigma_t = (\sigma^2 / h^3) (2m\varphi)^{1/2} \exp[-(2d/h)(2m\varphi)^{1/2}]$$

(for small voltages V),

$$\sigma_t = (e^3 V / 8\pi h \varphi d) \exp[-(4d/3eVh)(2m\varphi^3)^{1/2}]$$

(for large voltages V),

Note: For Ag, Au comment on care not to overheat monolayer during evaporation

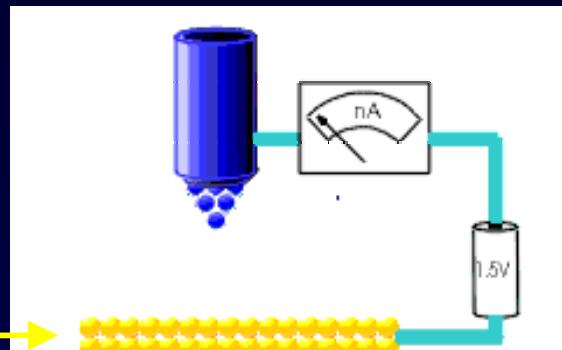
B. Mann, H. Kuhn, J. Appl. Phys. **42**, 4398 (1971).

Scanning Tunneling Microscopy of Molecular Assemblies

Map density of states

Not measure of
molecular conductance

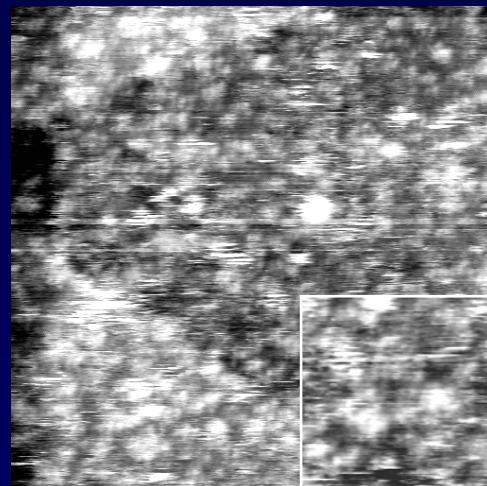
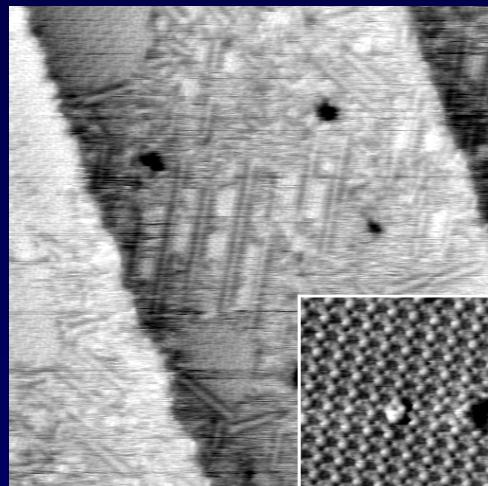
Metal



$d_{\text{tip-sample}} \leq 10 \text{ \AA}$

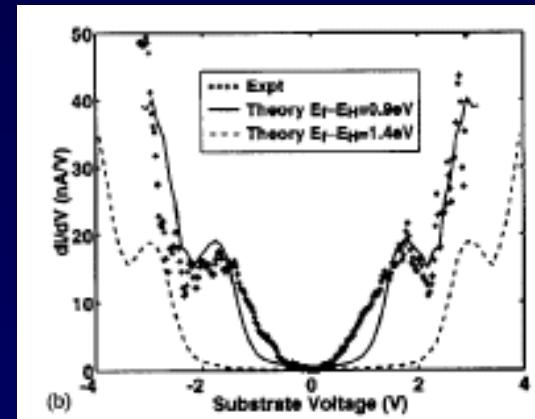
$$I \propto \exp\left(\frac{2\sqrt{2m\Phi}\hbar}{d}\right)$$

Ordered versus Dis-ordered Assembly
hexanethiol 1,1'-biphenyl-4,4'-dithiol



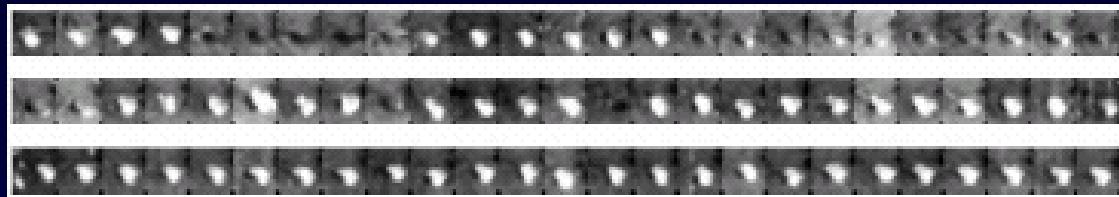
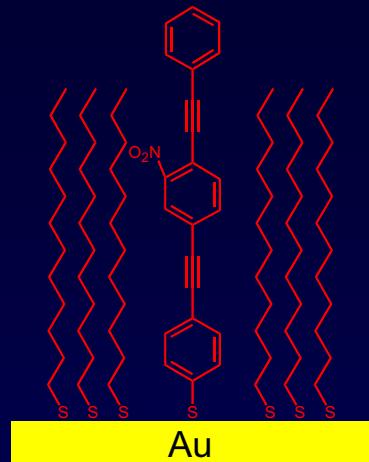
C. R. Kagan, A. Afzali, R. Martel, L. M. Gignac, P. M. Solomon, A. G. Schrott, B. Ek, *Nano Letters*, 3, 119 (2003).

Spectroscopy
 α,α' -xylyl dithiol



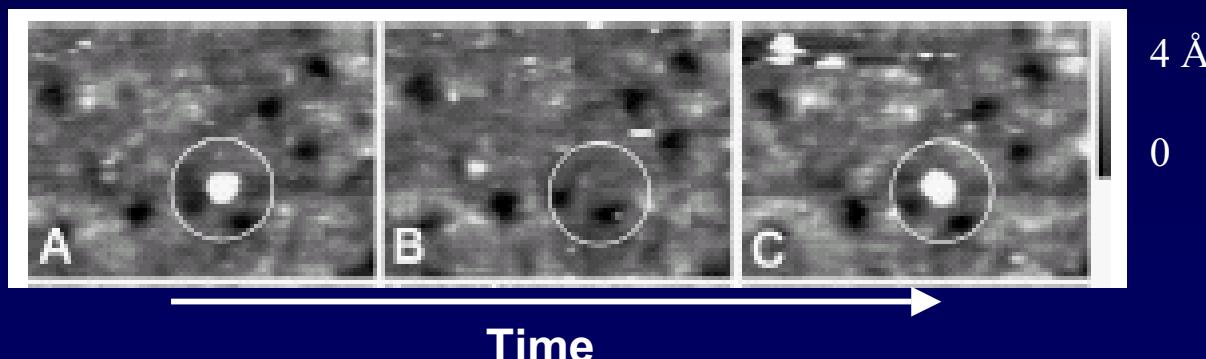
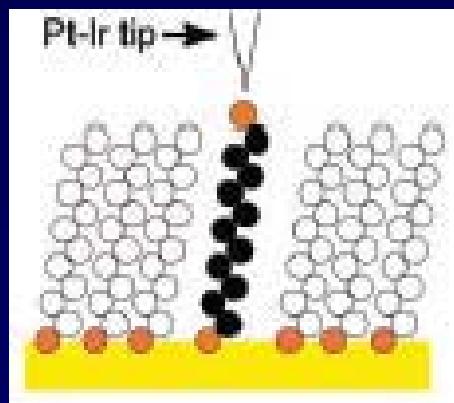
W. Tian, S. Datta, S. Hong, R. Reifenberger, J. I. Henderson, C. P. Kubiak, *J. Chem. Phys.* **109**, 2874 (1998).

Scanning Tunneling Microscopy: Stochastic Switching in Assembled Molecules



Time interval between frames 6 min.

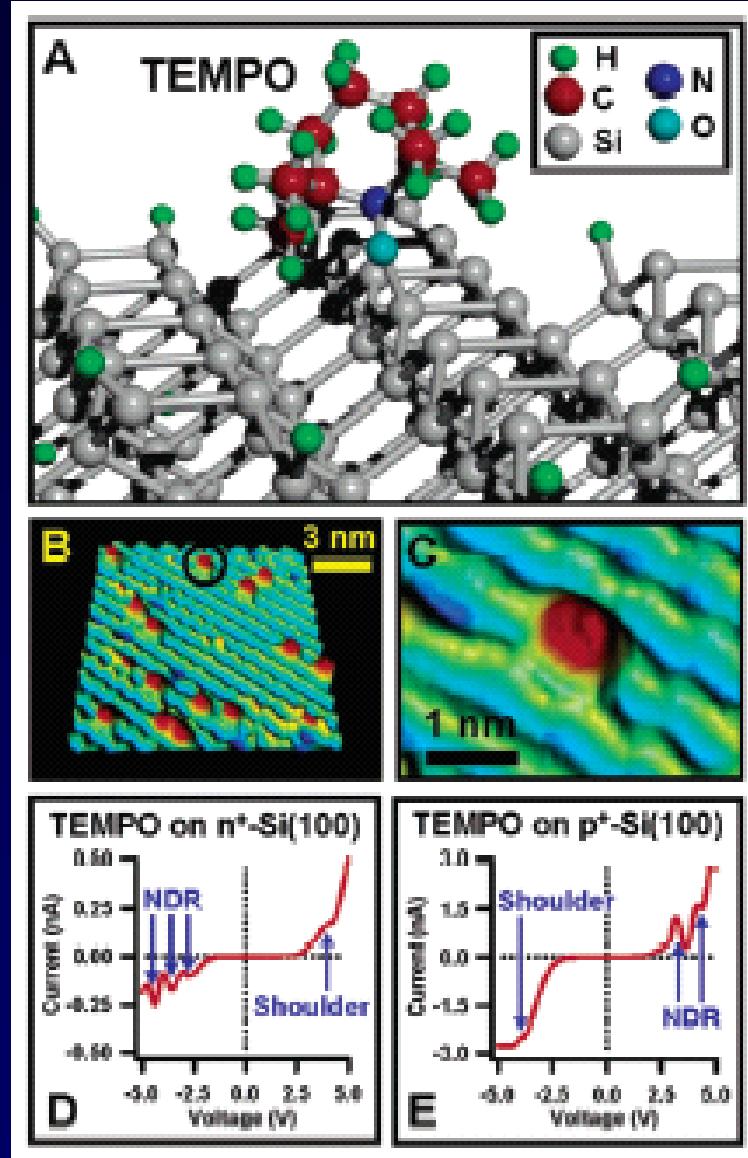
Z. J. Donhauser, B. A. Mantooth, K. F. Kelly, L. A. Bumm, J. D. Monnell, J. J. Stapleton, D. W. Price Jr., A. M. Rawlett, D. L. Allara, J. M. Tour, P. S. Weiss, *Science* **292**, 2303 (2001).



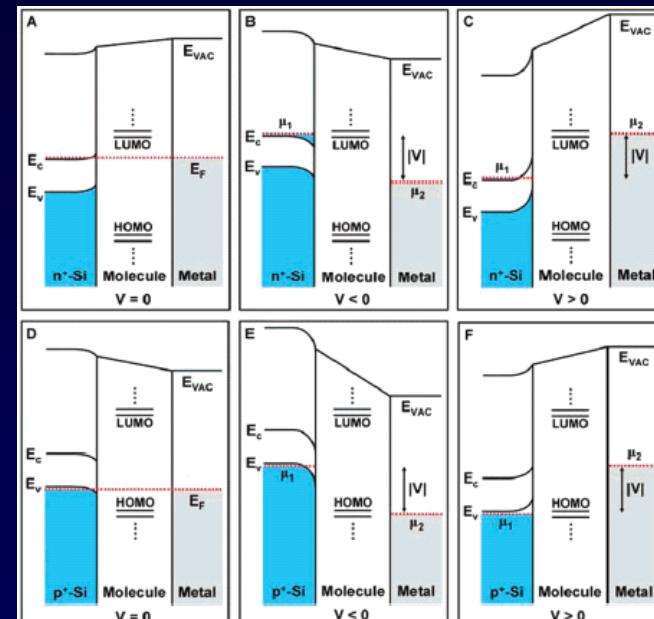
G. K. Ramachandran, T. J. Hopson, A. M. Rawlett, L. A. Nagahara, A. Primak, S. M. Lindsay, *Science* **300**, 1413 (2003).

Stochastic switching – arise from Au-S bond breaking?

STM Measurements of Molecules on Si

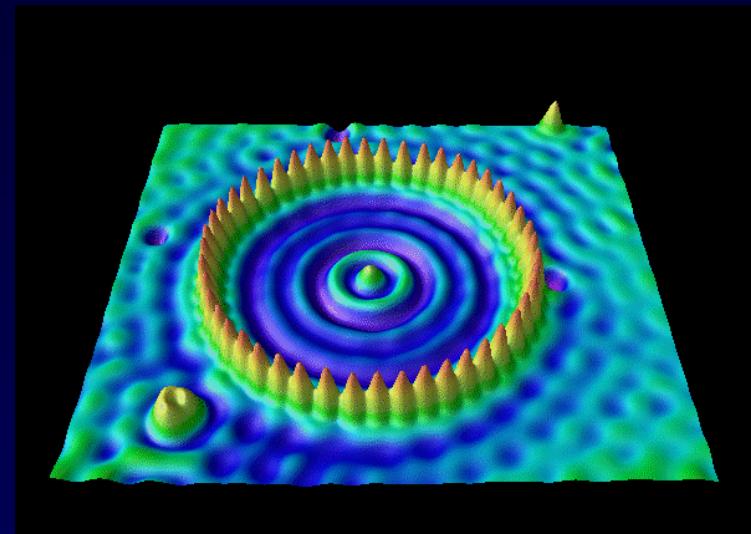
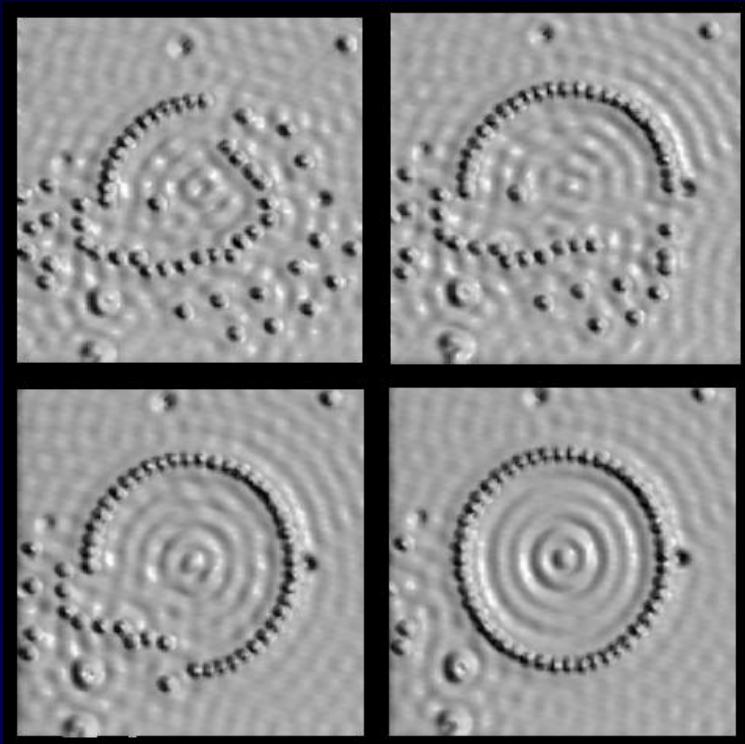


- NDR when molecular levels cross Si band edge
- Shoulder when molecular levels cross metal Fermi level



N. P. Guisinger, M. E. Greene, R. Basu, A. S. Baluch, M. C. Hersam, *Nano Lett.* **4**, 55 (2004).

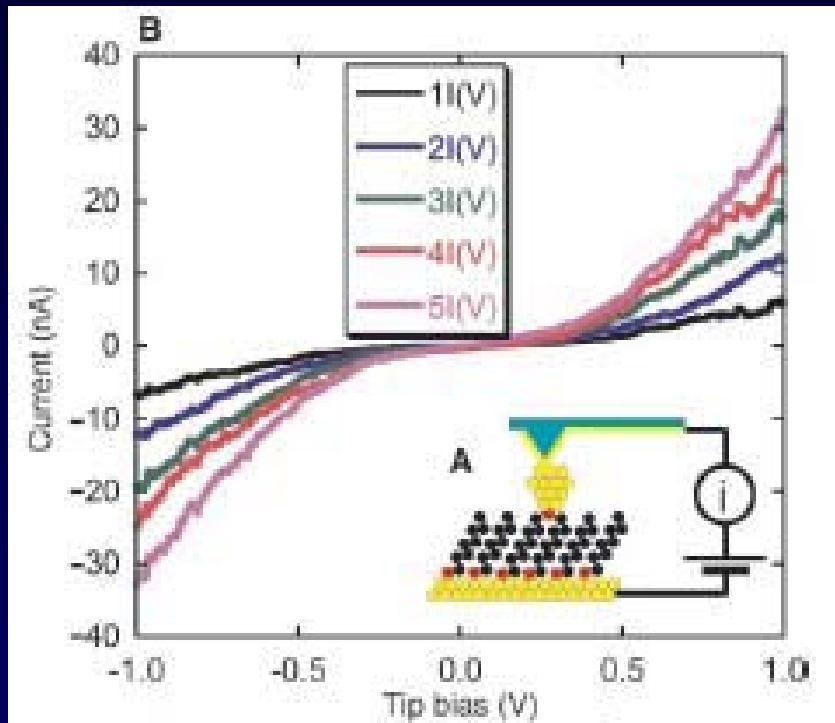
Scanning Tunneling Microscopy of Atoms



Fe adatoms on Cu (111)

M.F. Crommie, C.P. Lutz, D.M. Eigler. *Science* **262**, 218-220 (1993).

Conductive Probe AFM

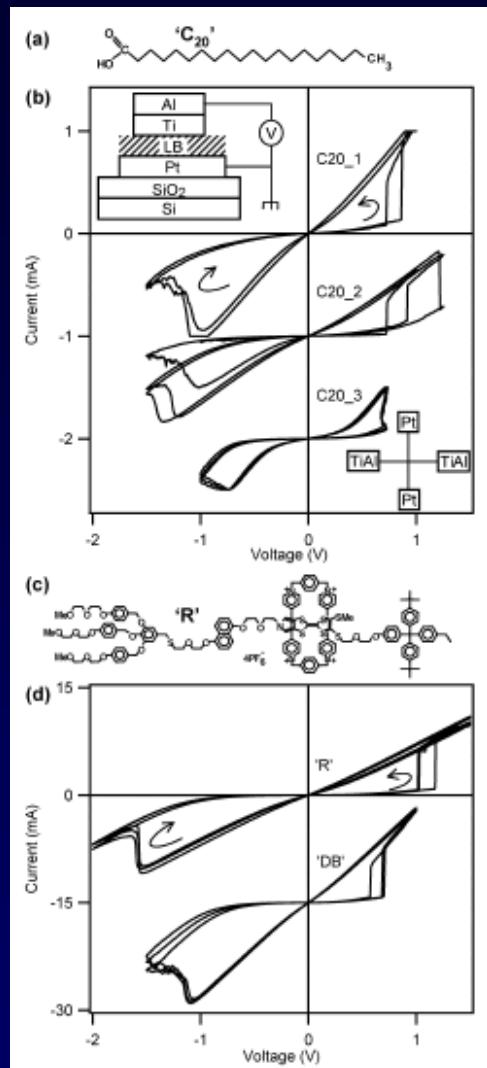


Two physical contacts allows measurements of conductance

Metal nanocrystal makes “better” contact through covalent bond to S atom on molecule and provides more reliable contact as it is not as dependent on applied force

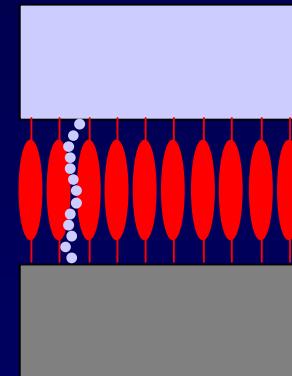
X. D. Cui, A. Primak, X. Zarate, J. Tomfohr, O. F. Sankey, A. L. Moore, T. A. Moore, D. Gust, G. Harris, S. M. Lindsay, *Science* **294**, 571 (2001).

Metal-Molecule-Metal Sandwiches/Crossbars



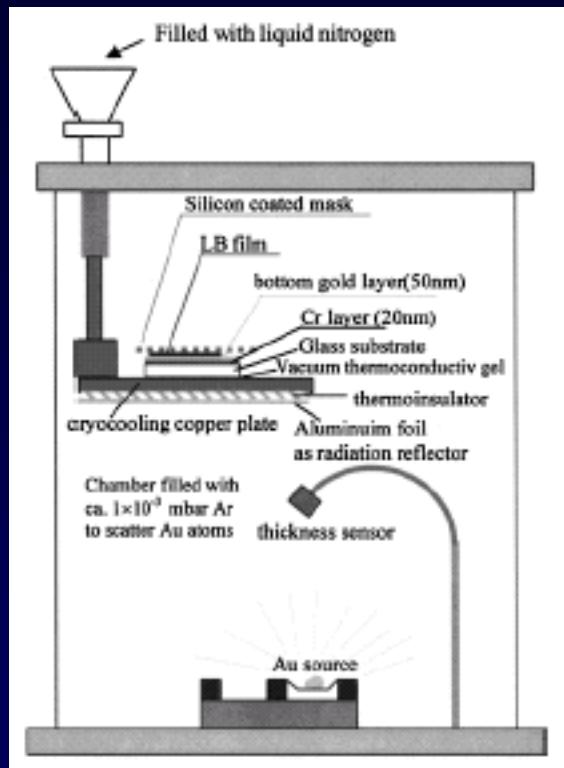
I-V characteristics are independent of the molecular chemistry

Metal filament formation?
Known to give similar characteristics even in thin organic and oxide films for ~40 years

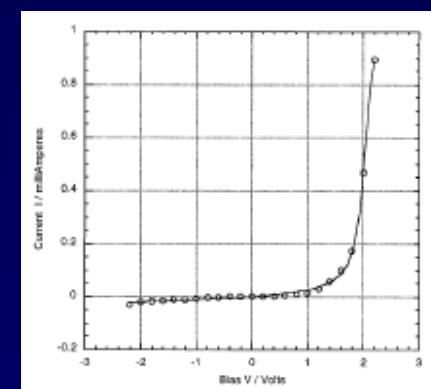
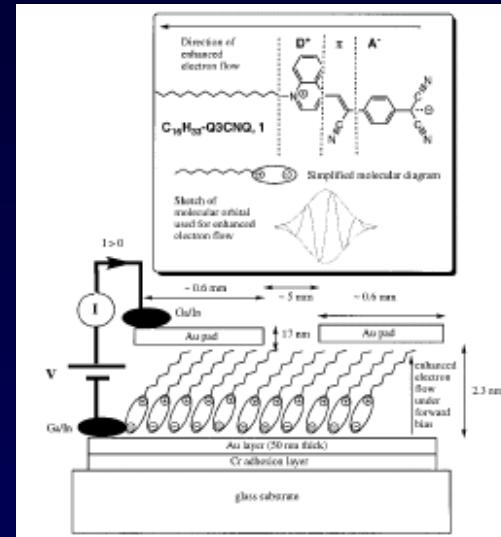


D. R. Stewart, D. A. A. Ohlberg, P. A. Beck, Y. Chen, and R. Stanley Williams, J. O. Jeppesen, K. A. Nielsen, J. Fraser Stoddart, *Nano Lett.* **4**, 133 (2004).

Cold-Gold Evaporation: Metal-Molecule-Metal Rectifying Junctions

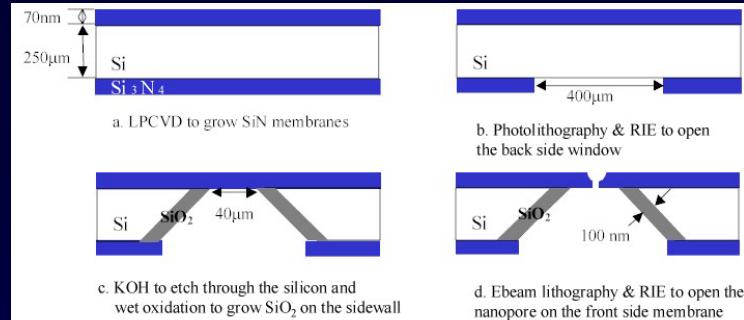


Langmuir-Blodgett monolayer of
hexadecylquinolinium tricyanoquinodimethane

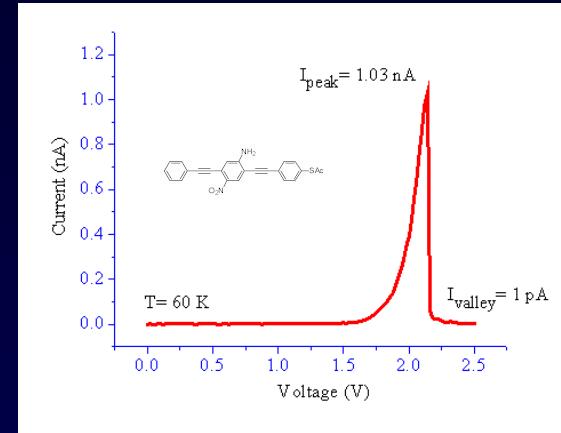


R. M. Metzger, T. Xu, I. R. Peterson, *J. Chem. Phys. B* **105**, 7280 (2001).

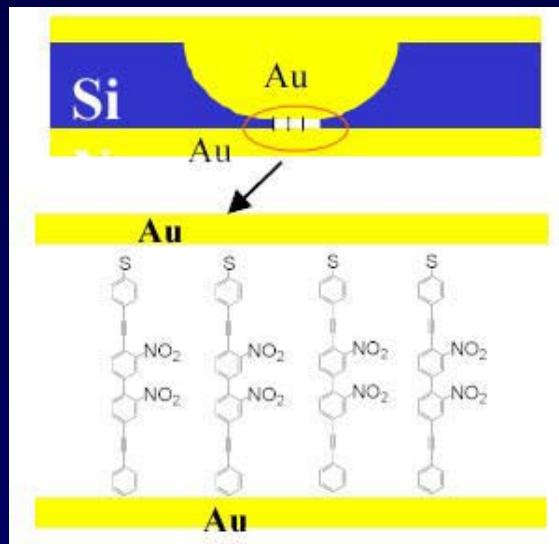
Nanopore Geometry



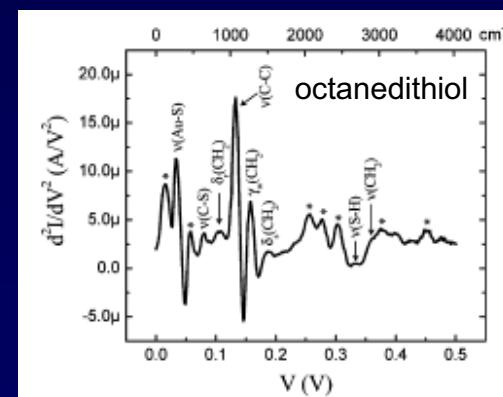
M. A. Reed, Yale University



J. Chen, M. A. Reed, A. M. Rawlett, J. M. Tour, *Science* **286**, 1550 (1999).



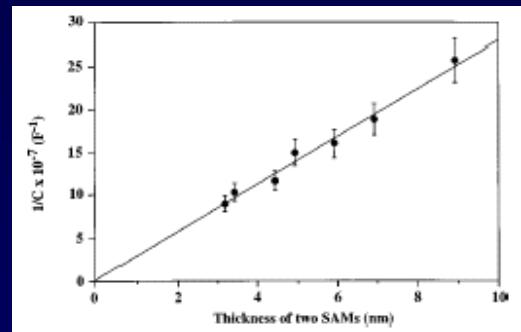
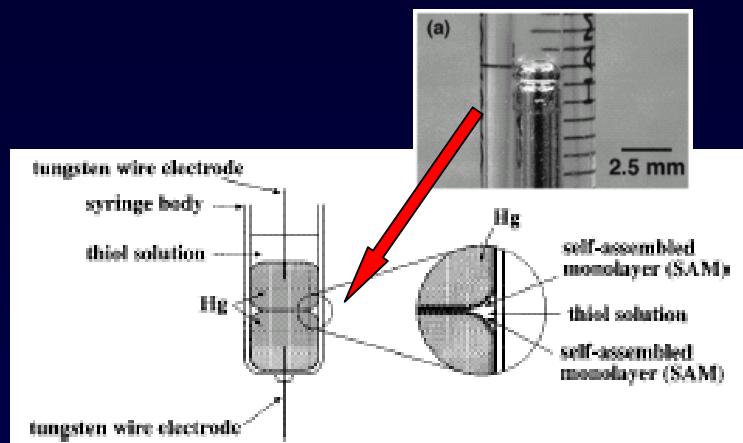
Decrease probed area to small ~ 30 nm dimension to reduce the probability of defects



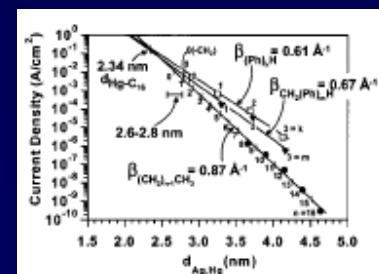
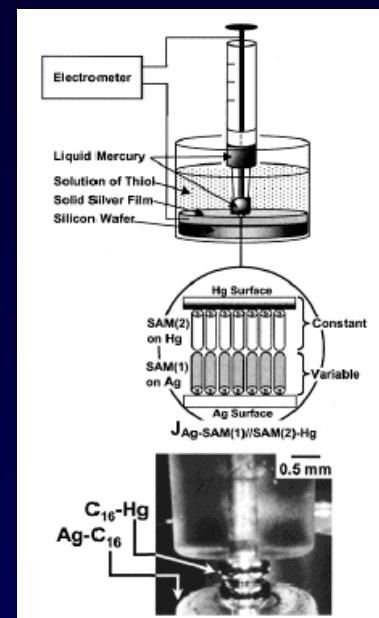
W. Wang, T. Lee, I. Kretzschmar, M. A. Reed, *Nano Lett.* **4**, 634 (2004).

Using Hg as an Electrode

Hg-SAM/SAM-Hg Junctions



Hg-SAM/SAM-Au or Ag Junctions



$$I \cong I_0 [e^{-\beta(1)d_{\text{SAM}(1)}}] [e^{-\beta(2)d_{\text{SAM}(2)}}]$$

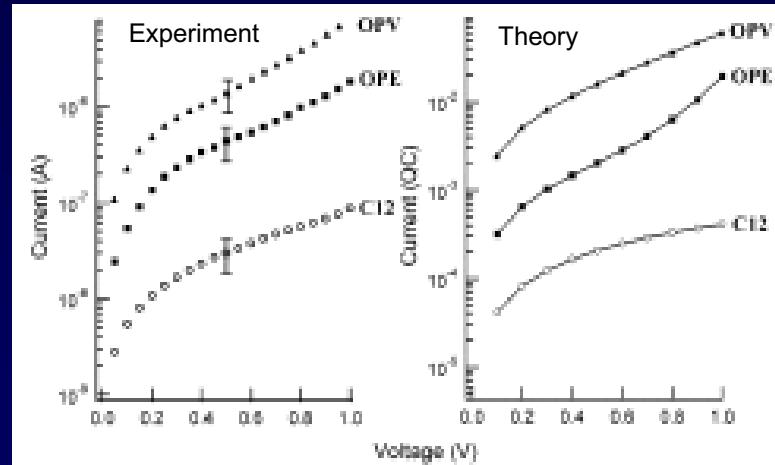
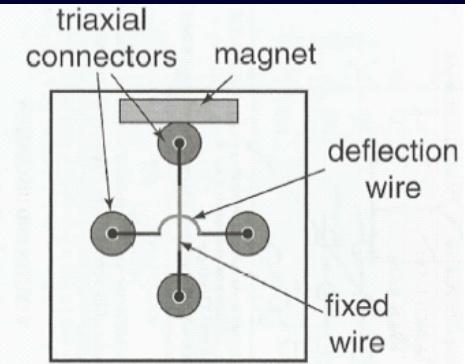
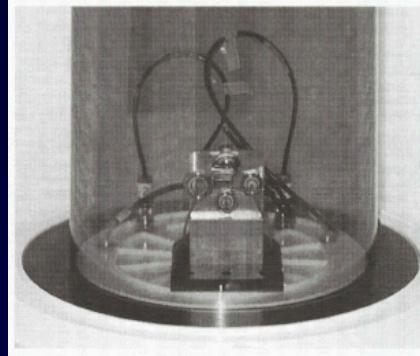
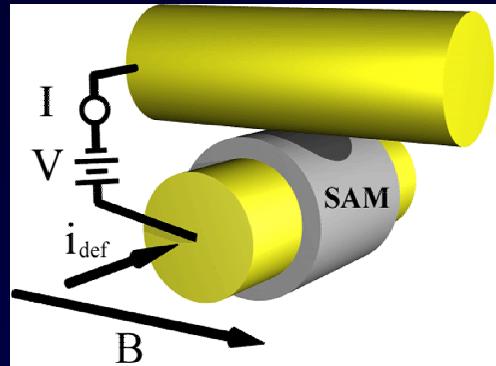
$$I \cong I_0 \gamma e^{-\beta(1)d_{\text{SAM}(1)}} \quad (2)$$

M. A. Rampi, O. J. A. Schueller, G. M. Whitesides, *App. Phys. Lett.* **72**, 7281 (1998).

R. E. Holmlin, R. Haag, M. L. Chabinyc, R. F. Ismagilov, A. E. Cohen, A. Terfort, M. A. Rampi, G. M. Whitesides, *J. Am. Chem. Soc.* **123**, 5075 (2001).

Crossed-Wire Junctions

Lorenz Force deflection

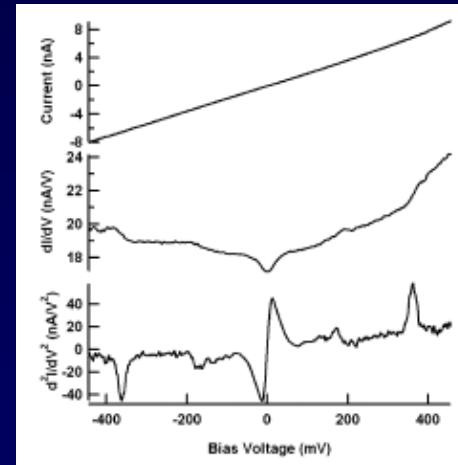


I-V characteristics

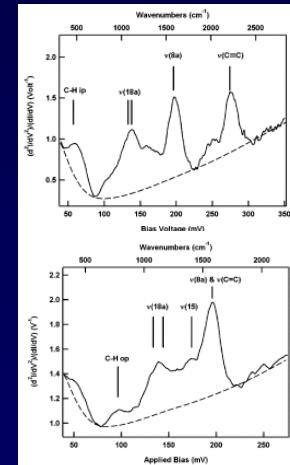
S. Gregory, *Phys. Rev. Lett.* **64**, 689 (1990).

J. G. Kushmerick, D. B. Holt, S. K. Pollack, M. A. Ratner, J. C. Yang, T. L. Schull, J. Naciri, M. H. Moore, R. Shashidhar, *J. Am. Chem. Soc.* **124**, 10654 (2002).

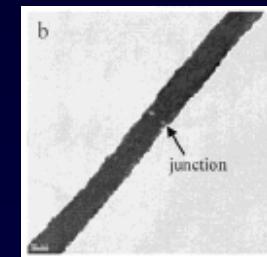
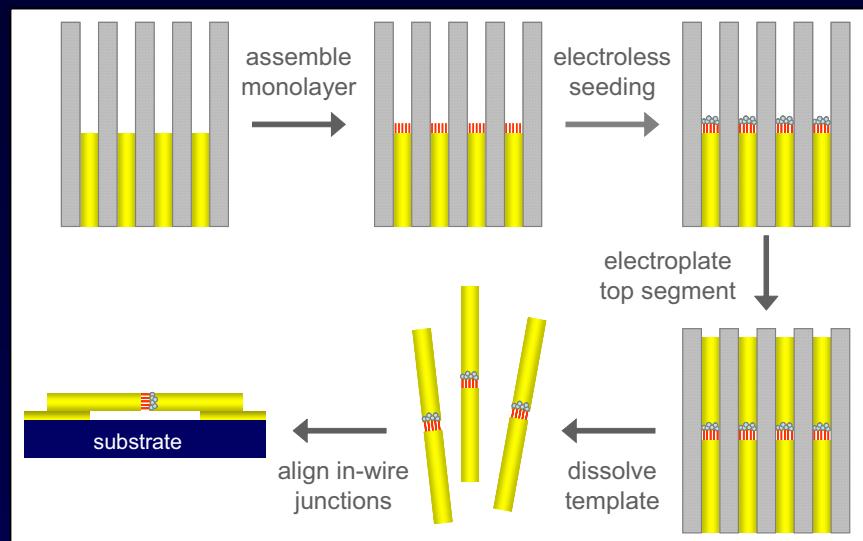
J. G. Kushmerick, J. Lazorcik, C. H. Patterson, R. Shashidhar, D. S. seferos, G. C. Bazan, *Nano Lett.* **4**, 639 (2004).



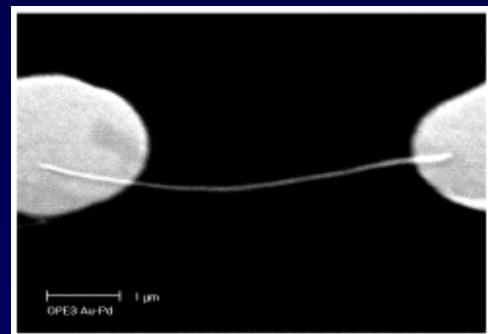
Inelastic Tunneling Spectroscopy



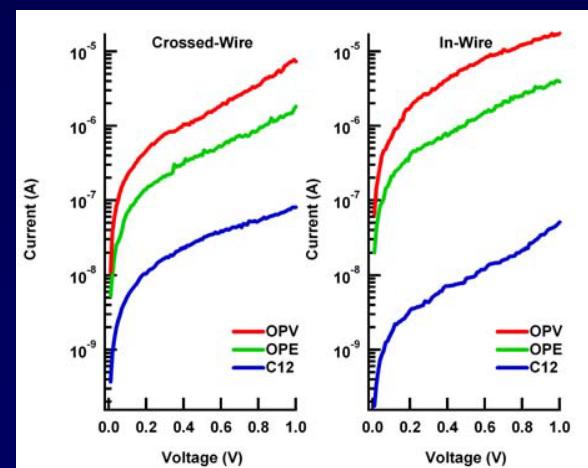
In-wire Junctions



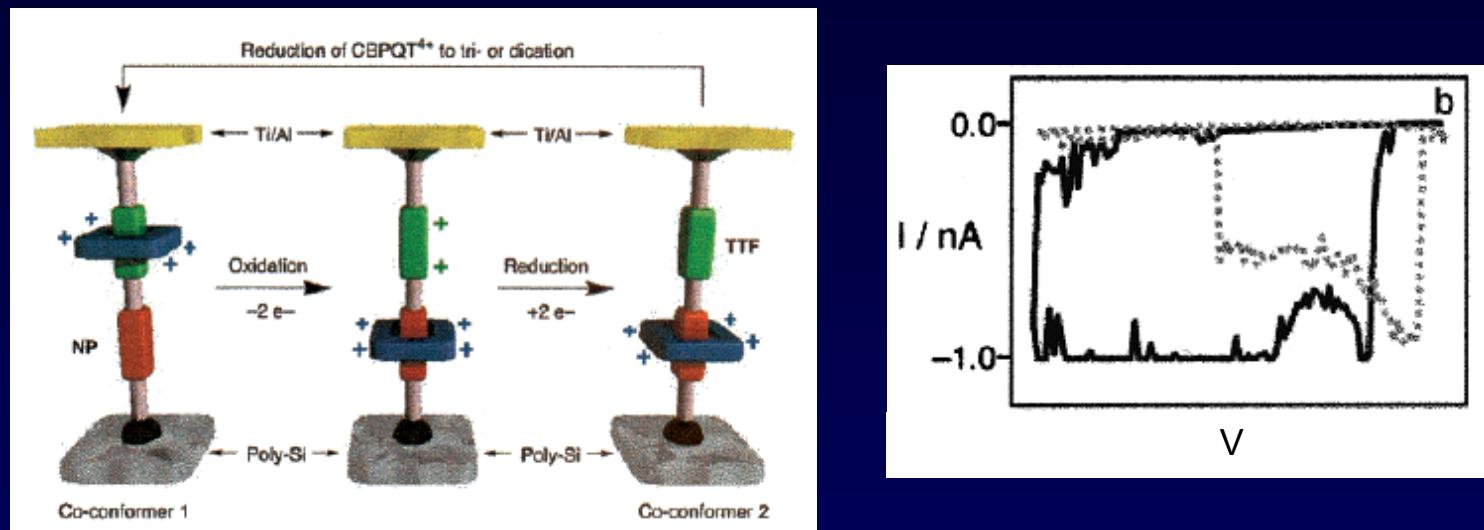
J. K. N. Mbindyo, T. E. Mallouk, J. B. Mattzela, I. Kratochvilova, B. Razavi, T. N. Jackson, T. S. Mayer, *J. Am. Chem. Soc.*, **124**, 4020 (2002).



L. T. Cai, H. Skulason, J. G. Kushmerick, S. K. Pollack, J. Naciri, R. Shashidhar, D. L. Allara, T. E. Mallouk, T. S. Mayer, *J. Phys. Chem. B* **108**, 2827 (2004). J. G. Kushmerick, D. L. Allara, T. E. Mallouk, T. S. Mayer, *MRS Bulletin*, June (2004).

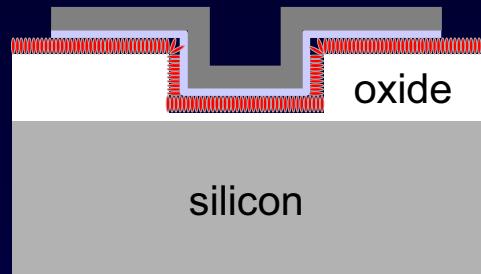


Metal-Molecule-Semiconductor Junction



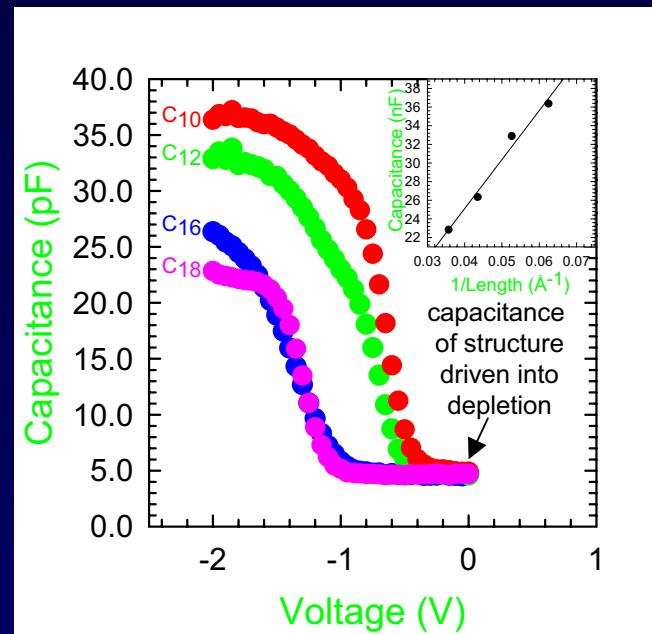
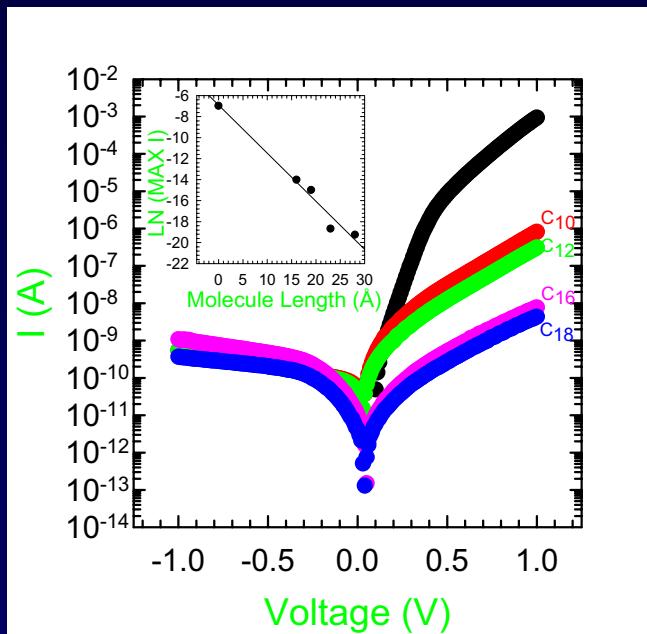
C. P. Collier, J. O. Jeppesen, Y. Luo, J. Perkins, E. W. Wong, J. R. Heath, J. F. Stoddart, *J. Am. Chem. Soc.* **123**, 12632 (2001).

Sandwich Structures on Semiconducting Surfaces



- Advantage: MIS control possible unlike metal-insulator-metal (good portion of MIM literature incorrect)
- assemble molecules of varying chain length

Metal-Insulator-Semiconductor Diodes



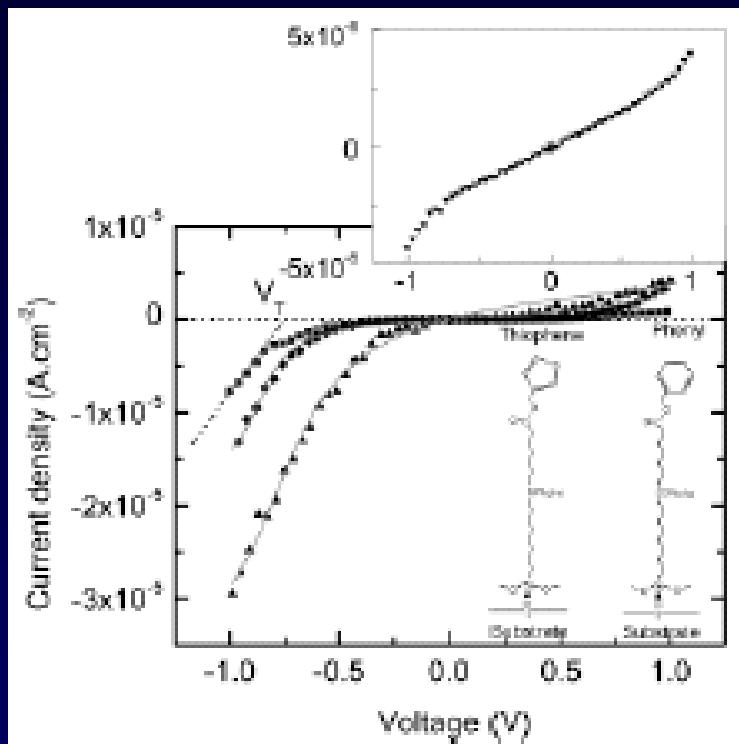
calculated capacitance agrees with MIS diode having organic molecules + ~10 Å SiO₂ native oxide

C. R. Kagan, C. T. Black

+ photoresponse measurements to understand barrier heights

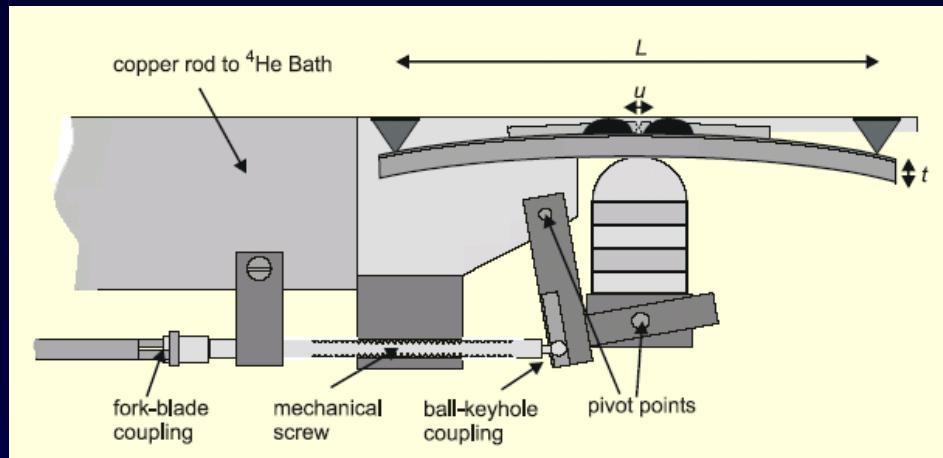
D. Vuillame et. al. Apl. Phys. Lett. **69**, 1646 (1996).

Molecular Junctions: Rectifiers on Si



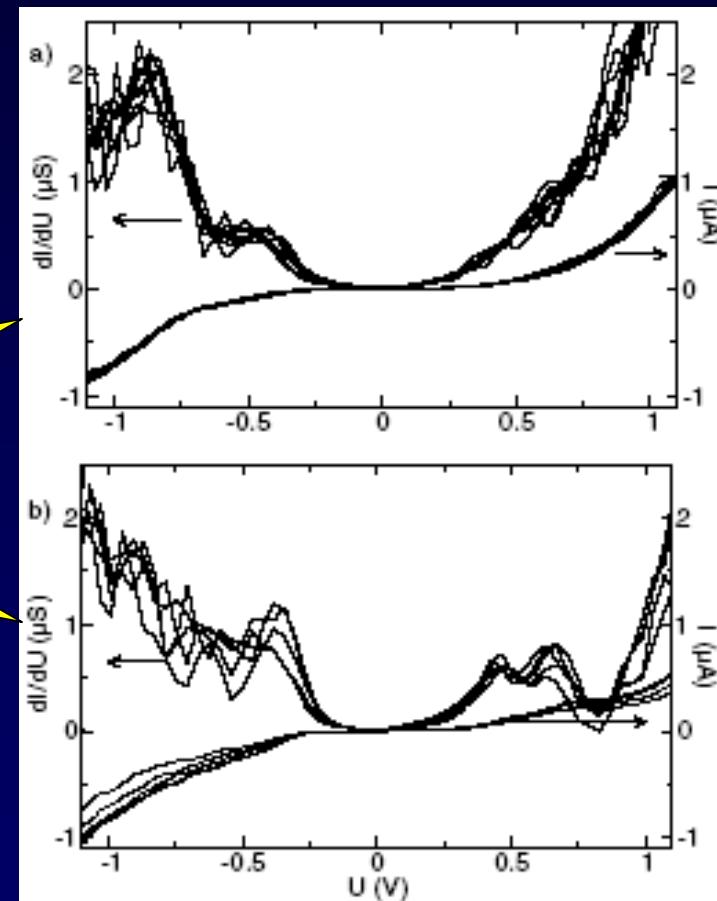
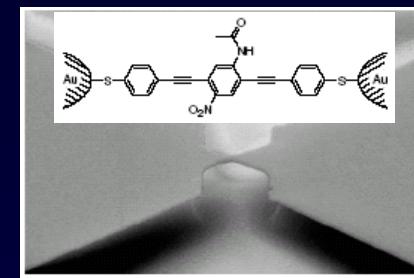
S. Lenfant, C. Krzeminski, C. Delerue, G. Allan, D. Vuillaume,
Nano Lett **3**, 741 (2003).

Mechanically Controllable Break Junctions



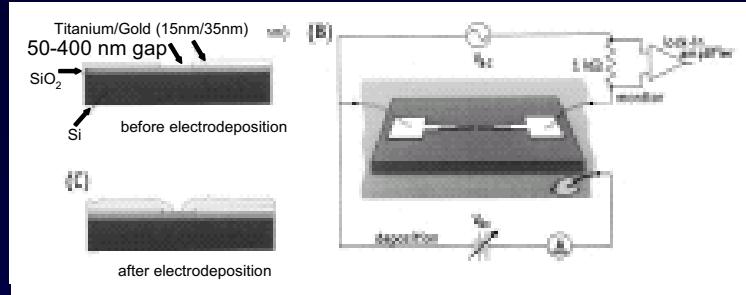
J. van Ruitenbeek

before and after
reconfiguration of the
molecule in the junction



J. Reichert, R. Ochs, D. Beckmann, H. B. Weber, M. Mayor,
H. v. Löhneysen, *Phys. Rev. Lett.* **88**, 176804 (2002).

Electrochemical Deposition/Re-dissolution to Form Atomic Scale Gaps



In Solution:

0.01 M potassium cyanaurate $[KAu(CN)_2]$

buffer $\sim pH 10$ composed of:

1 M potassium bicarbonate ($KHCO_3$) and

0.2 M potassium hydroxide KOH

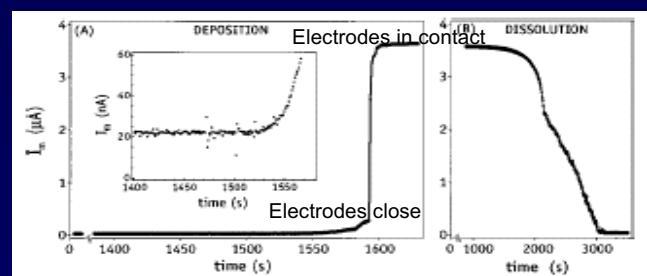
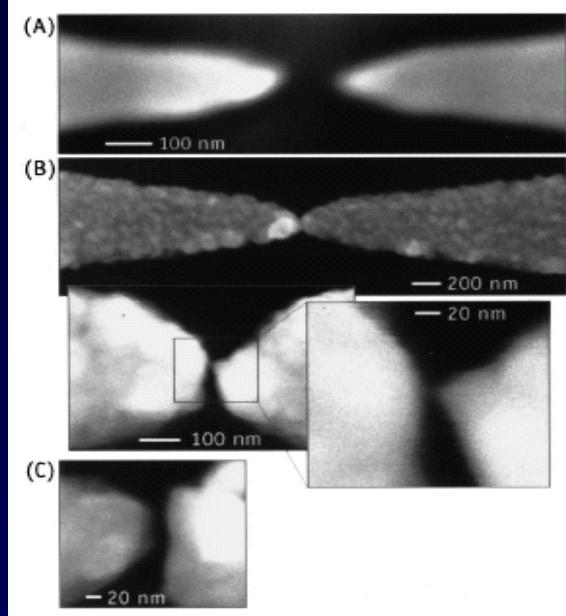
Cyanaurate accepts electron, liberating cyanide, depositing Au

Au counterelectrode

$V_{app} = -0.5 - 0.6V$ on both electrodes

Monitor I with 4 mV ac bias at 1 Hz, monitor across resistor with lock-in

A. F. Morpurgo and C. M. Marcus, D. B. Robinson, *App. Phys. Lett.* **74**, 2084 (1999).



Similarly for Pt electrodes

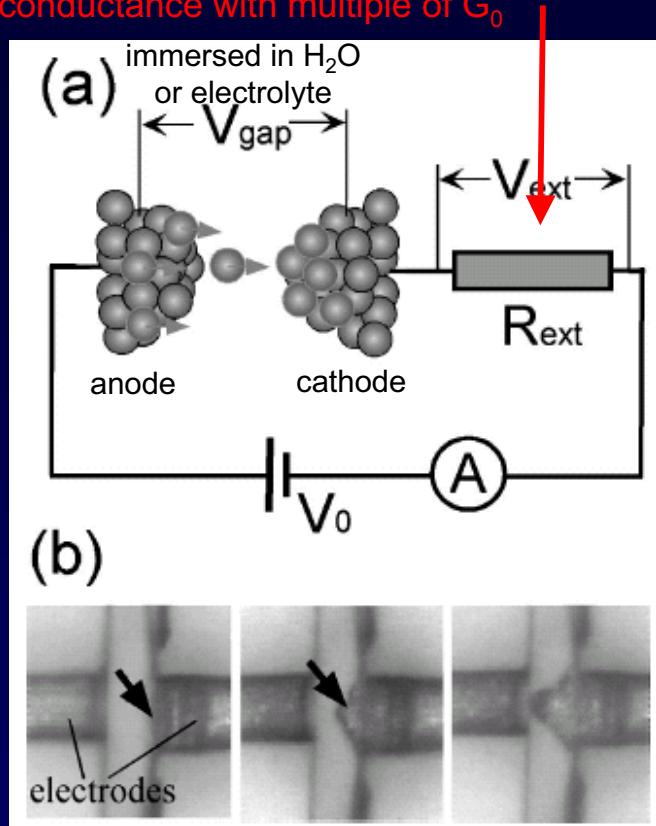
Gaps $\sim 1-20$ nm

Self-Terminating Electrochemical Method to the Formation of Atomic-scale Gaps

Provides built-in self-termination

$1/R_{\text{ext}} < G_0$, small gap with conductance determined by tunneling

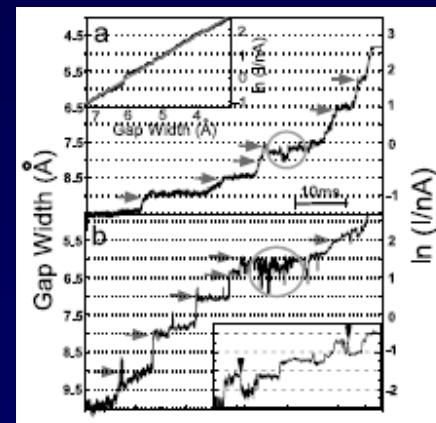
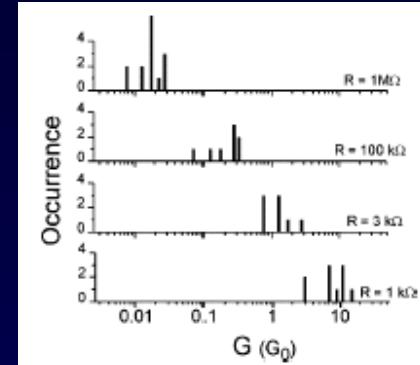
$1/R_{\text{ext}} > G_0$, conductance with multiple of G_0



$$V_{\text{gap}} = \frac{R_{\text{gap}}}{R_{\text{gap}} + R_{\text{ext}}} V_0,$$

R_{gap} depends on tunneling current and leakage current

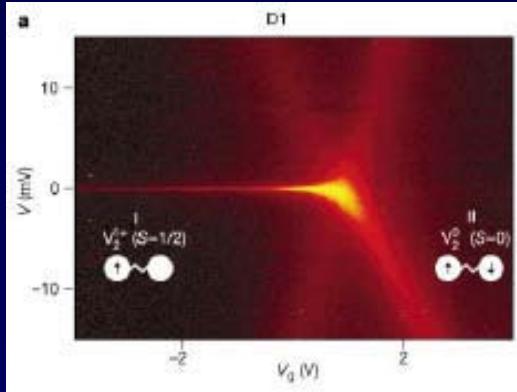
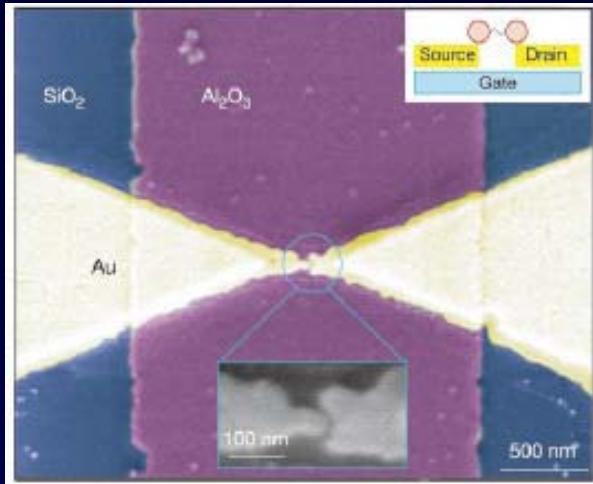
Leakage current depends on electrode geometry and electrolyte concentration



S. Boussaad and N. J. Tao, *App. Phys. Lett.* **80**, 2398 (2002).

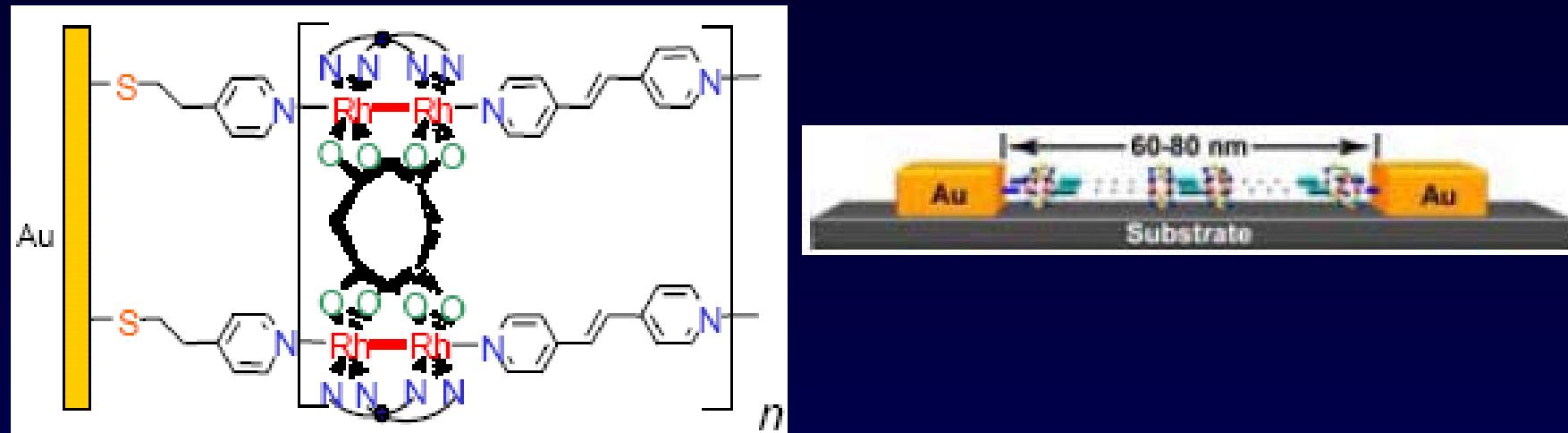
H.X. He, S. Boussaad, B.Q. Xu, C.Z. Li, N.J. Tao, *J. ElectroAnal. Chem.* **522**, 167 (2002)

Electromigration Junctions

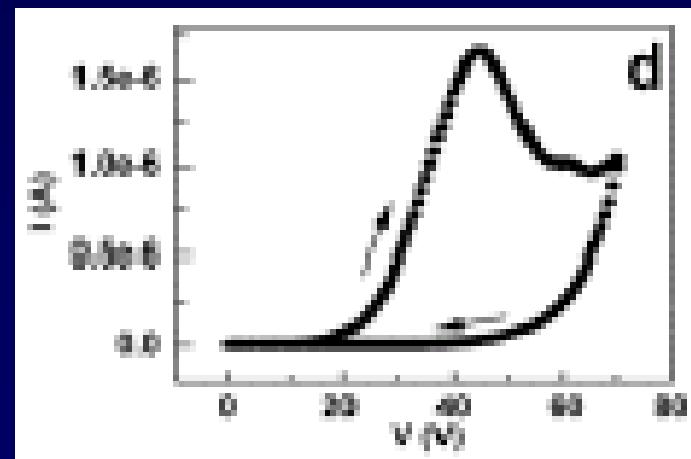


J. Park, A. N. Pasupathy, J. I. Goldsmith, C. Chang, Y. Yaish,
J. R. Petta, M. Rinkoski, J. P. Sethna, H. D. Abruna, P. L.
McEuen, D. C. Ralph, *Nature* **417**, 722 (2002); W. Liang, M. P.
Shores, M. Bockrath, J. R. Long, H. Park, *Nature* **417**, 725
(2002).

Bridging the Gap



Layer-by-layer Chemistry to meet the dimensions of standard lithographically defined electrodes

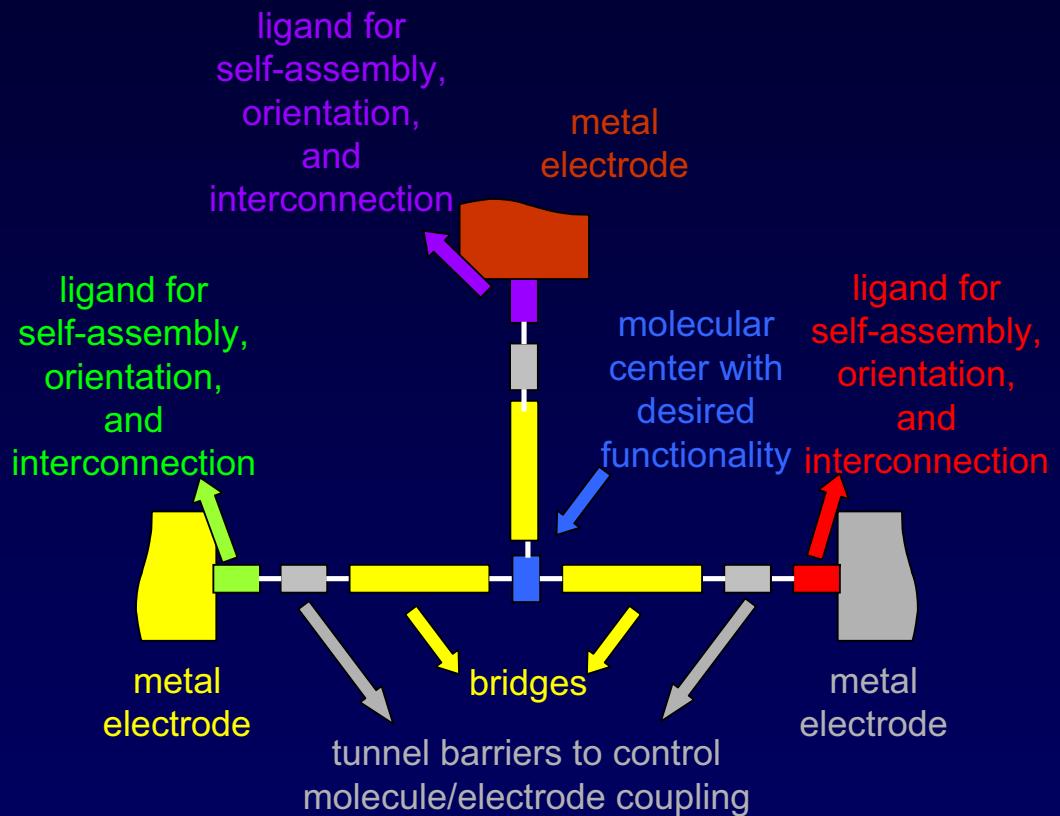


The Chemistry of Molecular Assembly

Cherie R. Kagan

**IBM T. J. Watson Research Center
Yorktown Heights, NY**

Molecular Materials and Devices



**Build desired functionality
into single molecules**

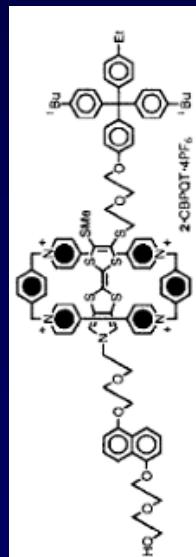
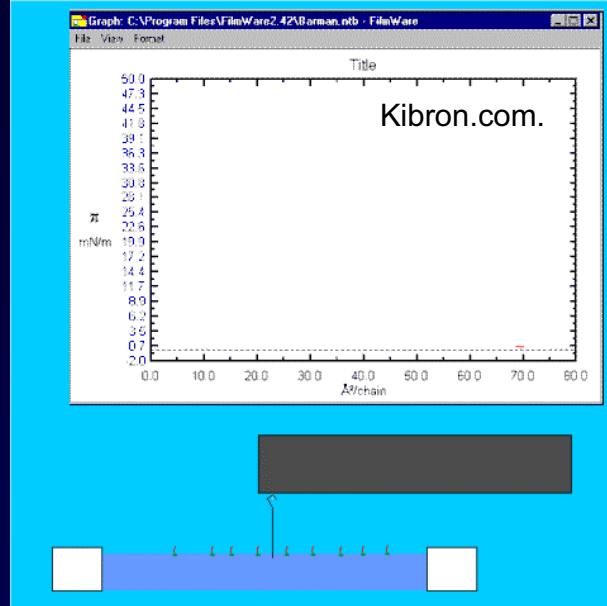
**Understand
the physics and design
of molecules
and molecular devices
to control:**

**switching potential
switching time/mechanism
reversibility/stability
room T operation
solubility
self-assembly/orientation
molecule-contact resistance/coupling
..... And the list goes on!**

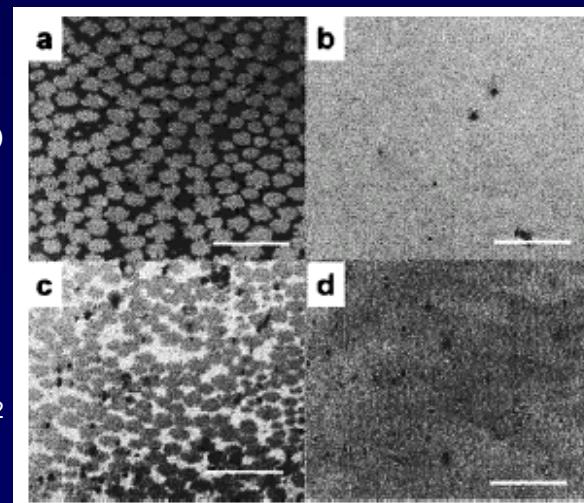
Physical Monolayers on a Langmuir-Blodgett Trough



Nima Tech.



6.4 mM CdCl₂

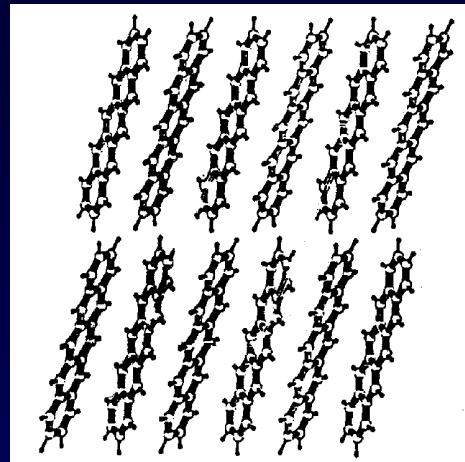


100 μ m

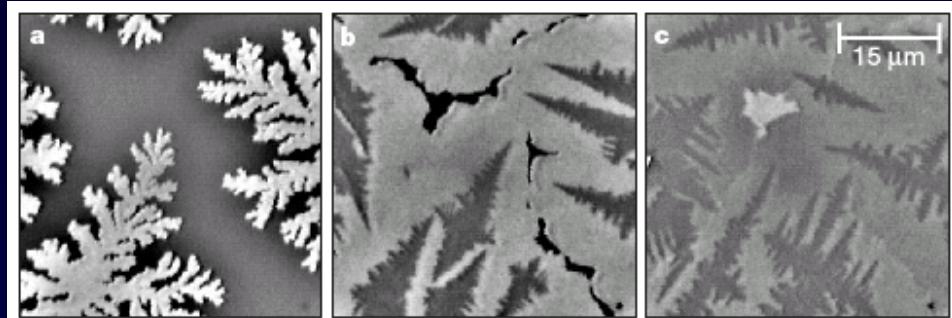
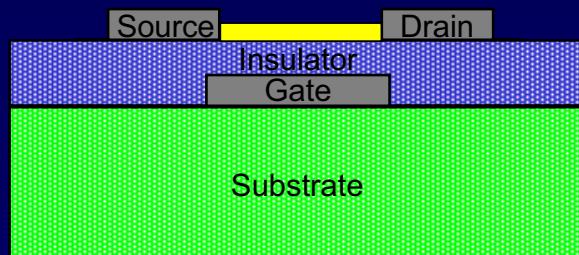
C. P. Collier, J. O. Jeppesen, Y. Luo, J. Perkins, E. W. Wong, J. R. Heath, J. F. Stoddart, *J. Am. Chem. Soc.* **123**, 12632 (2001).

Physical Assembly As in Thin Film Organic Devices

Intermolecular Charge Transport

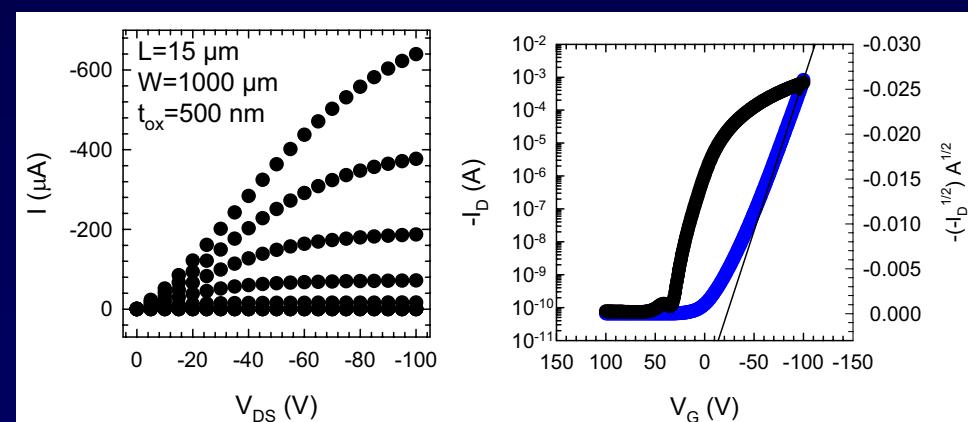


Collective property of molecules



Low-energy electron microscope monitoring pentacene growth on Si(001)

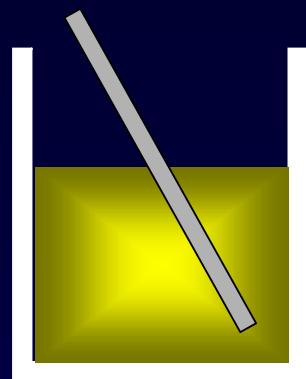
F. J. Meyer zu Heringdorf, M. C. Reuter, R. M. Tromp, *Nature* 412, 517 (2001).



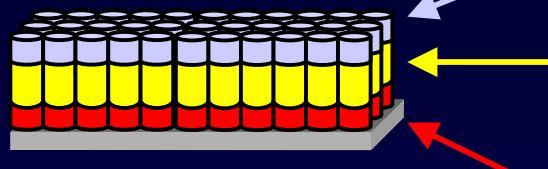
$$\text{Mobility} = 0.5 \text{ cm}^2/\text{V}\cdot\text{sec}$$
$$I_{\text{ON}}/I_{\text{OFF}} = 10^7$$

C. R. Kagan, A. G. Schrott

Chemical Assembly on Surfaces



Immerse substrate in solution of surface-active molecular species for seconds to hours

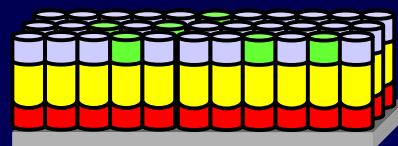


tail group
Interacts with adjacent or added molecules, air, electrodes

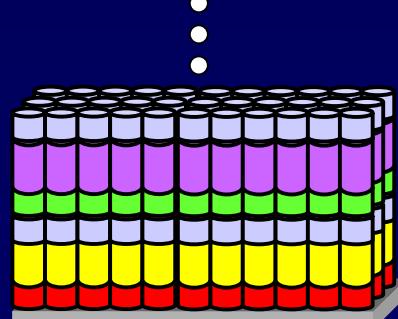
Intermolecular interactions (van der Waals, $\pi-\pi$, ...)

Surface-active head group providing chemisorption to the surface

Closely-packed ordered SAM



Different tail groups may interact through hydrogen bonding, dipolar interactions



Reactive tail groups for multilayer assembly

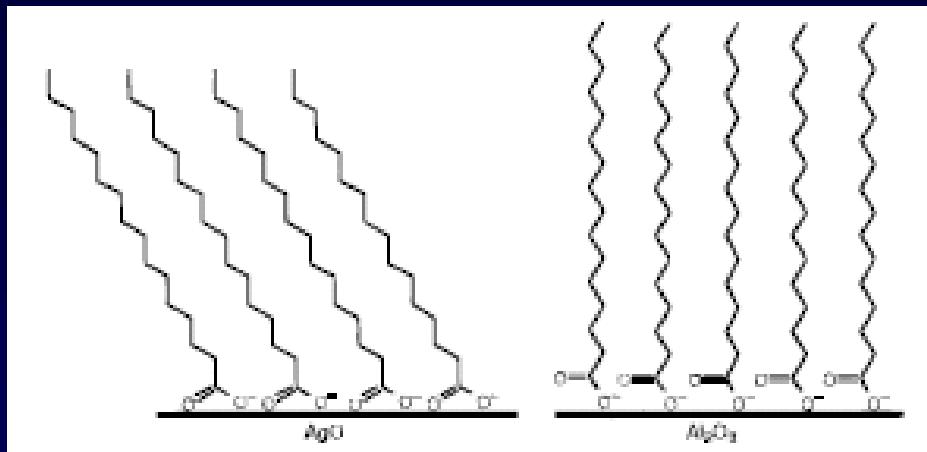
Interactions:

- molecule-molecule
- molecule-substrate
- molecule-solvent

Affects:
ordering, growth, wetting,

Classic Example of Fatty Acids

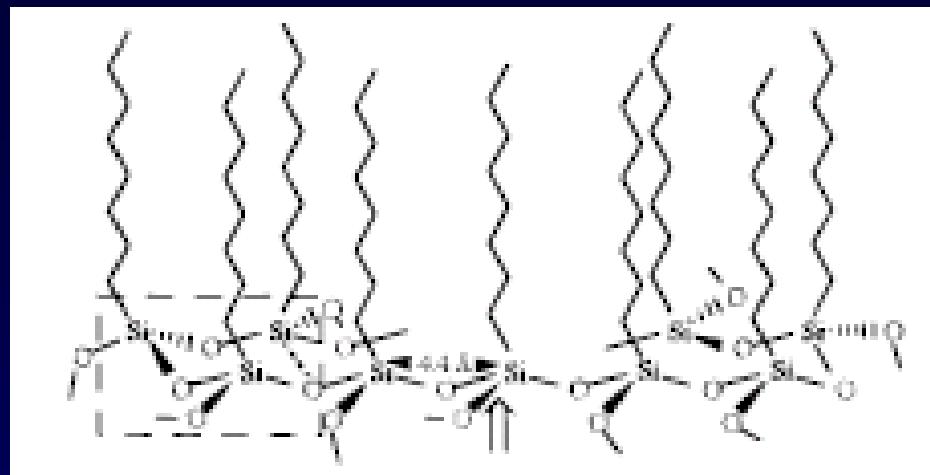
Example:



acid-base reaction between carboxylic acid and surface metal cation

Classic Example of Silanes

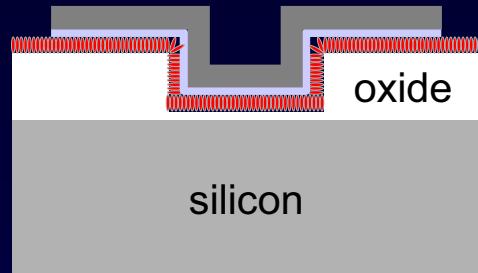
silane + hydroxylated surface surface →



Driving force:
Polysiloxane connected to surface silanol
or other hydroxylated surface

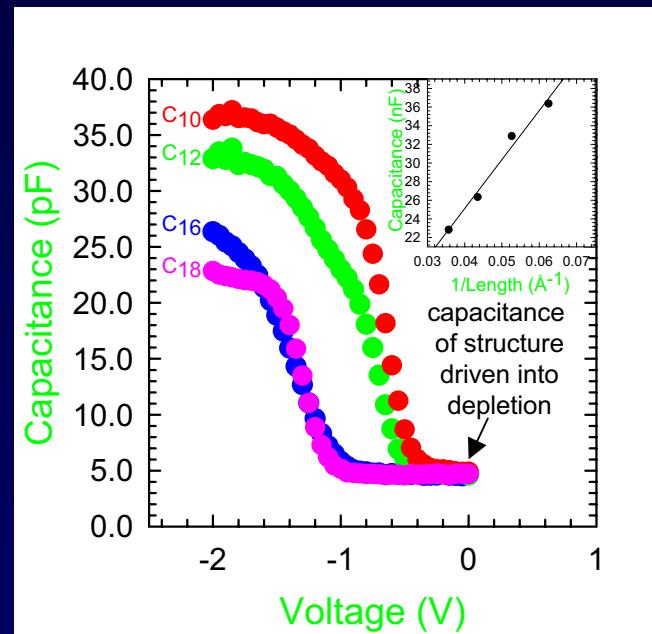
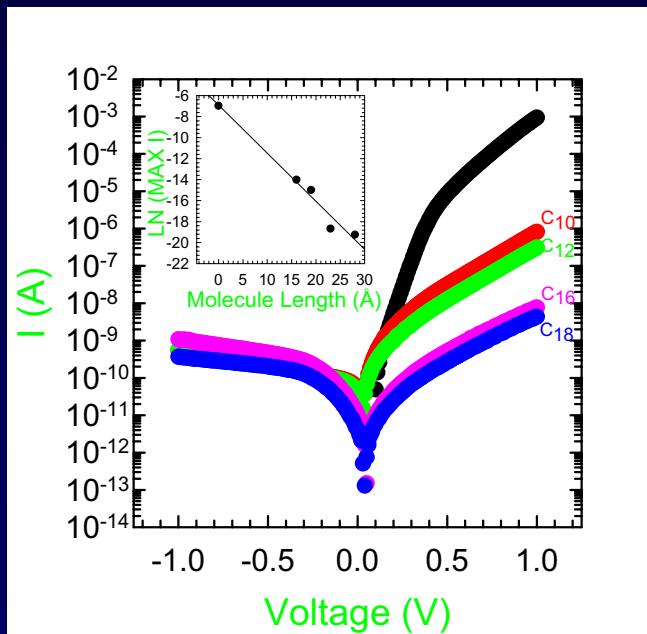
Note: monolayer formation is highly sensitive to surface water

Understanding the Fabrication and Characteristics of Molecular Devices



- Advantage: MIS control possible unlike metal-insulator-metal (good portion of MIM literature incorrect)
- assemble molecules of varying chain length

Metal-Insulator-Semiconductor Diodes



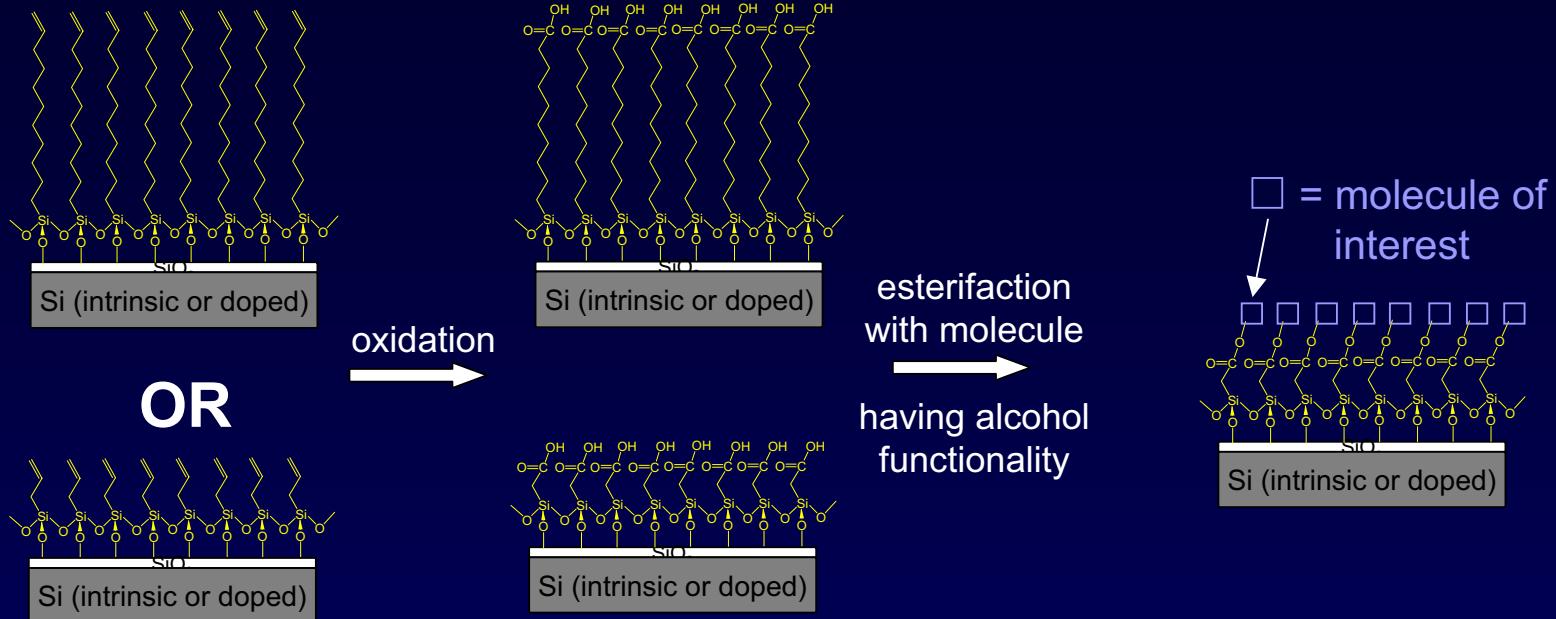
calculated capacitance agrees with MIS diode
having organic molecules + ~10 Å SiO₂ native oxide

C. R. Kagan, C. T. Black

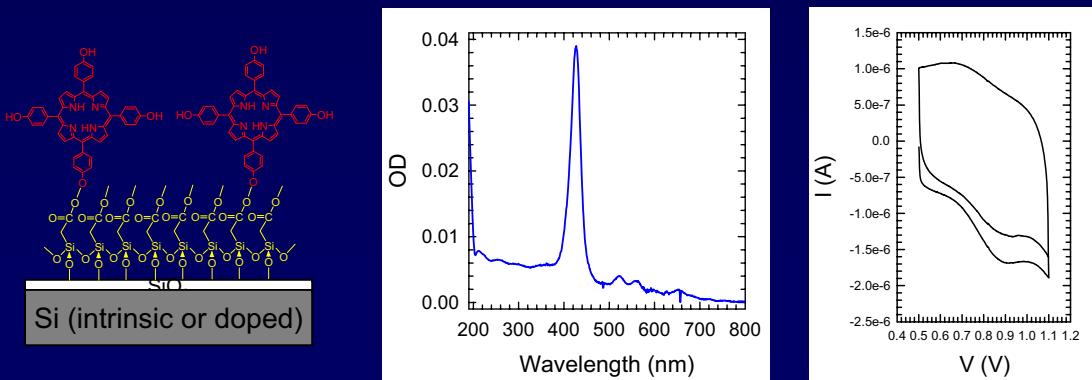
+ photoresponse measurements to understand barrier heights

D. Vuillame et. al. Apl. Phys. Lett. **69**, 1646 (1996).

Chemistry to Covalently Bind Molecules to Oxides

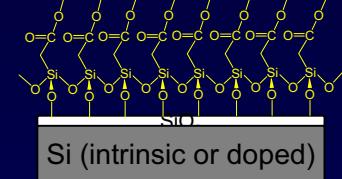


Example: tetrahydroxyphenylporphine



D. Vuillame Appl. Phys. Lett. **76**, 1339 (2000).

□ = molecule of interest



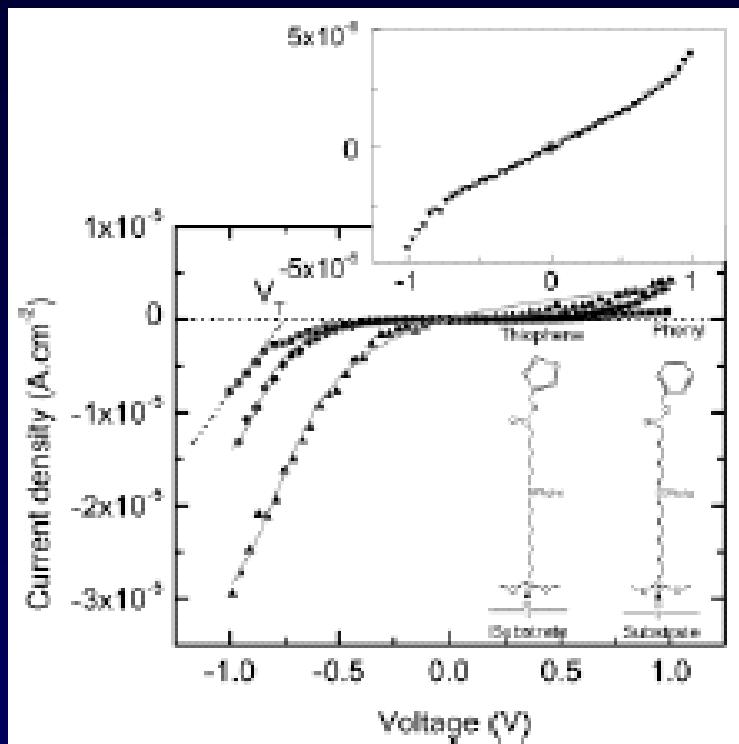
Molecules tried :

- porphyrins
- ferrocene
- pyrene
- anthracene
- all-trans retinol

Works for alcohols, phenols,
.....?

Kagan/Afzali

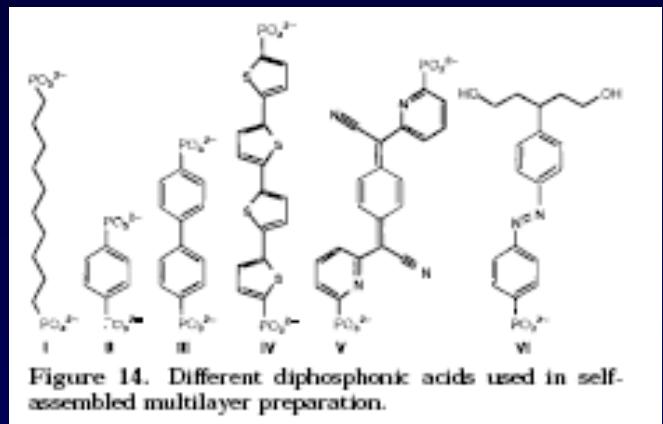
Molecular Junctions: Rectifiers on Si



S. Lenfant, C. Krzeminski, C. Delerue, G. Allan, D. Vuillaume,
Nano Lett **3**, 741 (2003).

Other Head Group Chemistries for Self-Assembly on Oxide Surfaces

Phosphonic Acids –



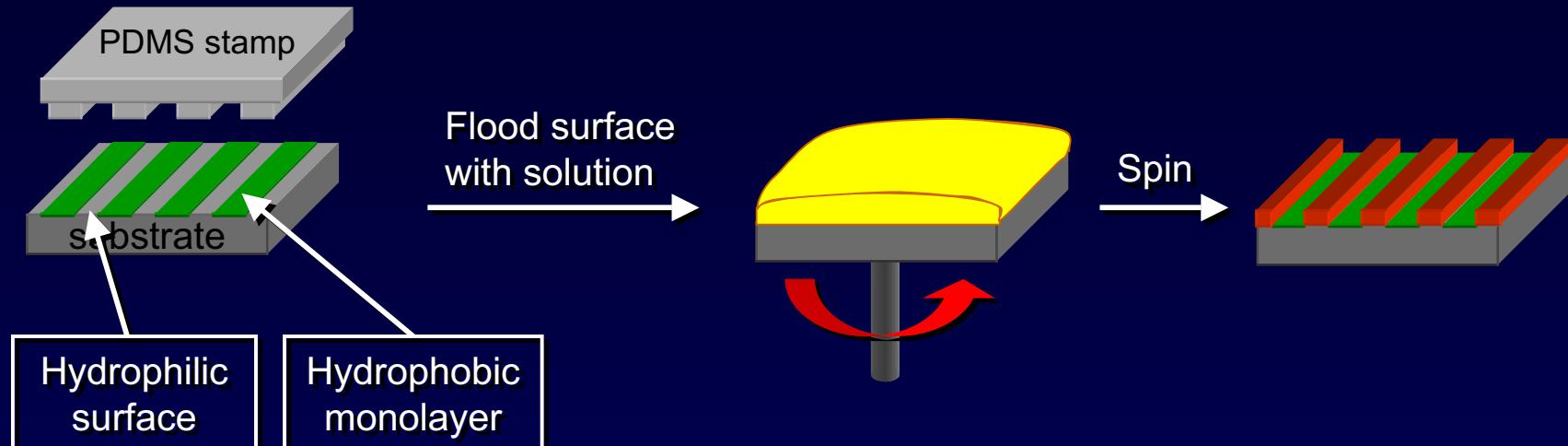
+ Zr^{4+} \longrightarrow Zirconium Phosphate Multilayers

H. Lee, L. J. Kepley, H. G. Hong, T. E. Mallouk, *J. Am Chem. Soc.* **110**, 618 (1988).

H. Lee, L. J. Kepley, H. G. Hong, S. Akhter, T. E. Mallouk, *J. Phys. Chem.* **92**, 2597 (1988).

T. M. Putvinski, M. L. Schilling, H. E. Katz, C. E. D. Chidsey, A. M. Musjsce, A. B. Emerson, *Langmuir* **6**, 1567 (1990)/

Patterning Organic-Inorganic Hybrid Materials



Organic Monolayer

Differentiates the Chemical Nature
Of the Substrate Surface

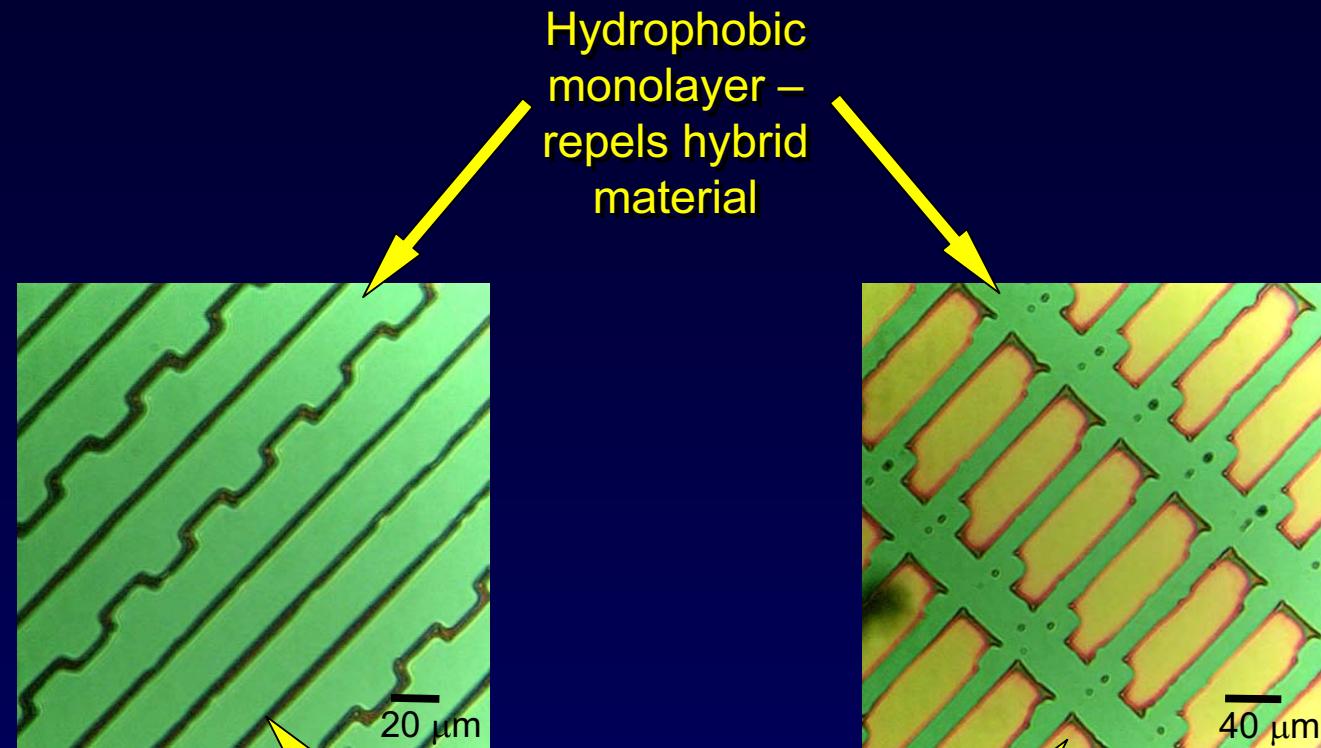
To pattern subsequently

Solution deposited thin films

- Simple
- Low-cost
- Low-temperature
- Parallel Process/Additive
- Avoid potentially damaging post processing steps

Patterned Organic-Inorganic Hybrid Thin Films

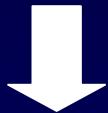
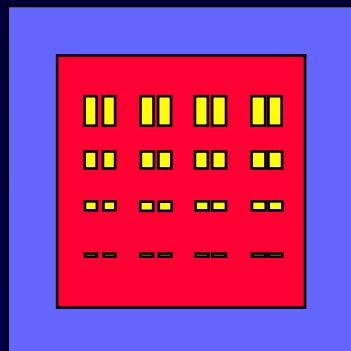
Example: Hydroxamic acids on Oxide Surfaces



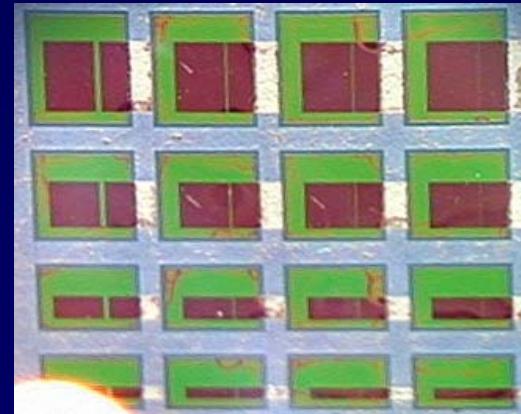
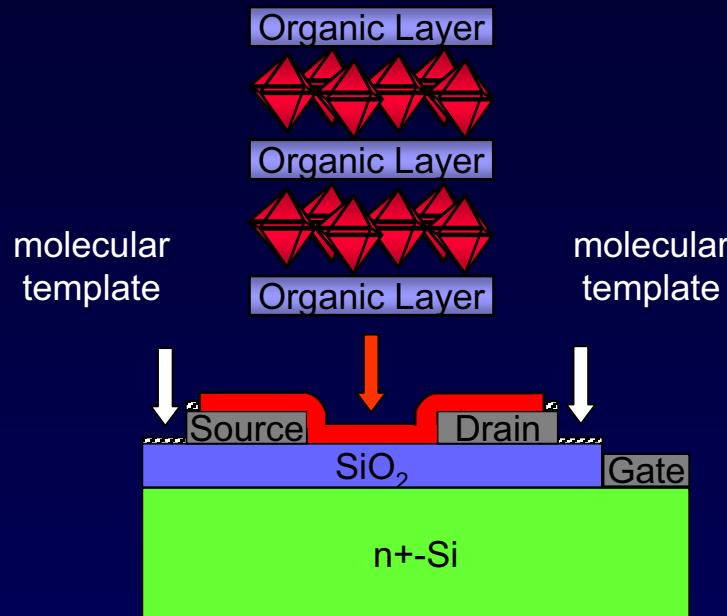
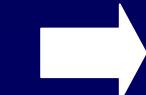
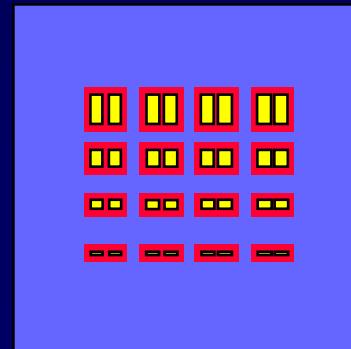
Hydrophobic monolayer – hexadecylhydroxamic acid
Substrate – $\text{ZrO}_2/\text{SiO}_2/\text{Si}$

Patterned Organic-Inorganic Hybrid Thin Film Transistors

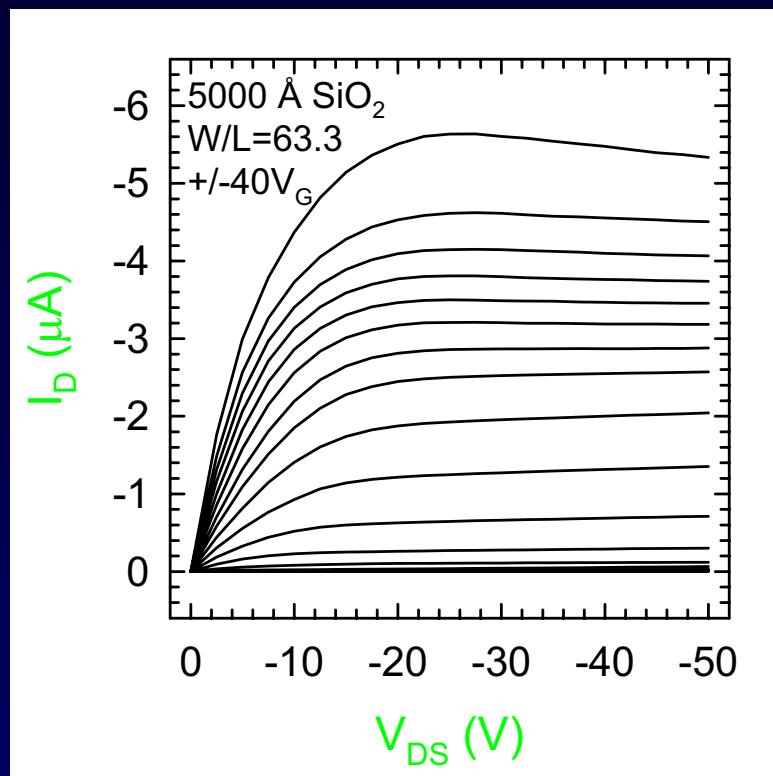
Unpatterned



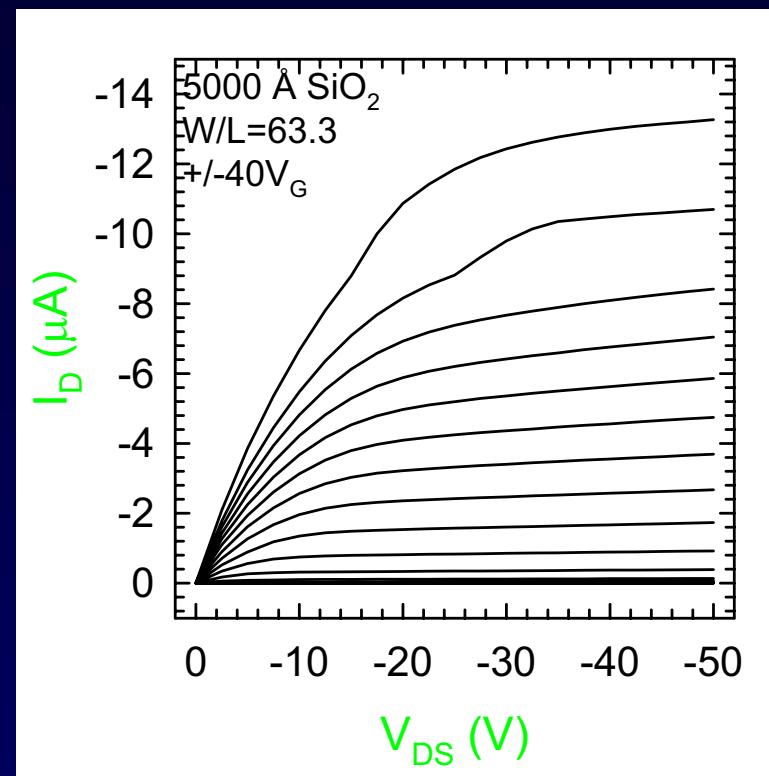
Isolate devices from each other and from back gate



Organic-Inorganic Hybrid Material $(C_6H_5C_2H_4NH_3)_2SnI_4$ Patterned Devices

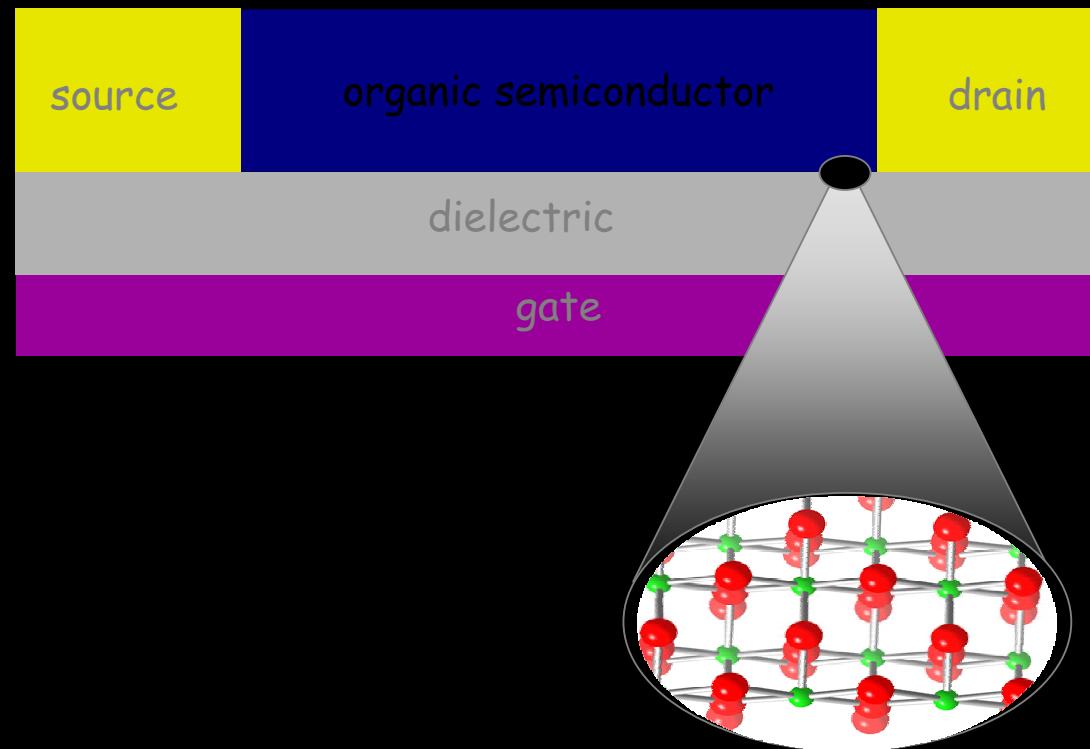


Template:
Octadecylphosphonic
acid
 $\mu = 0.1 \text{ cm}^2/\text{V}\cdot\text{sec}$
 $I_{ON}/I_{OFF} \sim 10^4$

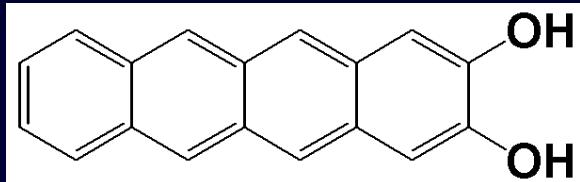


Template:
fluorinated alkylsilane
 $\mu = 0.52 \text{ cm}^2/\text{V}\cdot\text{sec}$
 $I_{ON}/I_{OFF} \sim 10^5$

Self-Assembly of linear acenes on gate oxides



Self-Assembly on High K-Dielectrics



THF solution with
 Al_2O_3 Surface

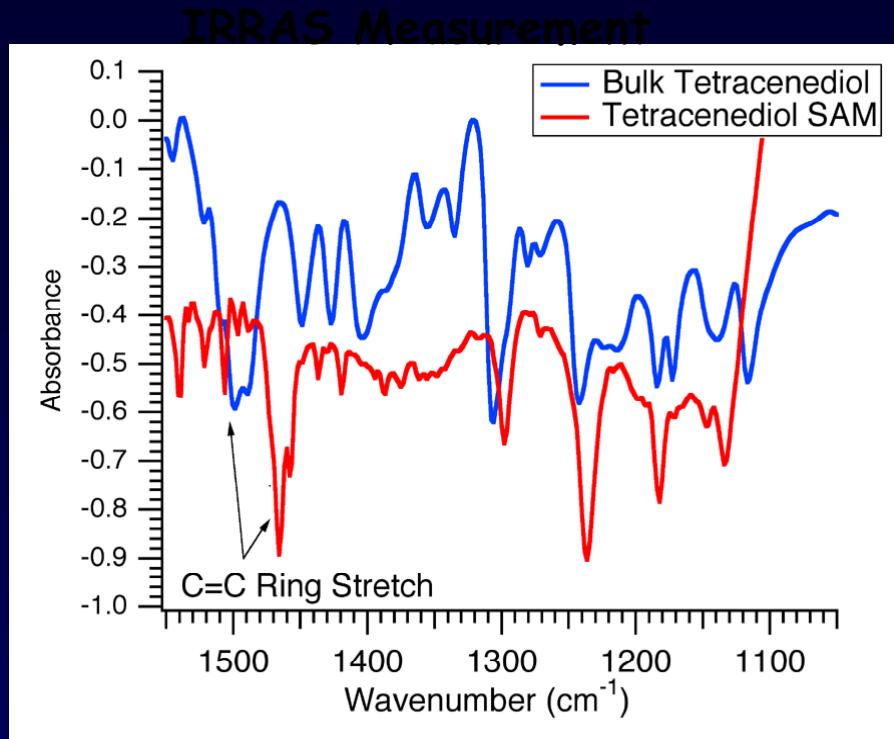
Water Contact Angle:

Advancing = 76°
Receding = 63°



XPS

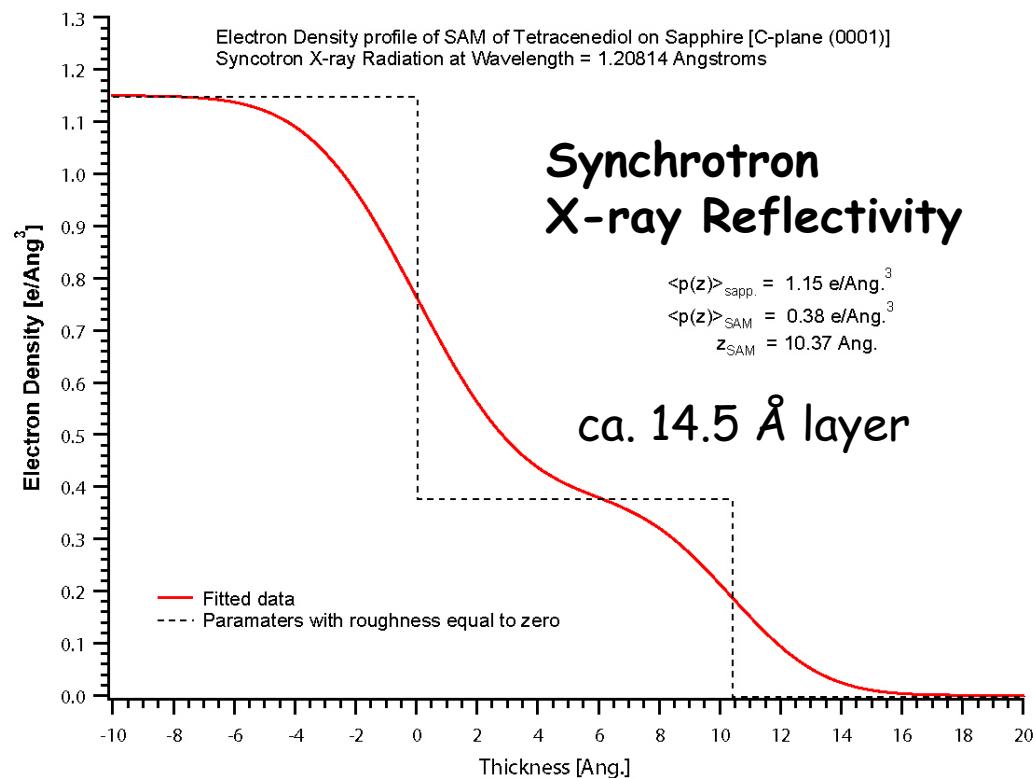
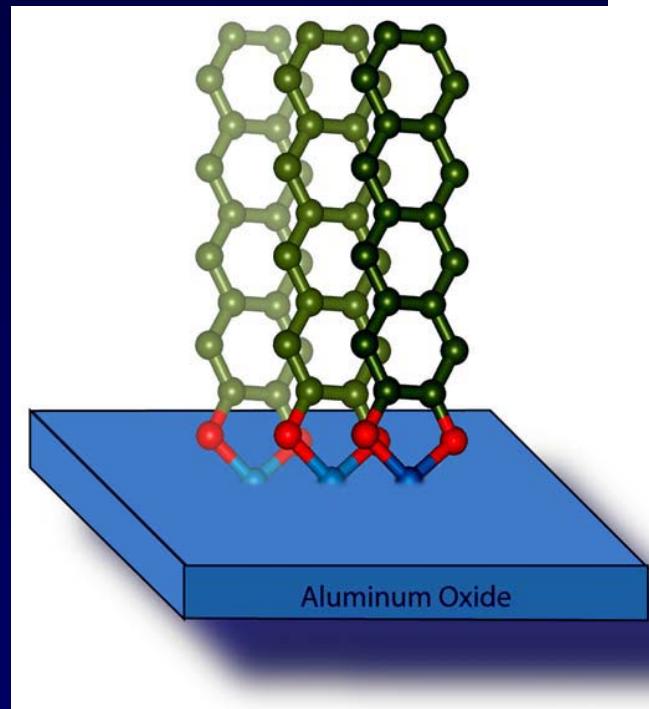
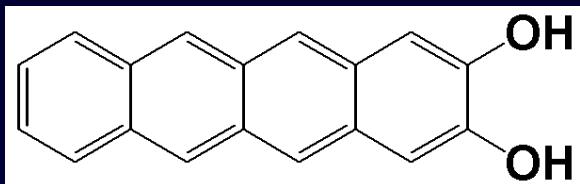
	15°	35°	70°
O	31.4	36.4	41.2
C	47.1	36.3	26.2
Al	21.4	27.2	32.5
C/Al	2.20	1.34	0.81



Ellipsometry:
Measured Thickness = 14.8 Å
Calculated: 14 Å

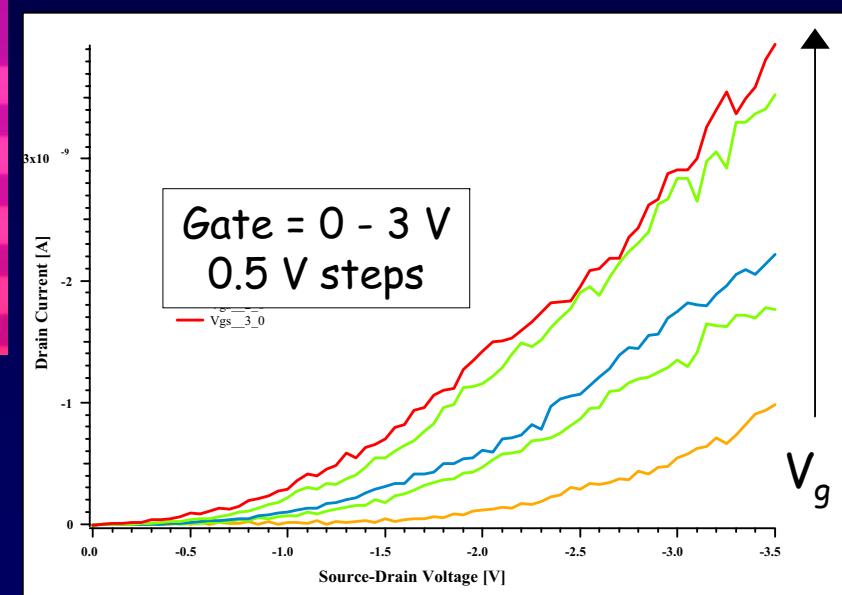
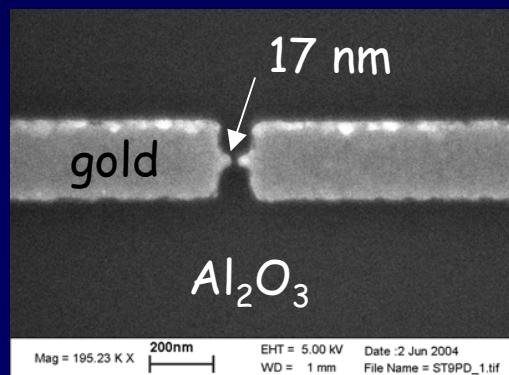
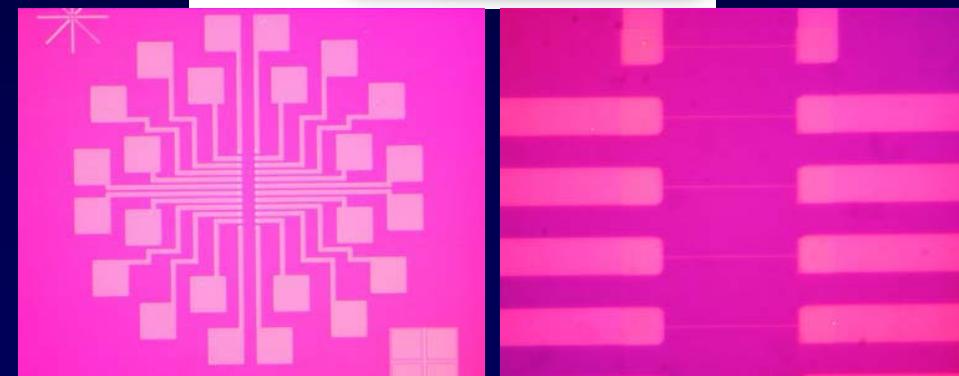
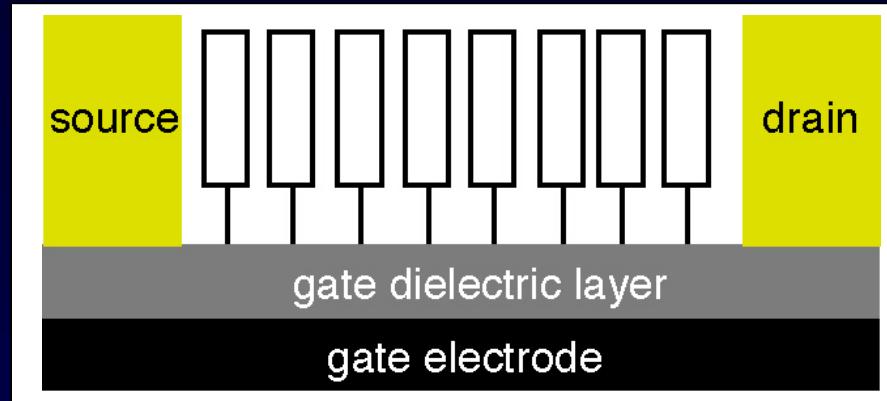
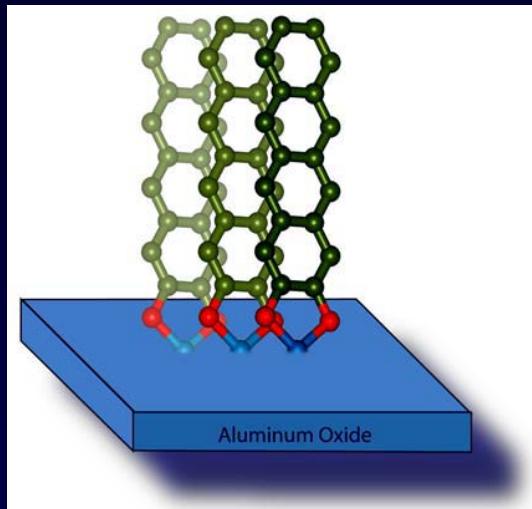
Also: HfO_2 , ZrO_2 , and Y_2O_3

Monolayers on sapphire crystals



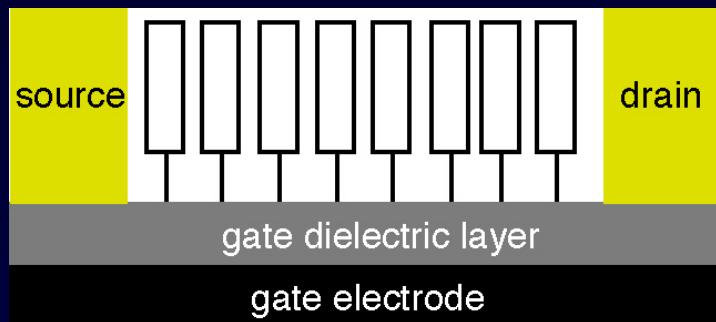
electron density
0.38 e⁻/Å³ for monolayer
0.39 e⁻/Å³ for tetracene crystal

Monolayer devices



Yield of similar devices: approx. 90%

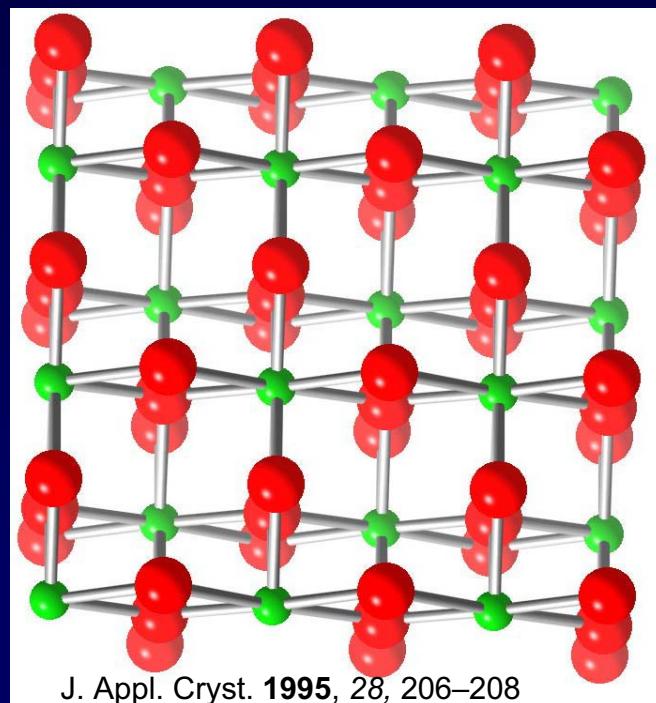
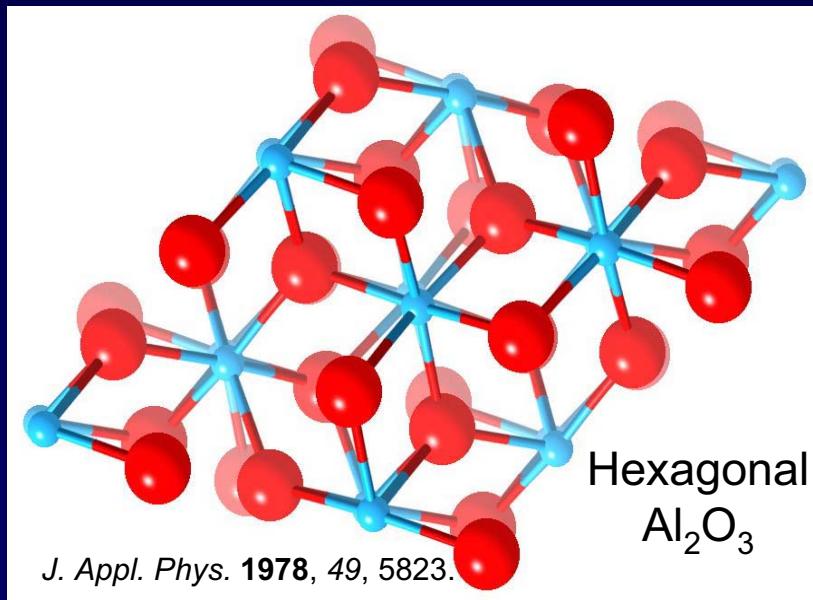
The next step: tune the three interfaces

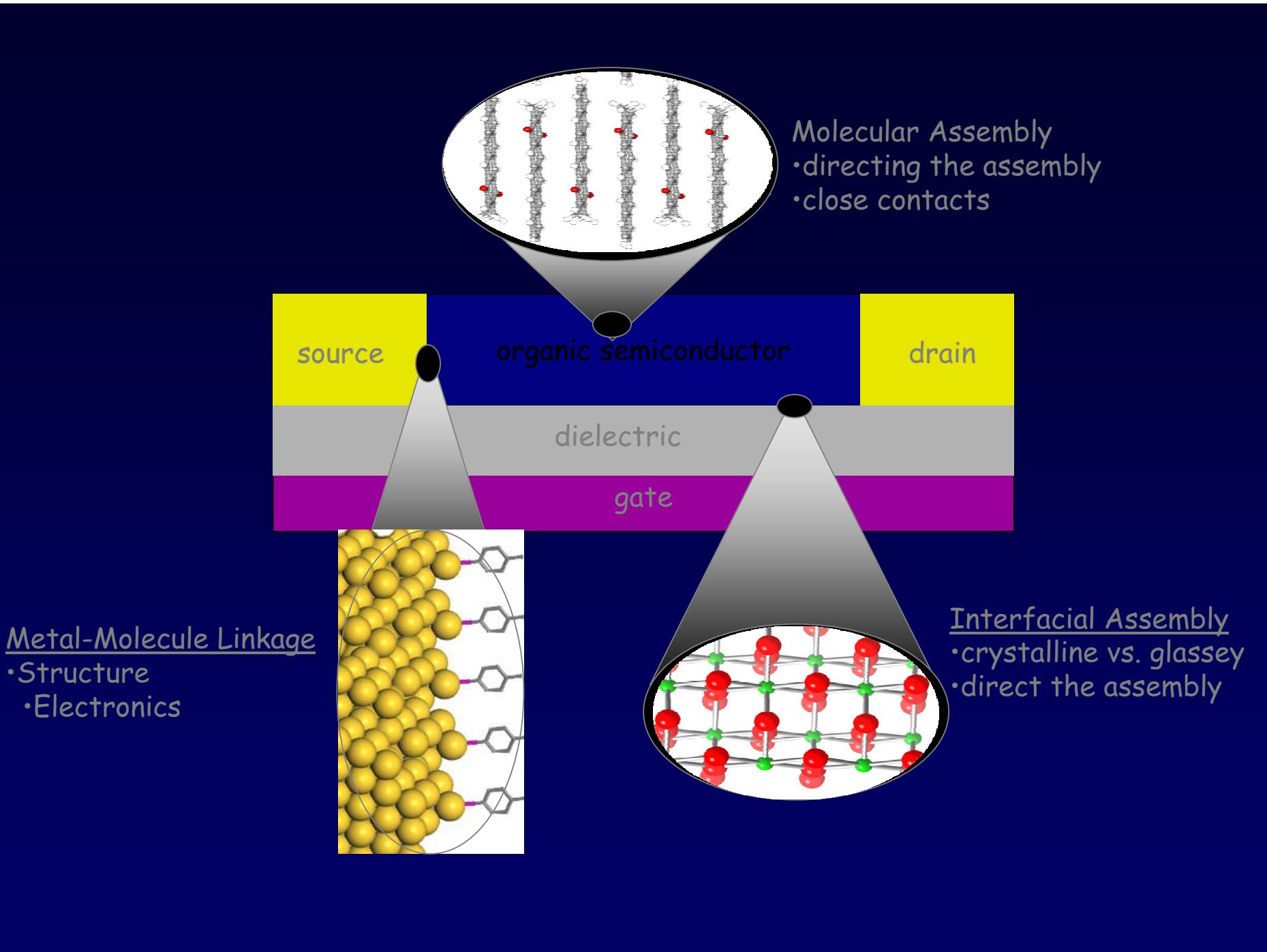


Source/Drain:
Gold (adhesion layer?)
Platinum
Derivatized

Gate dielectric:
Aluminum oxide
Hafnium oxide
Zirconium oxide
Crystalline

Viewing down the z-axis of Al_2O_3 and ZrO_2





Classic Example: Organosulfur, organoselenium

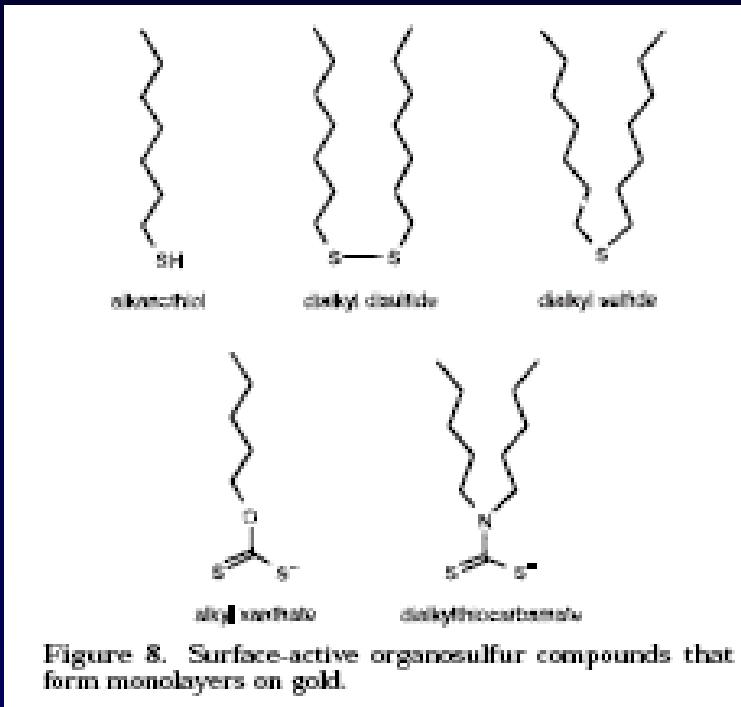
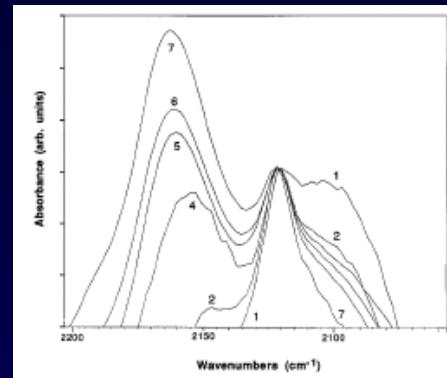
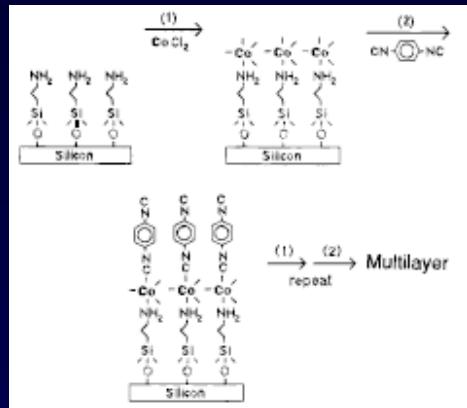


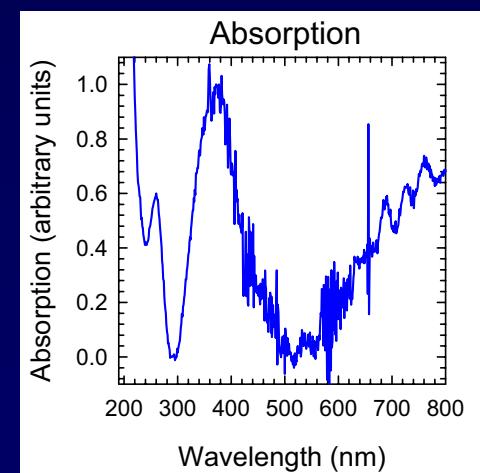
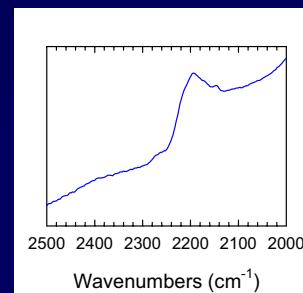
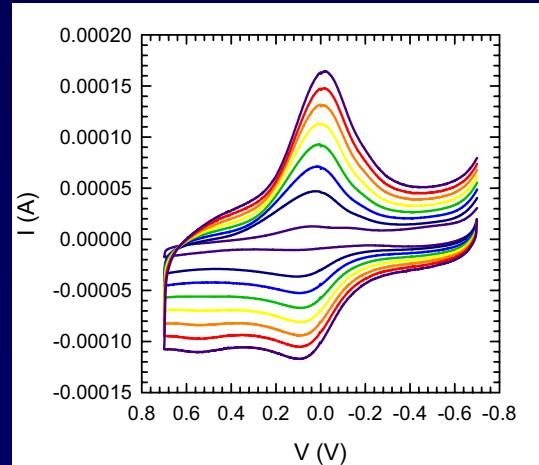
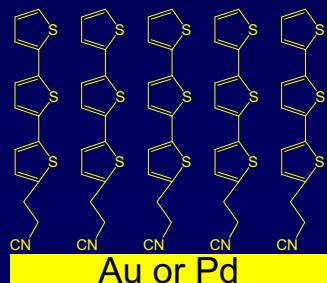
Figure 8. Surface-active organosulfur compounds that form monolayers on gold.



Other Head Group Chemistries for Self-Assembly on Metal Surfaces: Example Isocyanides

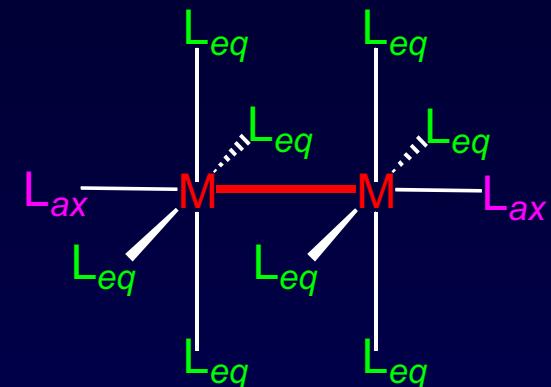
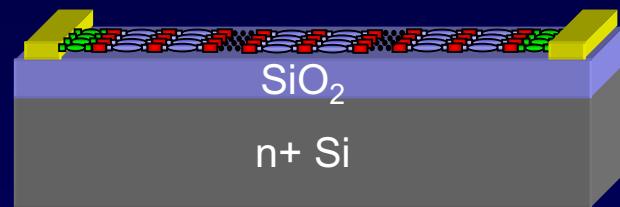
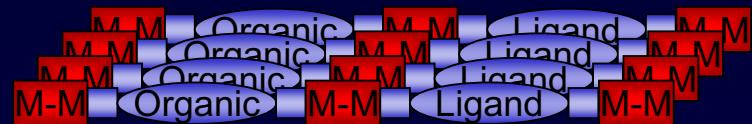


M. A. Ansell, E. B. Cogan, C. J. Page, *Langmuir* **16**, 1172 (2000).



C. R. Kagan, A. Afzali, V. Sundar

Directed Assembly of Molecular Devices: Layer-by-Layer Growth of Metal-Metal Bonded Supramolecules



$M = V, Nb, Cr, Mo, W, Tc,$
 $Re, Fe, Ru, Os, Co, Rh,$
 $Ir, Ni, Pd, Pt, Cu, Ag \dots$

Ligands chosen to tailor:

- Electronic coupling between dimetal units
- Electrochemistry
- Solubility
- Structure

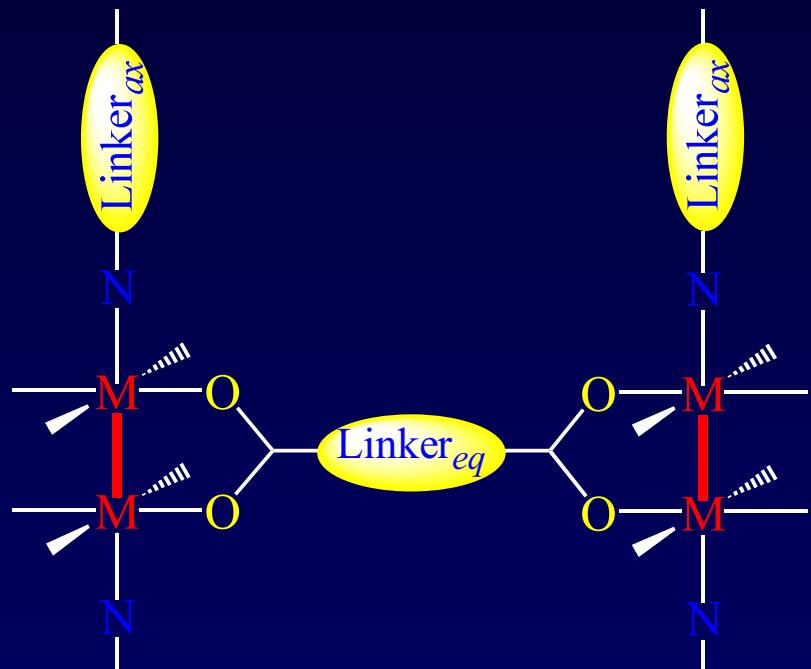
- Bridge channels $> 3 \text{ nm}$
- Chemistry meet lithographic capabilities

Tailoring the Metal-Metal Bonded Supramolecule

◆ With equatorial linker



◆ With equatorial and axial linkers



◆ With axial linker



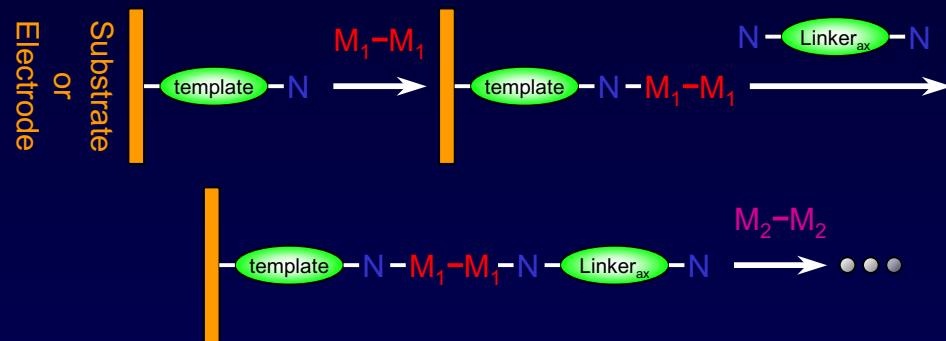
→ Supramolecules with a variety of crystal structures

Compounds previously studied in solution or single crystal form

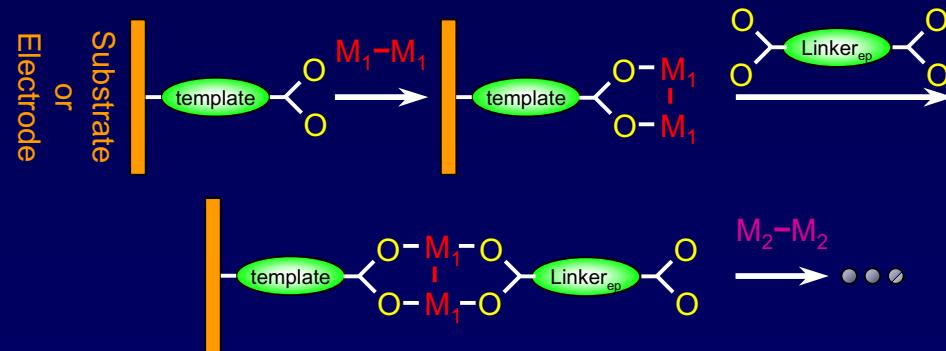
Metal-Metal Bonded Supramolecules

Assembling Devices::

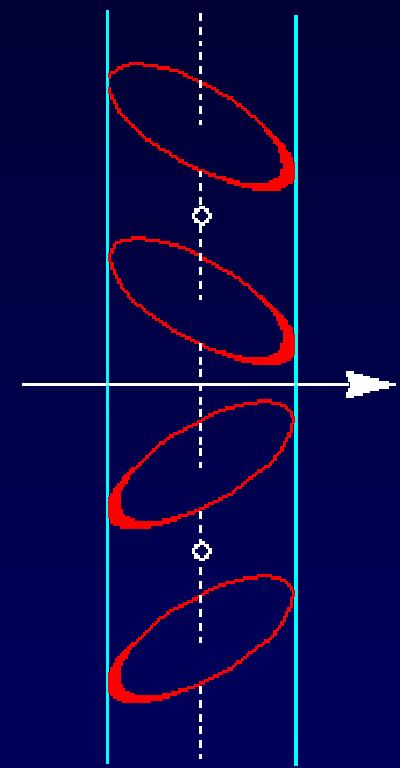
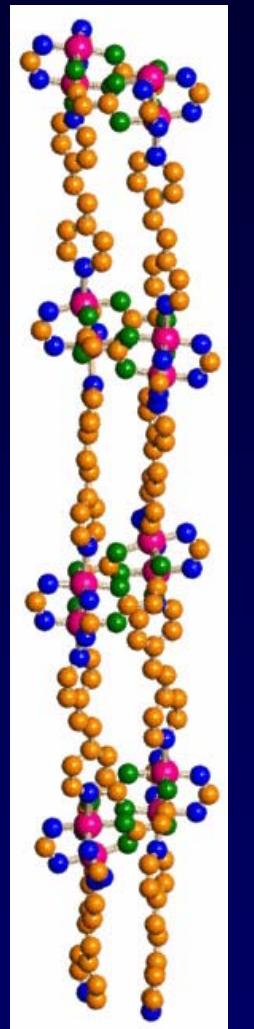
- 1 Link axially, functionalize equatorial positions



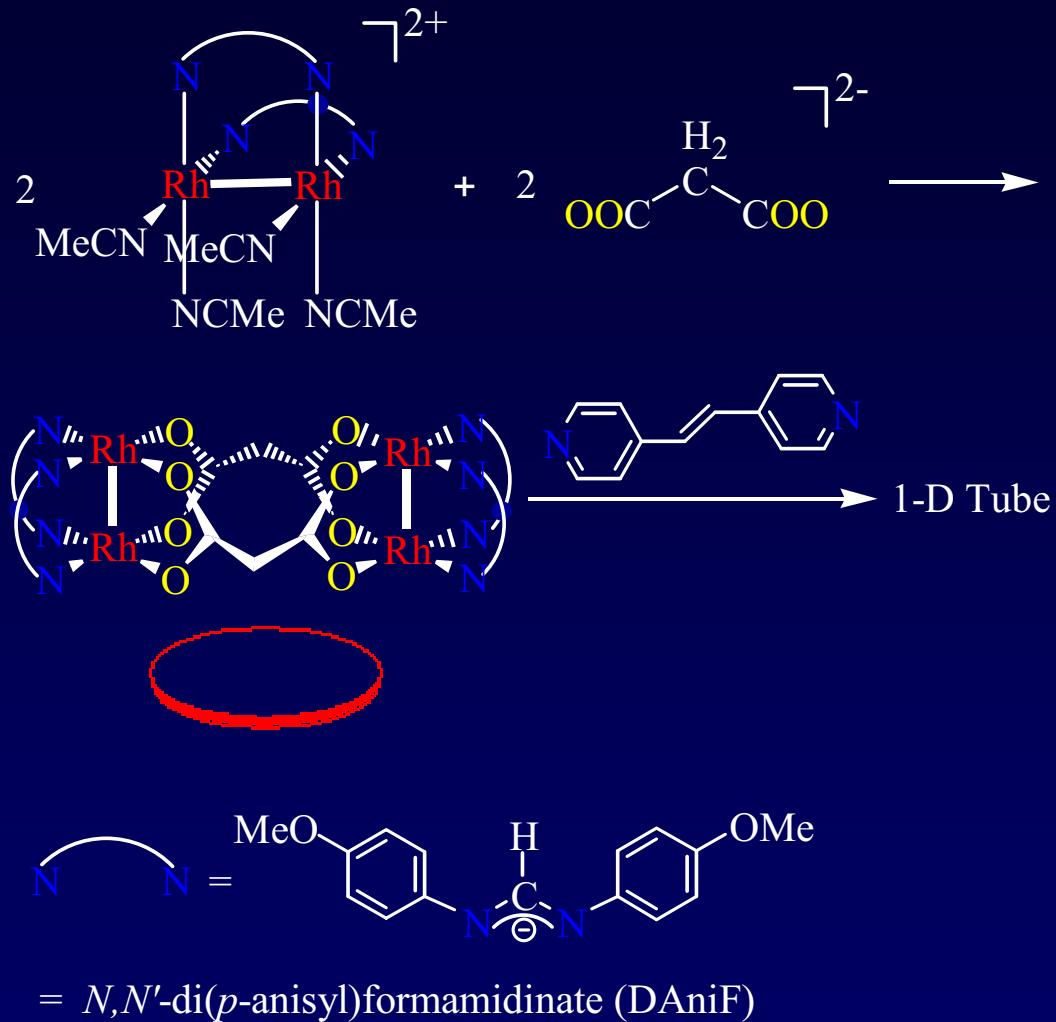
- 2 Link equitorially, functionalize axial positions



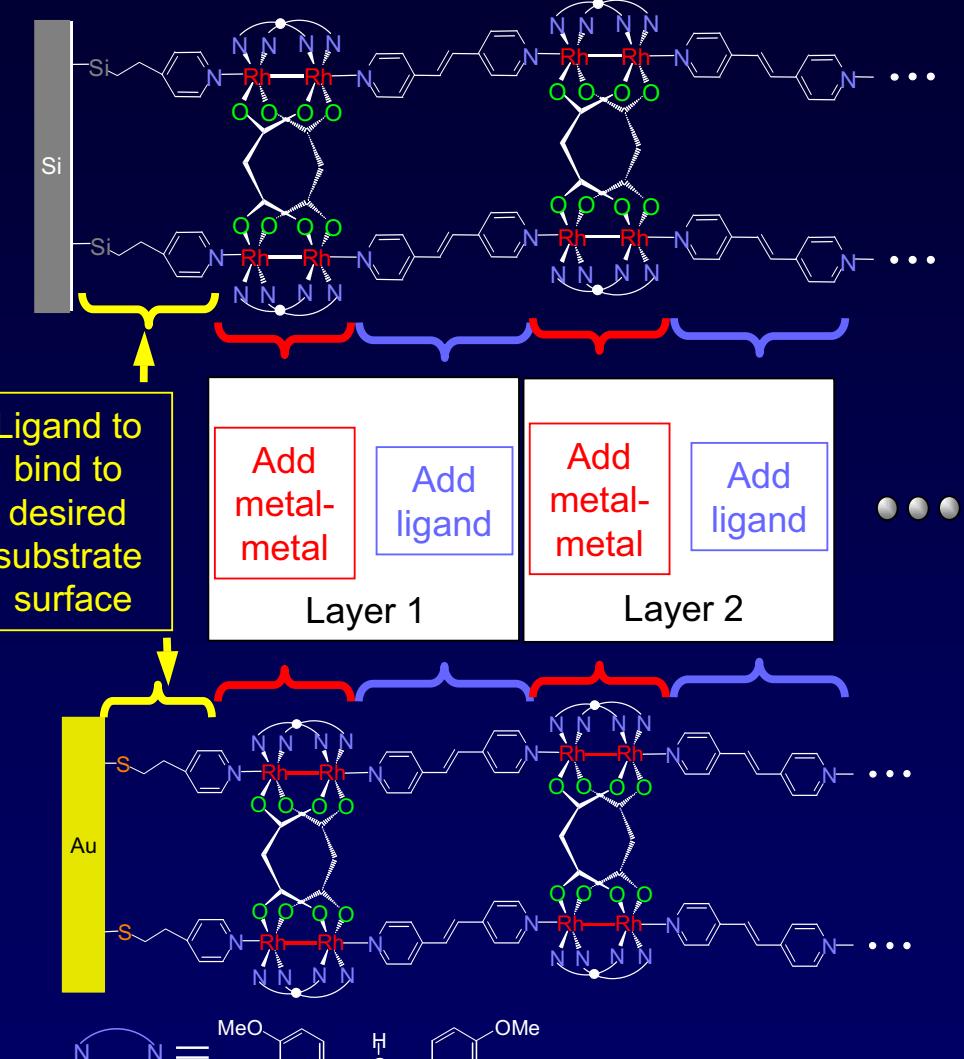
Molecular Tube



○ = inversion center
→ = twofold axis



Layer-By-Layer Growth of Metal-Metal Bonded Compounds



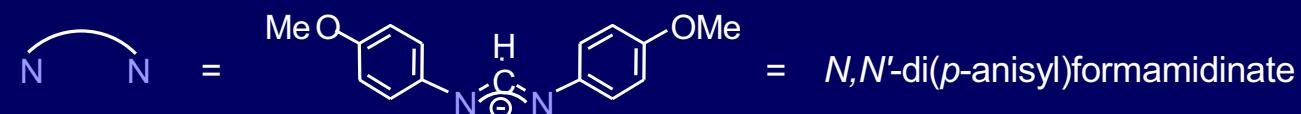
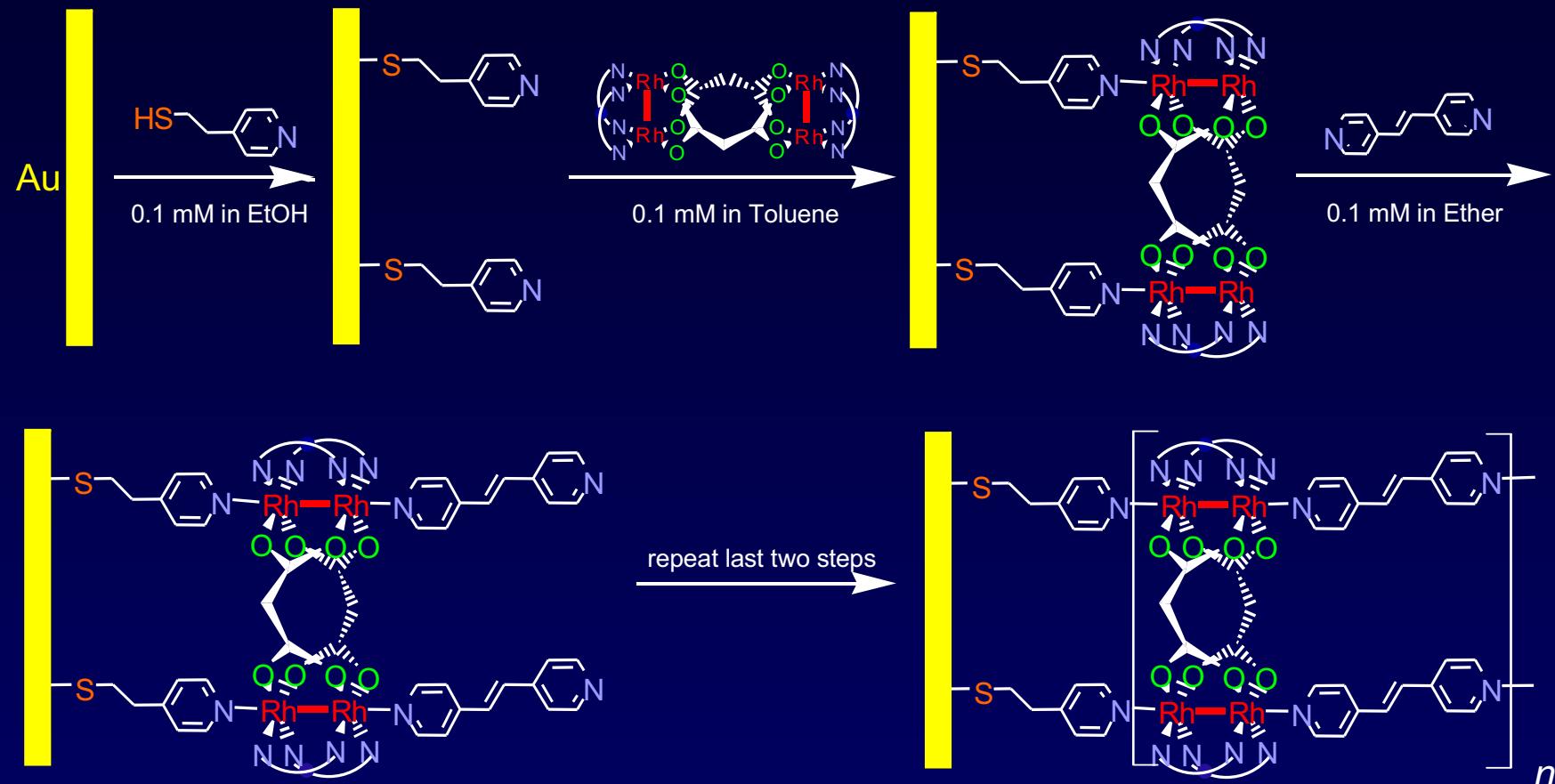
Tailor head group of ligand
to bind to
particular substrate surface

Tailor end group
to template
metal-metal bonded unit

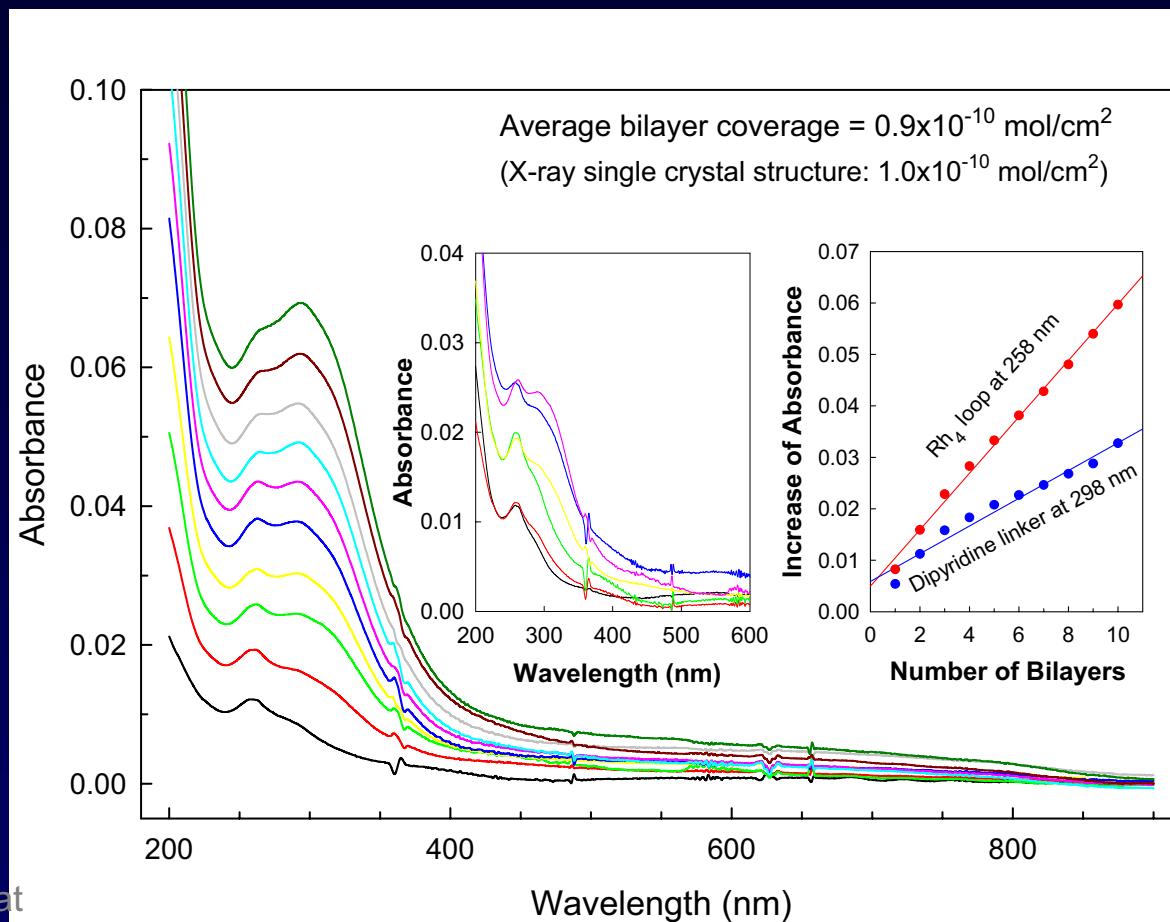
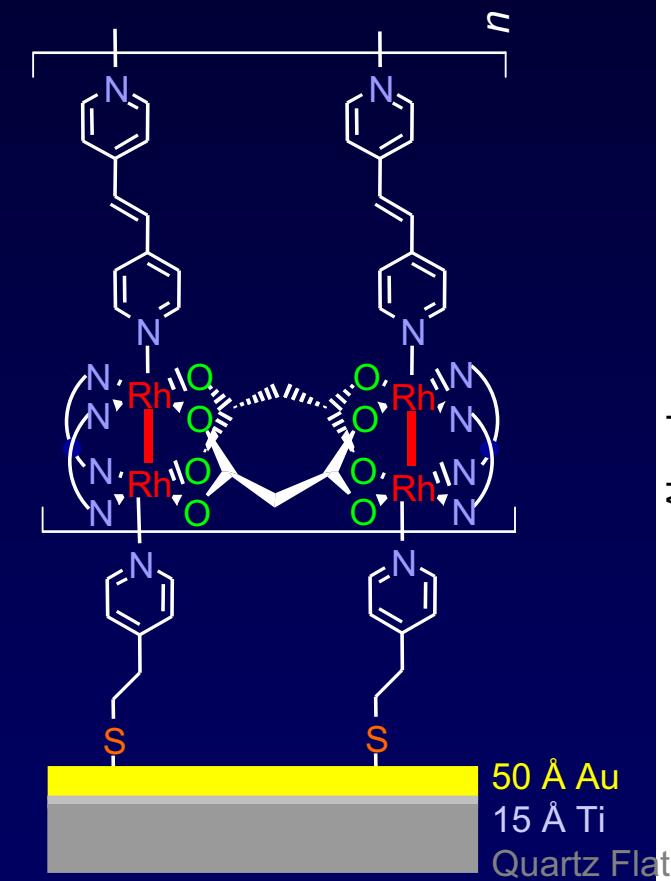
Choose M-M bond

Choose ligand to bridge
M-M bonded units

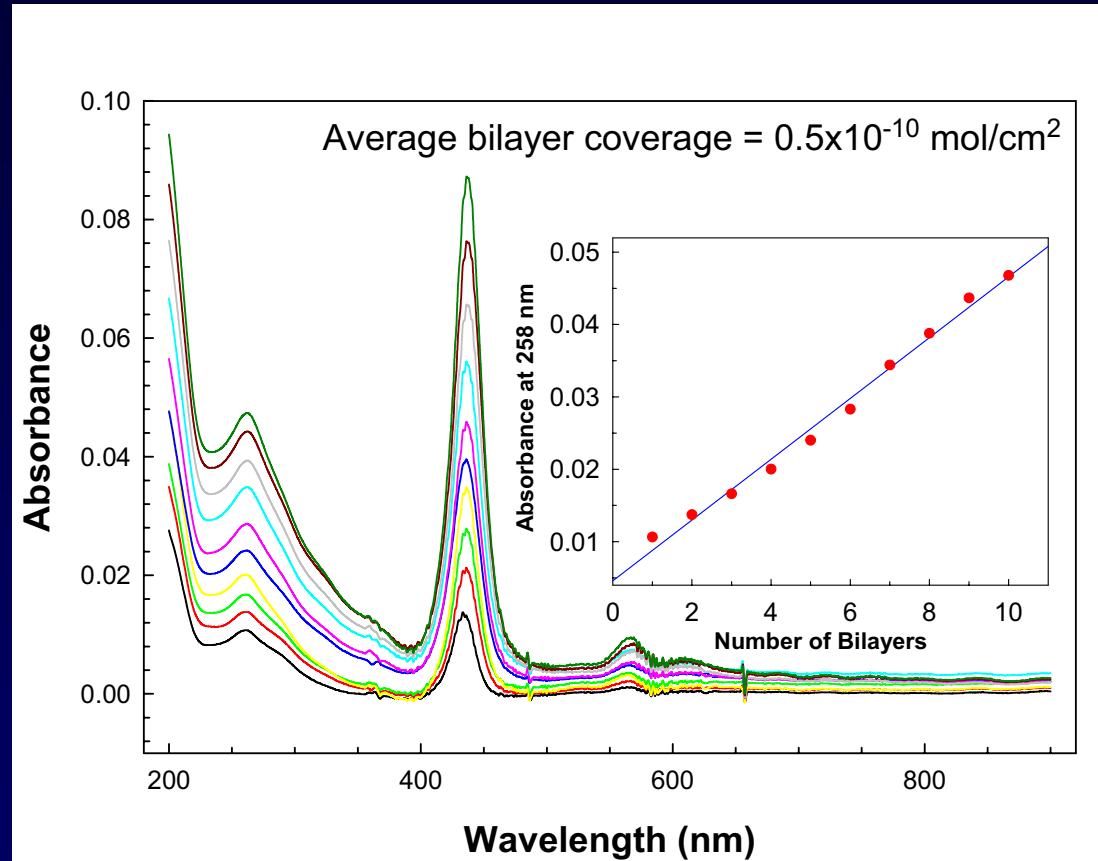
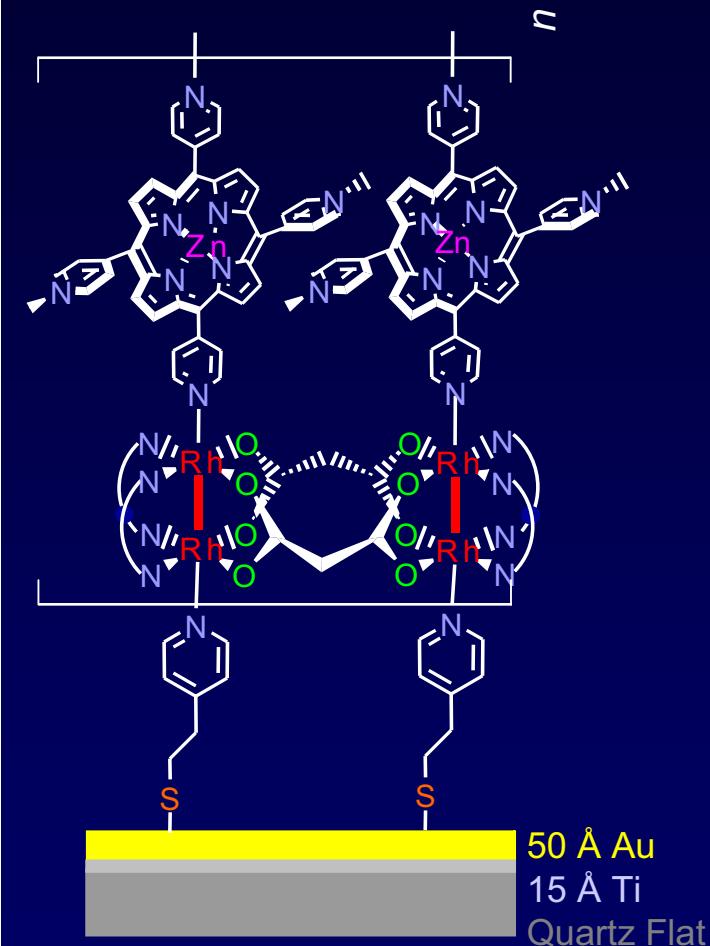
Synthetic Steps for Layer-By-Layer Growth



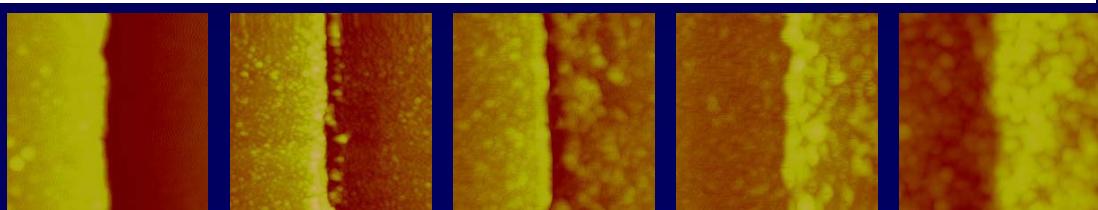
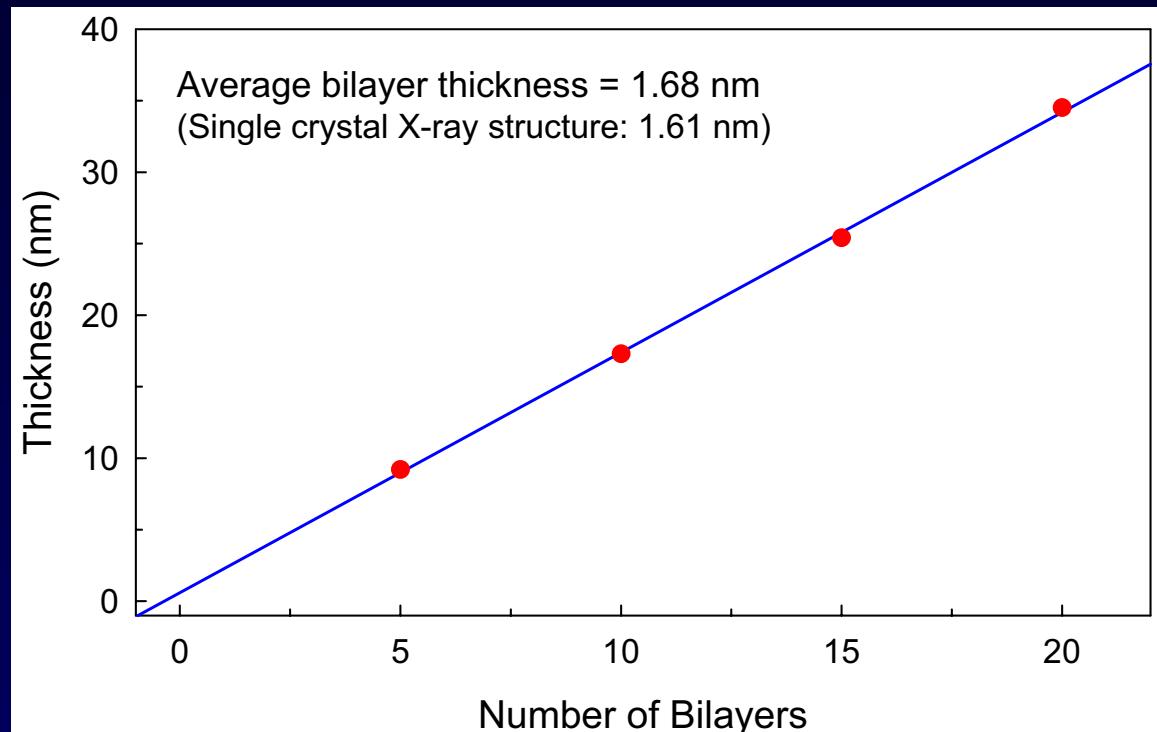
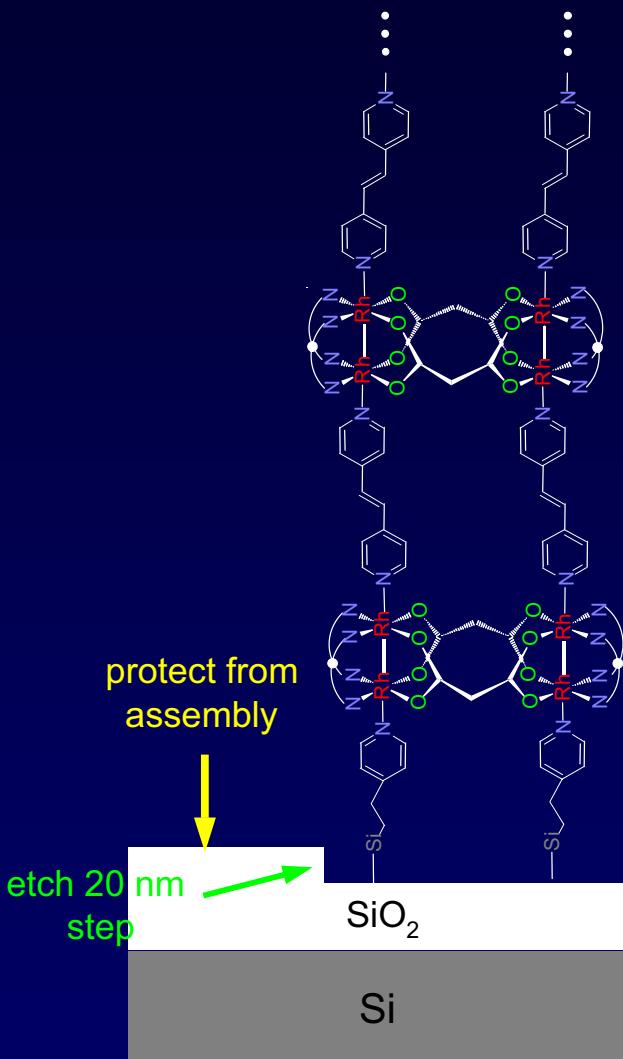
Monitor Layer-By-Layer Growth by UV-vis Absorption



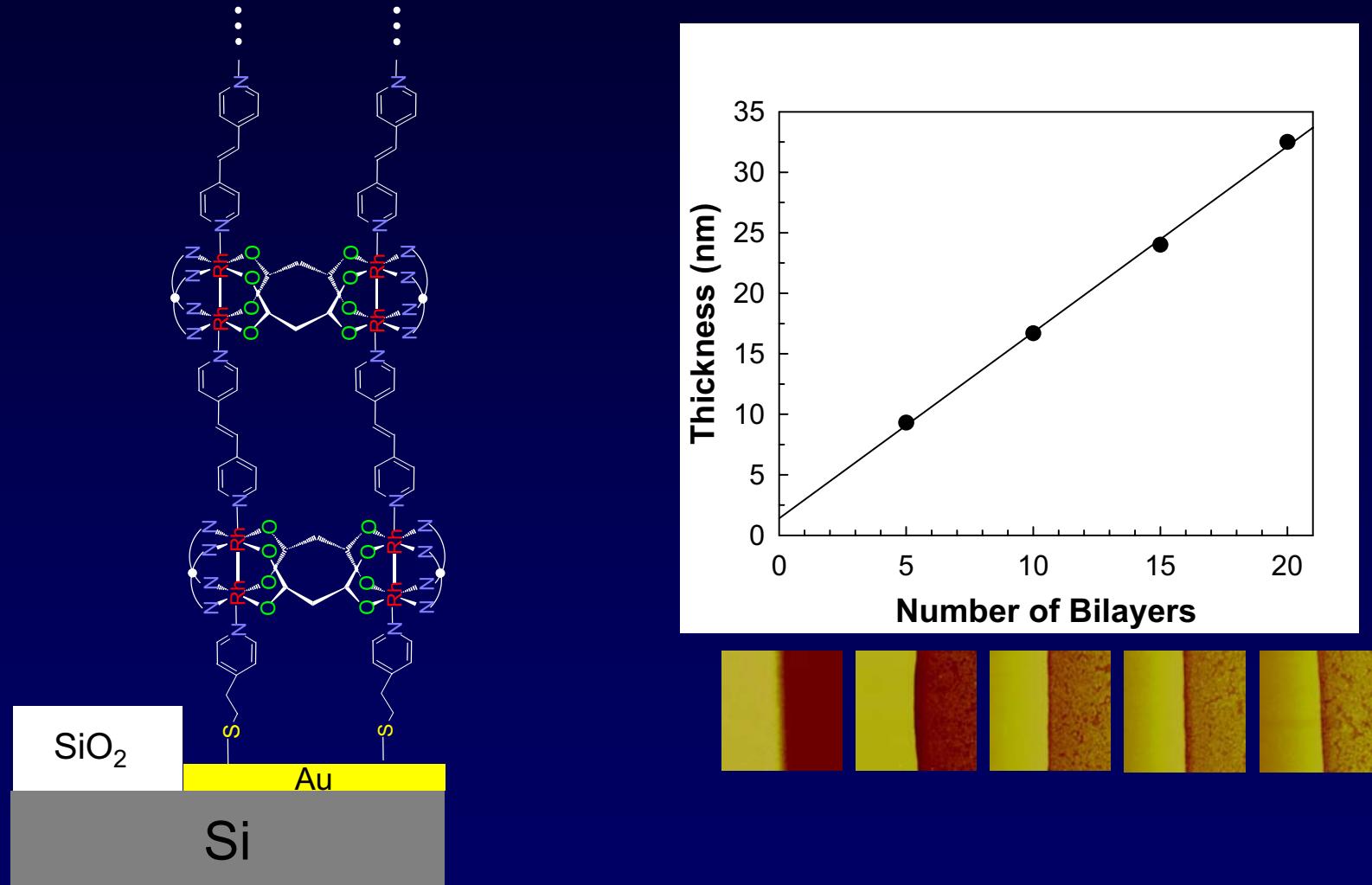
Monitor Layer-By-Layer Growth by UV-vis Absorption



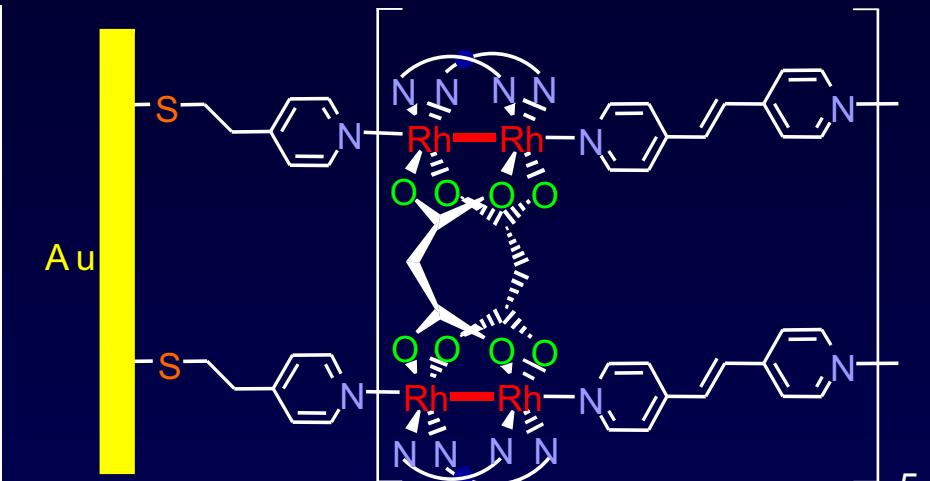
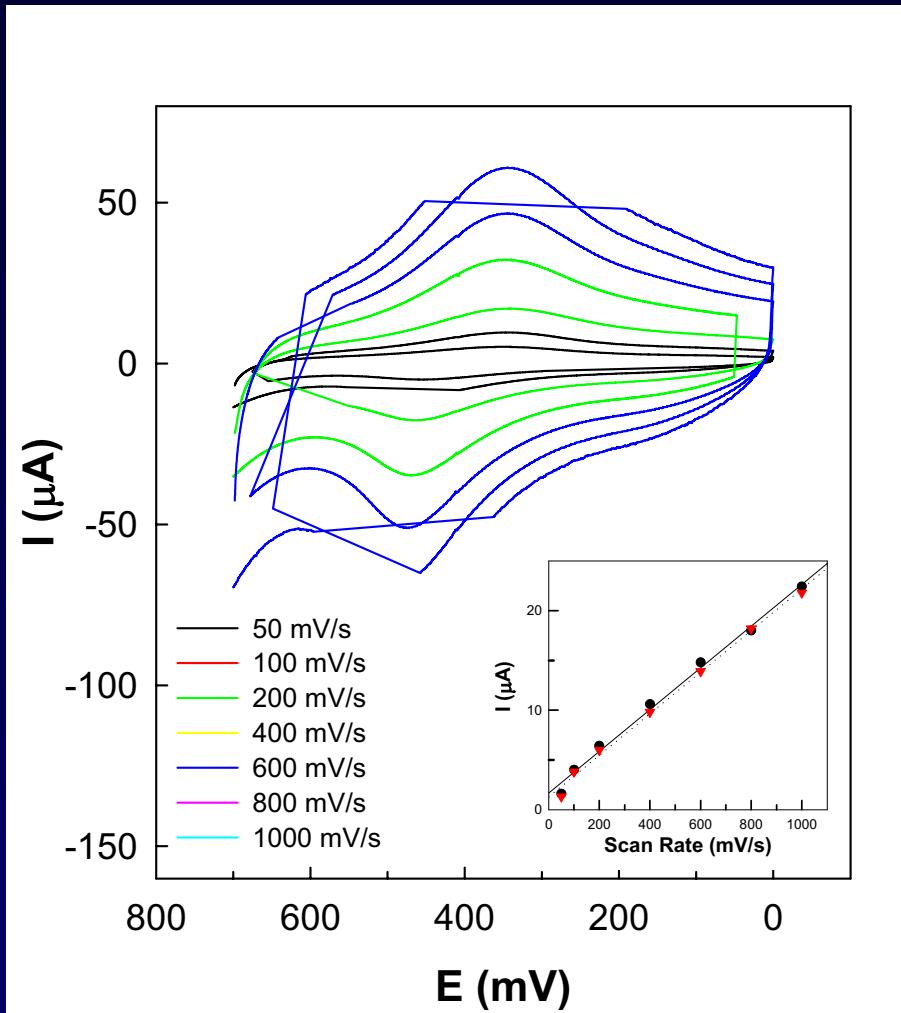
Monitor Layer-By-Layer Growth via AFM on SiO_2



Monitor Layer-By-Layer Growth via AFM on Au

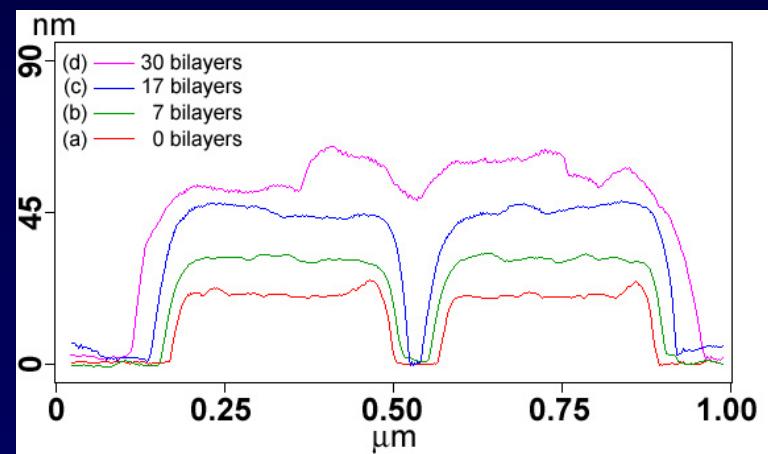
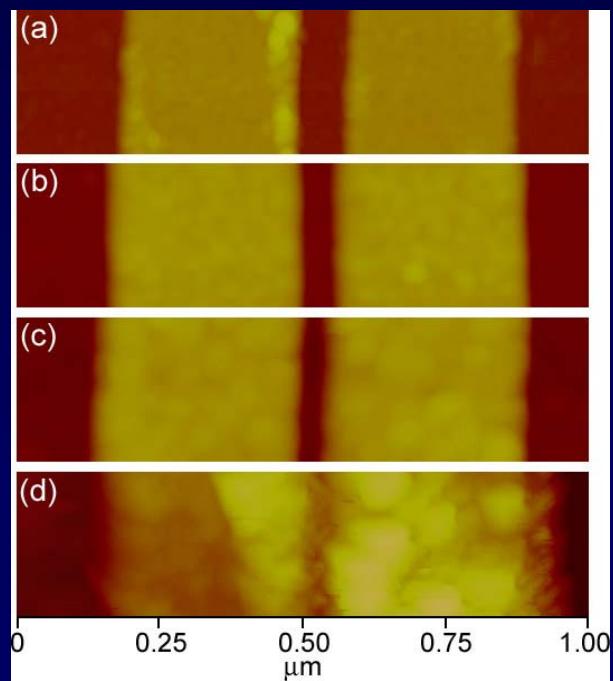
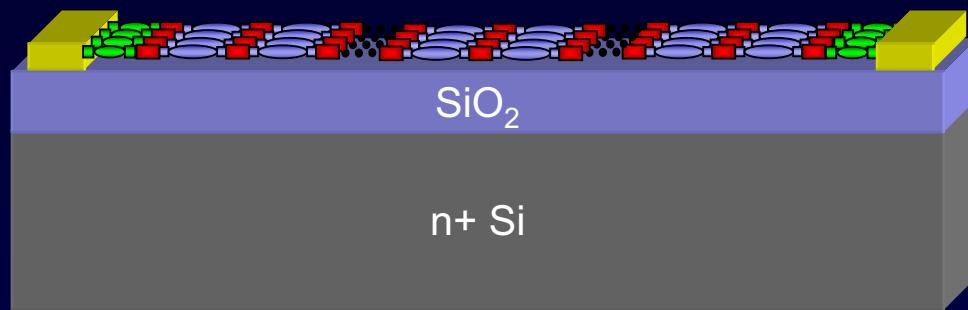


Electrochemistry of Metal-Metal Bonded Layers



- $i_p \propto v$
- $E_p \neq f(v)$
- $E^\circ = 406 \text{ mV vs Ag/AgCl in 1M NaCl}$

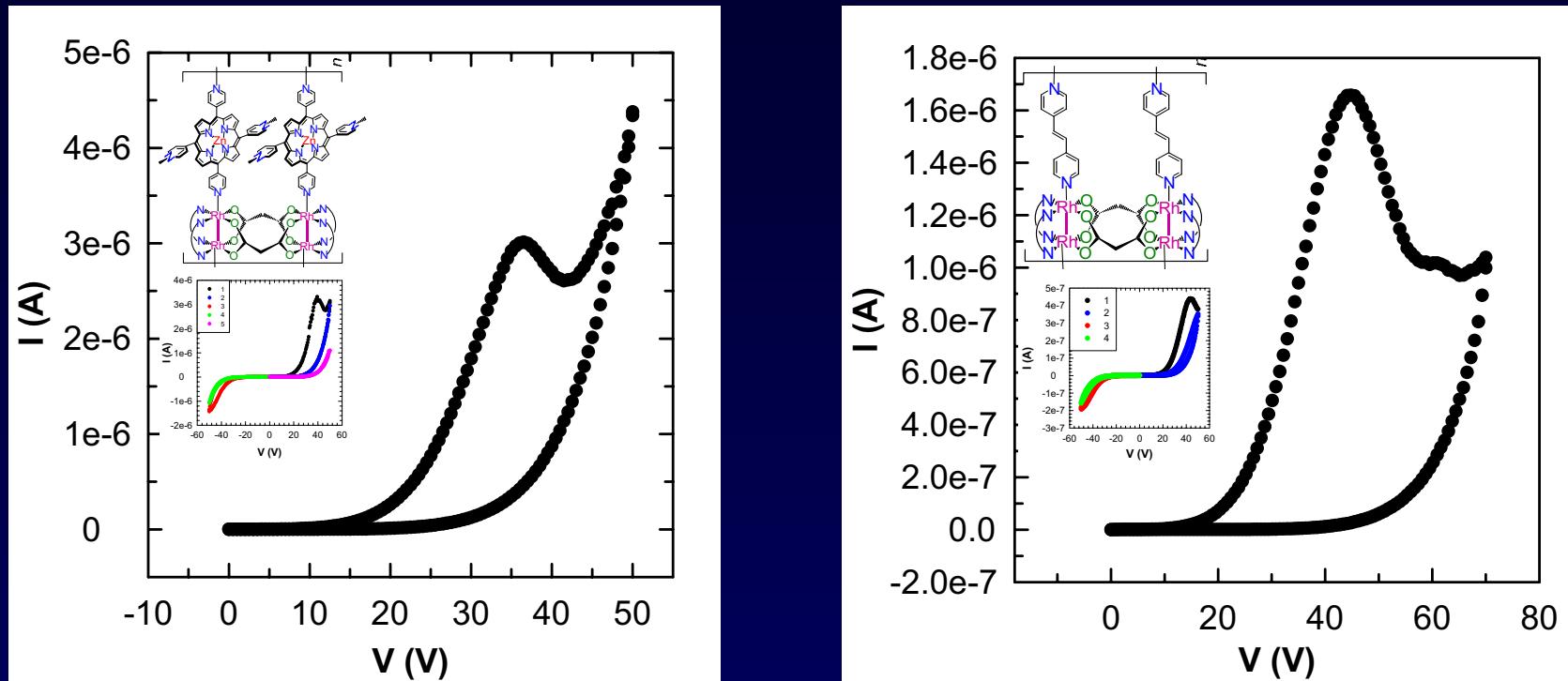
AFM images showing Layer-by-Layer Growth Across nm Scale Electrodes



Axial Linker

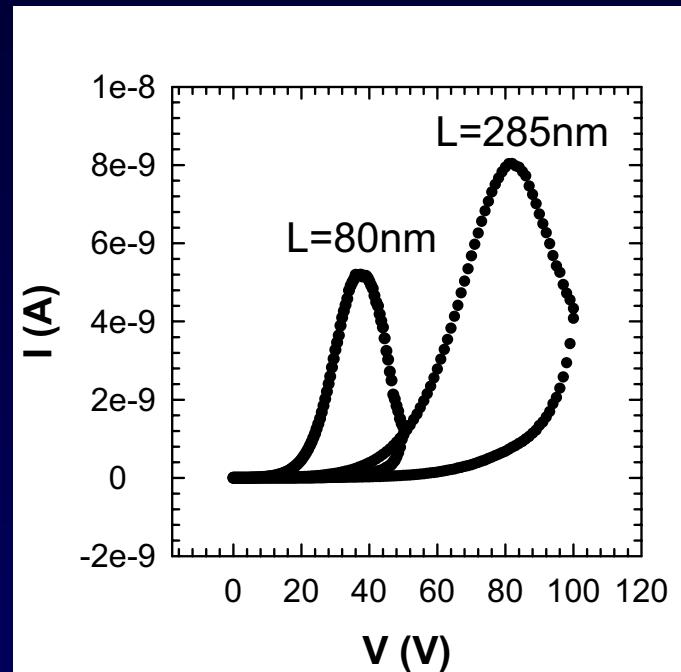
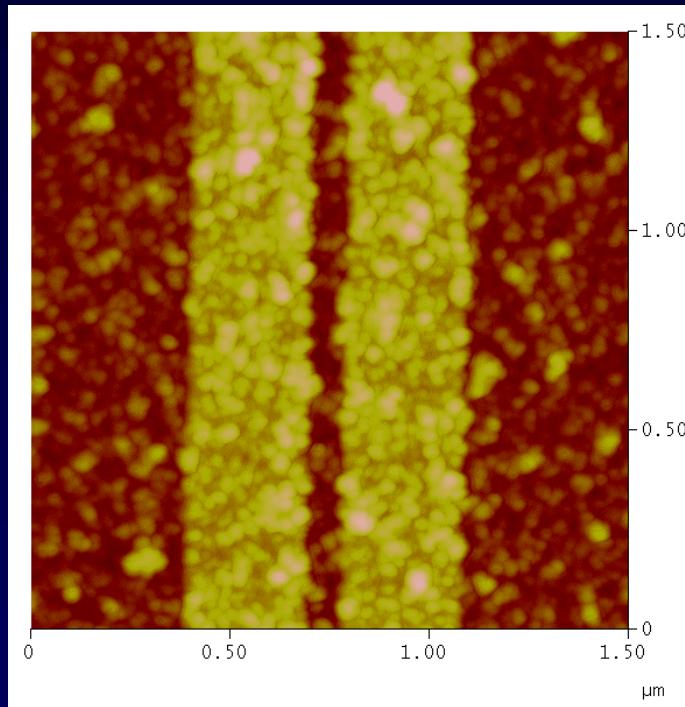
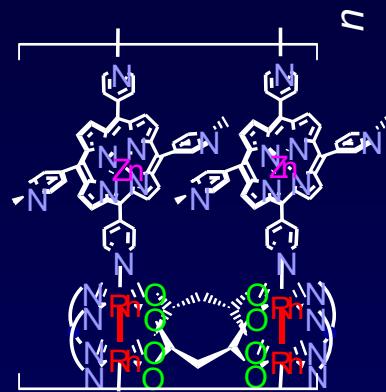


I-V Characteristics of Rh-Rh Supramolecules Grown Layer-by-Layer Across Device Channel



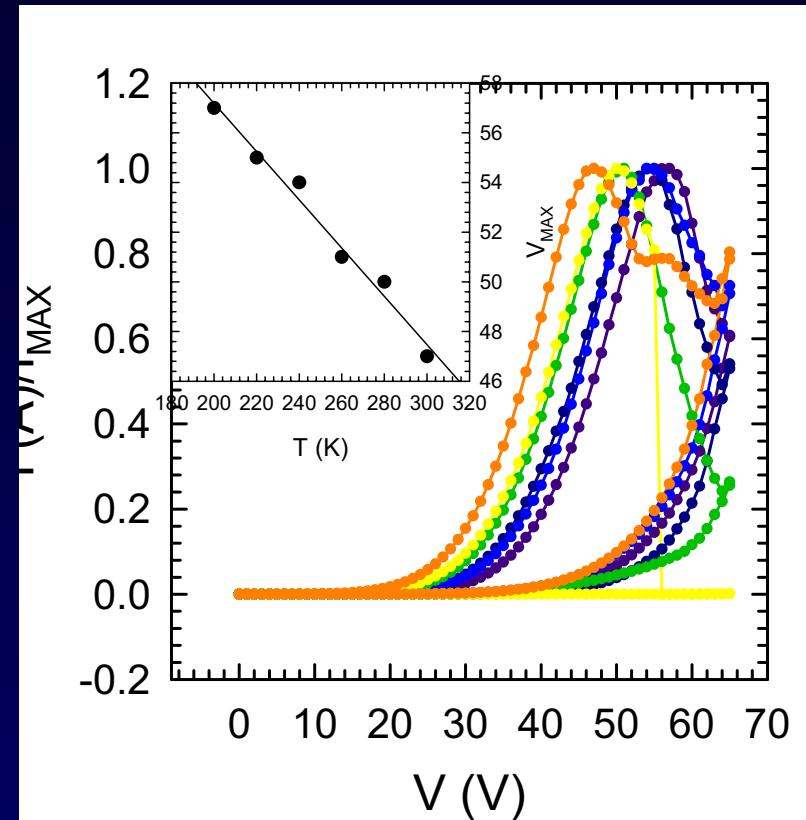
- Room Temperature
- Reproducible “Negative Differential Resistance”
 - Device-to-Device on Same Chip
 - Different Chip
 - Near Perfect Yield
- Not Reversible

Spin-coating Metal-Metal Bond Complex to Form Polycrystalline Thin Film

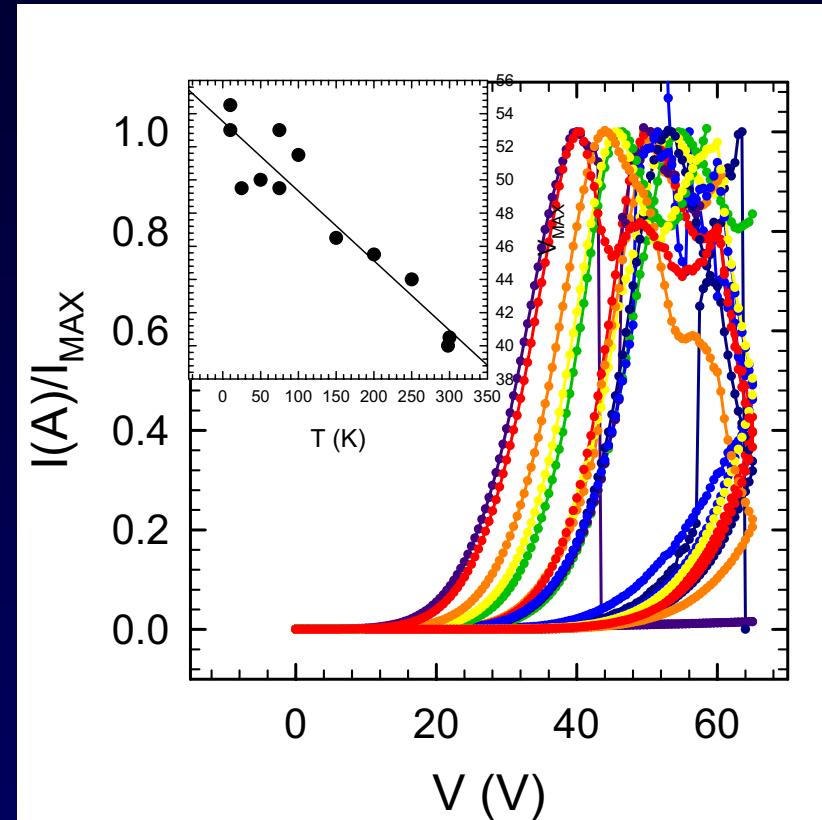


- compound assembles to form a polycrystalline thin film
- grain structure characteristic of underlying structural motif
- I-V characteristic show similar behavior
- peak potential increases with increasing channel length

Temperature Dependent I-V Characteristics Rh-Rh Supramolecule with DipyridylEthylene Ligand



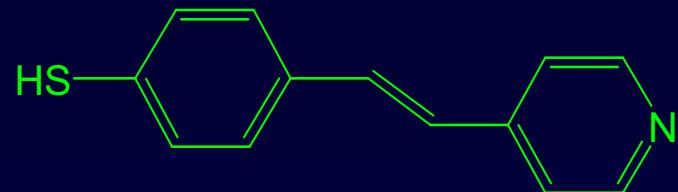
200-300K



5-300K

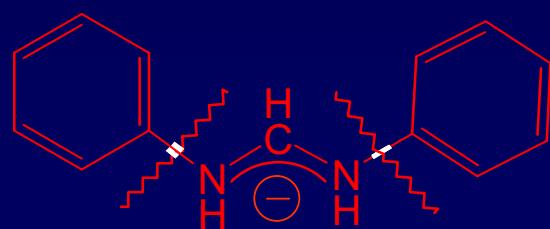
Chemical Manipulation : Examples

Surface Template – Molecule-Metal Contact



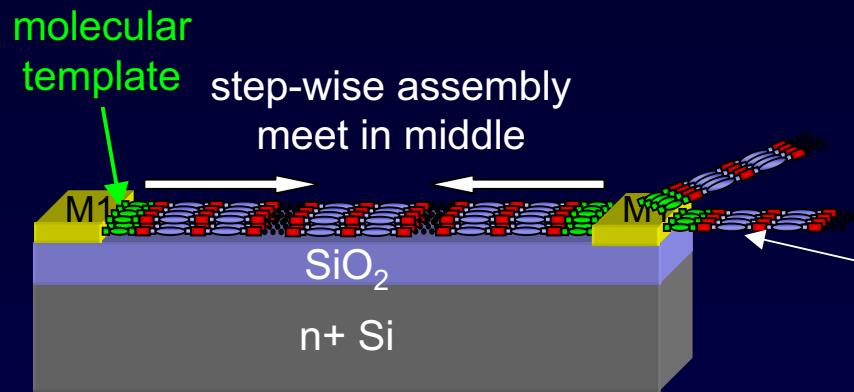
A. Afzali

Equatorial Ligands – “Switching” Potential, Receptors



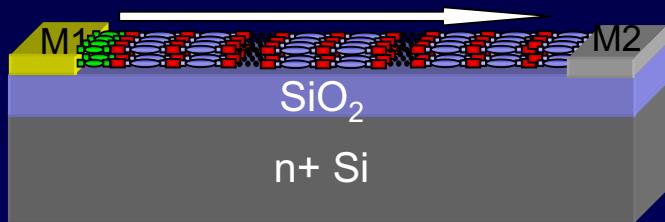
L. Vyklicky

Controlling Molecular Assembly through Device Geometry

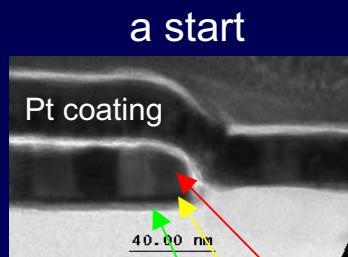


molecular material
assembles everywhere
off same metal surface

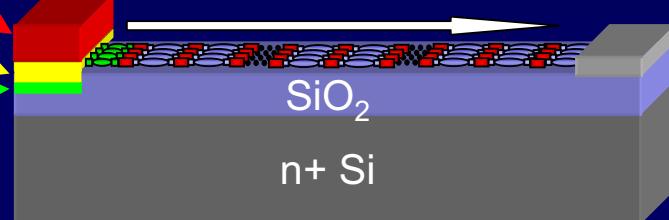
step-wise assembly
from one-side to the other



different metal electrodes



limit assembly to electrode
sidewall



embedded electrodes
hide adhesion layer
limit molecular assembly

control charge flow in device

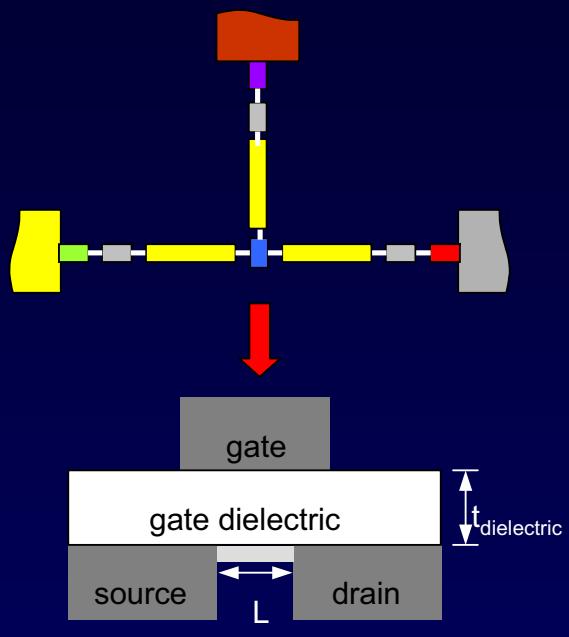
The Physics of Molecular Devices

Cherie R. Kagan

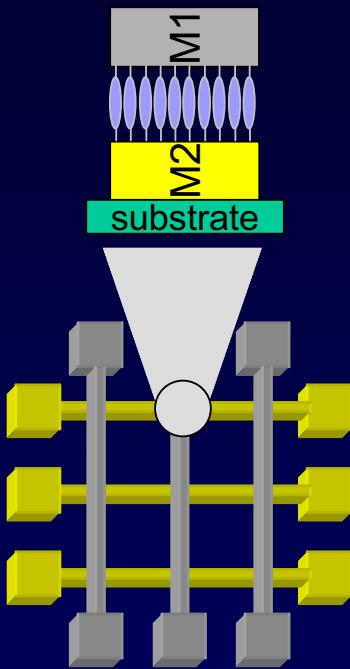
**IBM T. J. Watson Research Center
Yorktown Heights, NY**

Molecular Electronics, Memory, Sensors

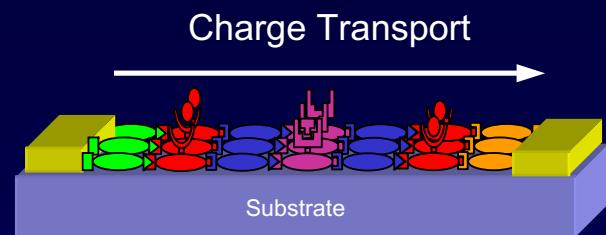
Transistors



Memory



Sensor

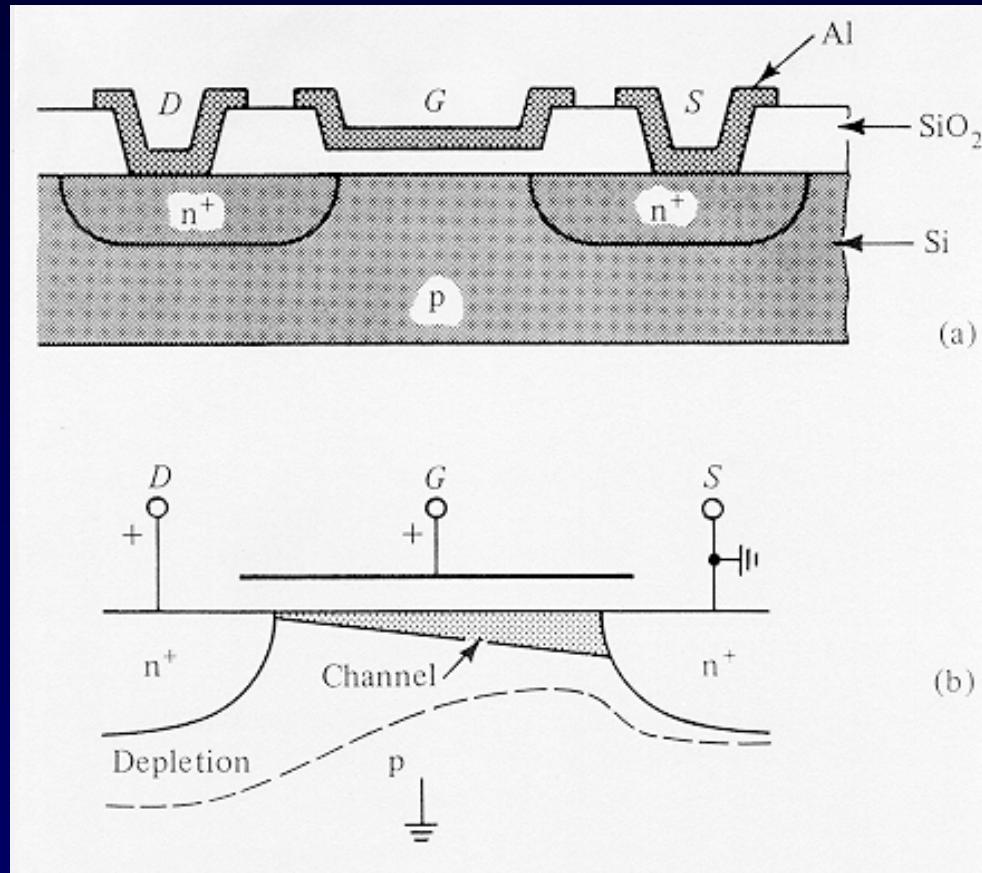


Molecular Electronics, Memory, and Sensors
Opportunity for Solid State Chemistry and Physics

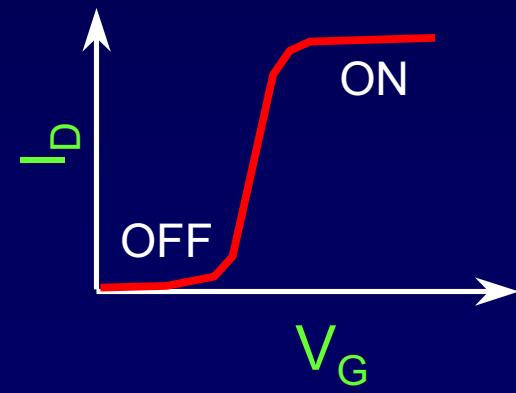
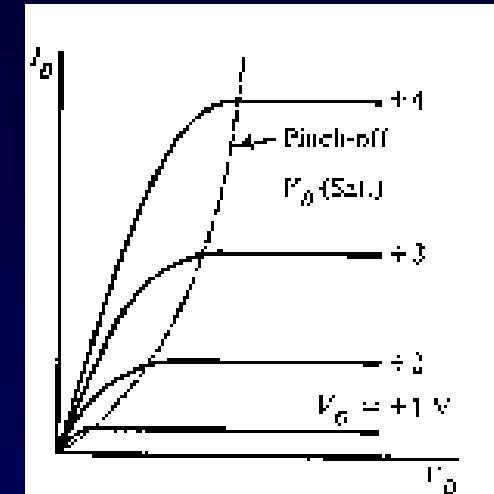
Understand:

- Molecular design, assembly, and function
- Device Test Structures
- Use Chemistry to Build Devices

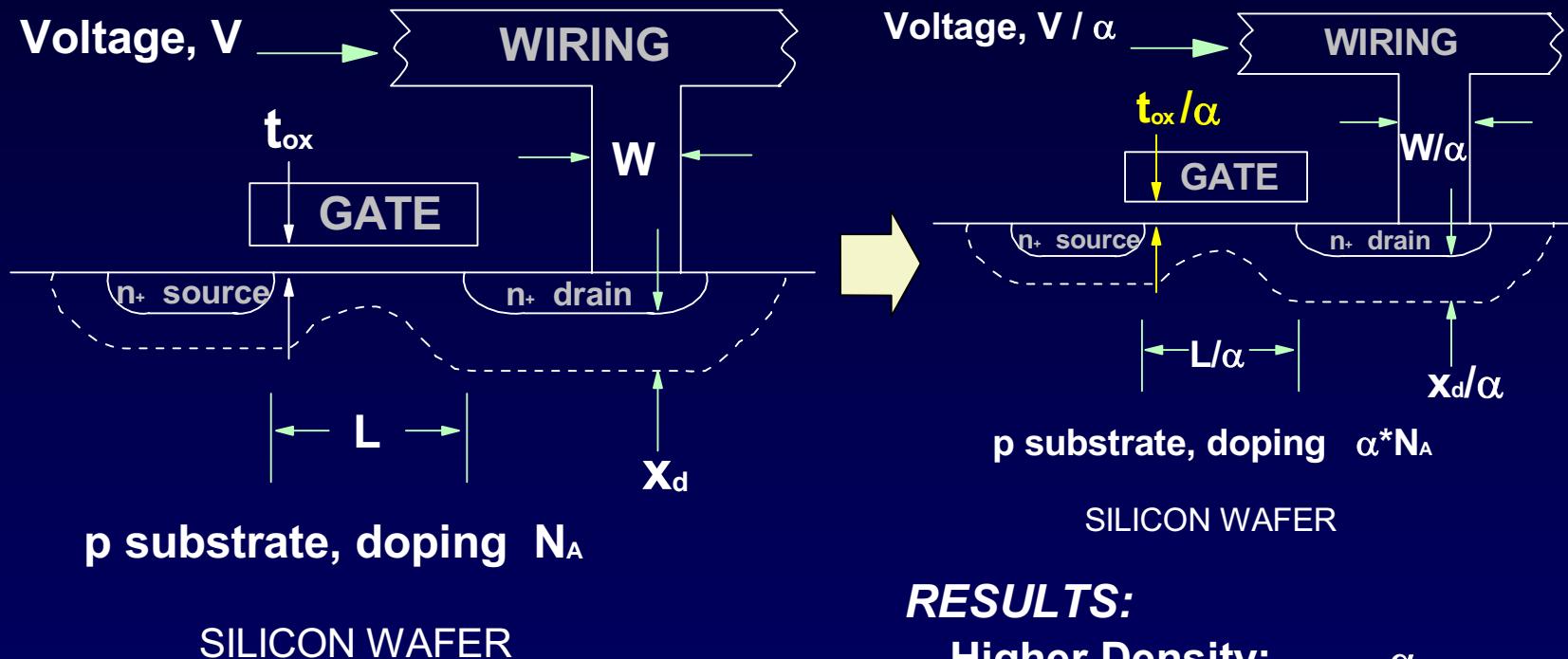
Metal-Insulator-Semiconductor Field Effect Transistor (MISFET)



Cross section and schematic illustration
of a MOS transistor.



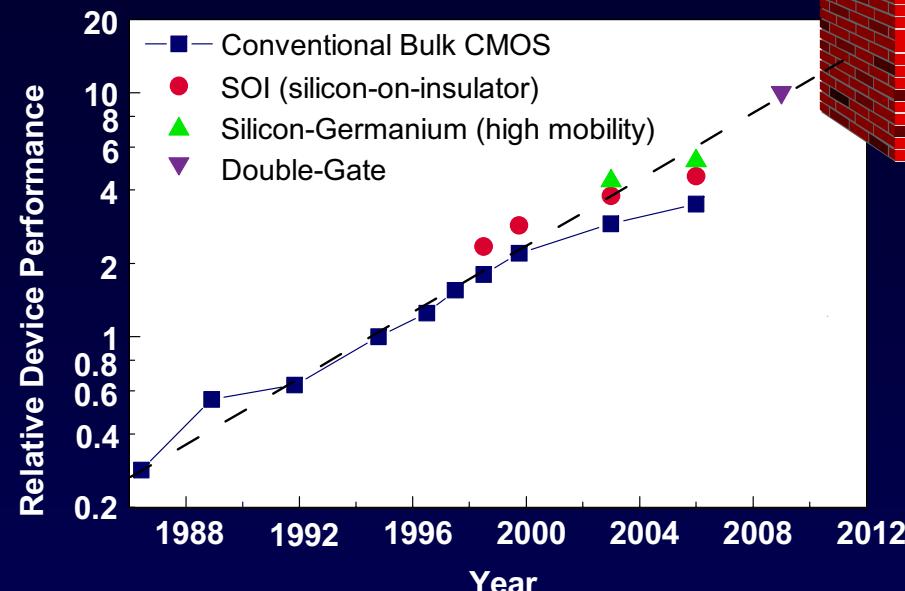
Transistor Scaling (Dennard Scaling)



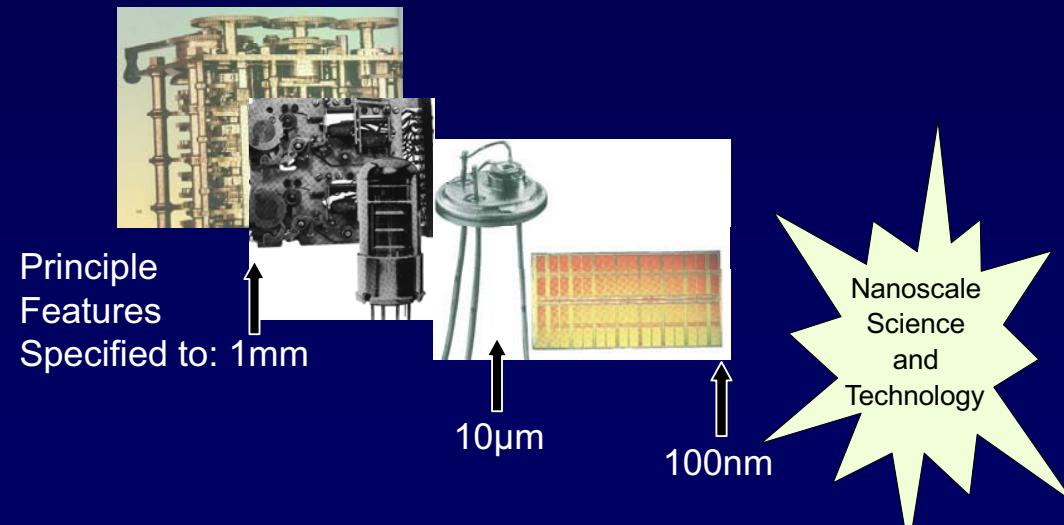
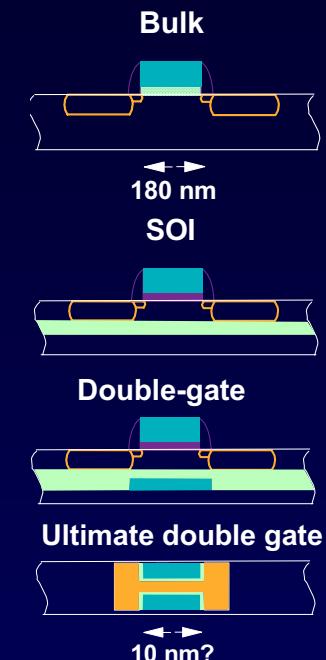
RESULTS:

- Higher Density: α_2
- Higher Speed: α
- Lower Power:
per circuit $1/\alpha_2$
- Power Density: Constant

Whats Next?



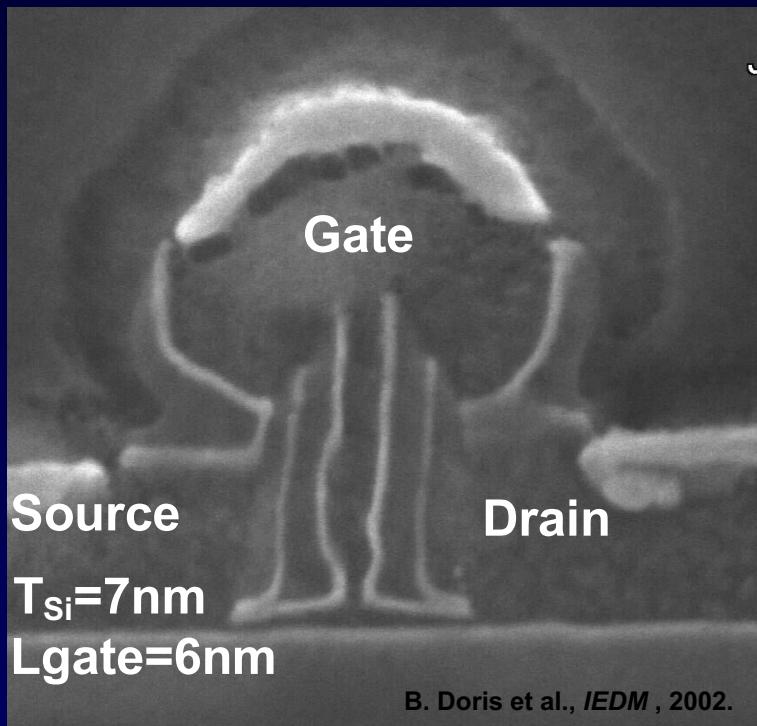
?
Molecular Electronics



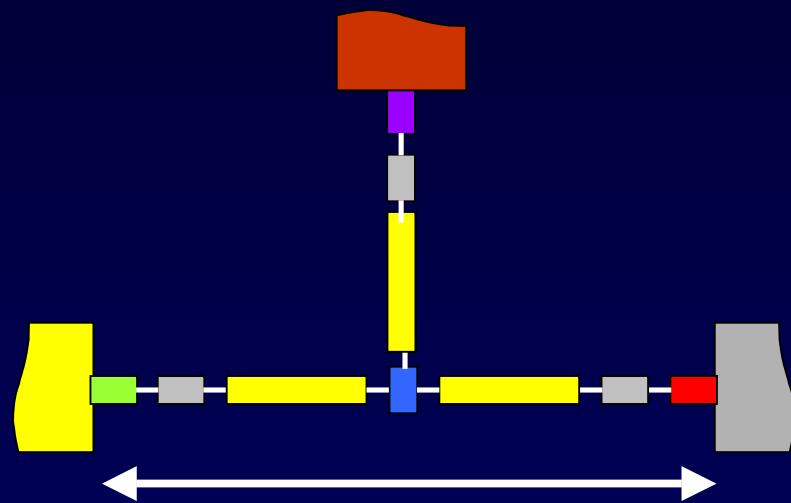
The Future is in
Nanoscale
Science, Materials,
and Devices

Its Not Only in Size, But Cost and Functionality

Si FET



Molecular Device

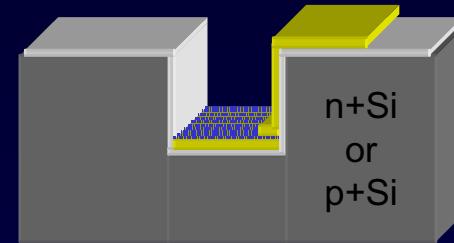


- Silicon and Molecular Devices are governed by electrostatics and eventually limited by tunneling
 - difficult to be much smaller than 2 - 3 nm

Colleagues

SAMFET:

Ali Afzali
Richard Martel
Lynne Gignac
Paul Solomon
Alex Schrott
Bruce Ek

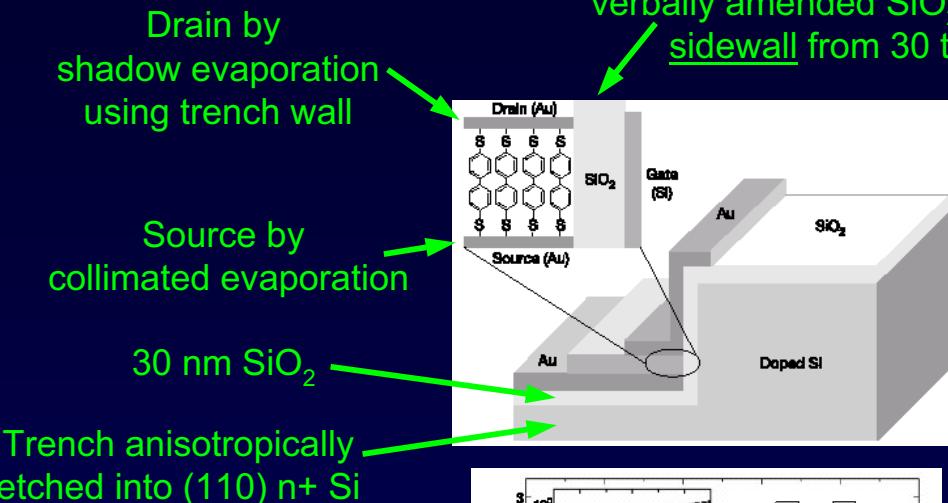


Contributions From:

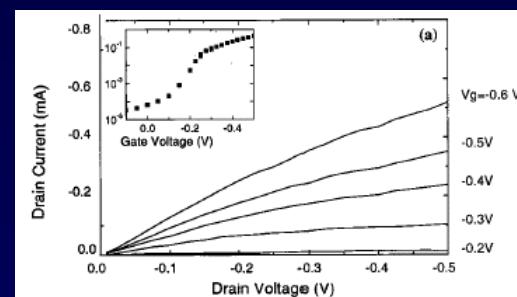
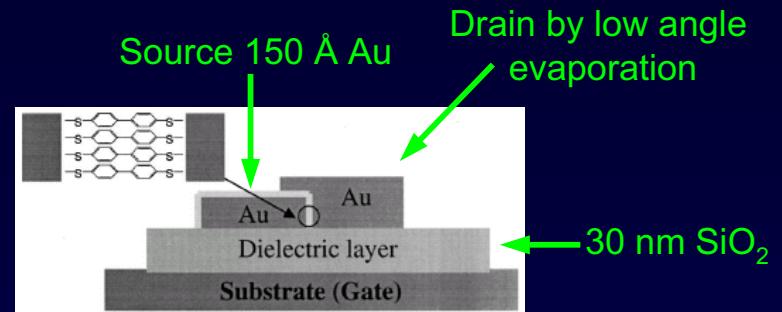
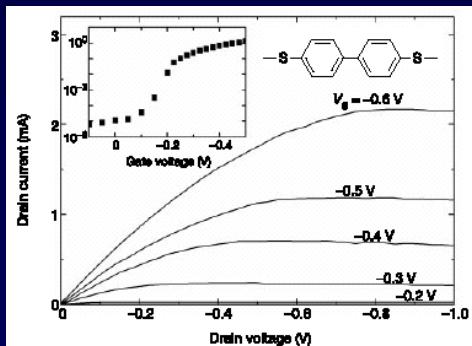
ASTL, Ying Zhang, CSS (Nina Ruiz), T. Domenicucci, Chun Lin
Frank Meyer zu Heringdorf, Mike Prikas, Dave Medeiros,
Vincent Derycke, Harry Hovel, Paul Andry, James Vishiconti

Special Thanks: Ruud Tromp, David Frank, Norton Lang, Phaedon Avouris,
Philip Wong

Self-Assembled Monolayer FETs?



Reported transconductance ~ 10 mA/V
Wow, that's better than Si Fets!



Cartoon:

- What do the structures really look like?
- Do dithiols form ordered/oriented monolayers?
- Can Au be deposited on the trench bottom without coating the sidewalls?

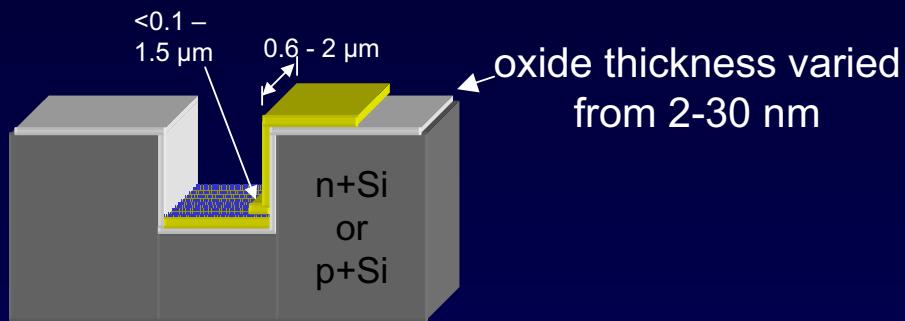
Device Mysteries:

- $L < t_{\text{dielectric layer}}$
 - Gate field penetrate channel?
 - Long channel behavior?
- At 0 V_g , the device is OFF ?
- Subthreshold slope better than kT/q ?

Device Structures - Trenches

Cross-section:

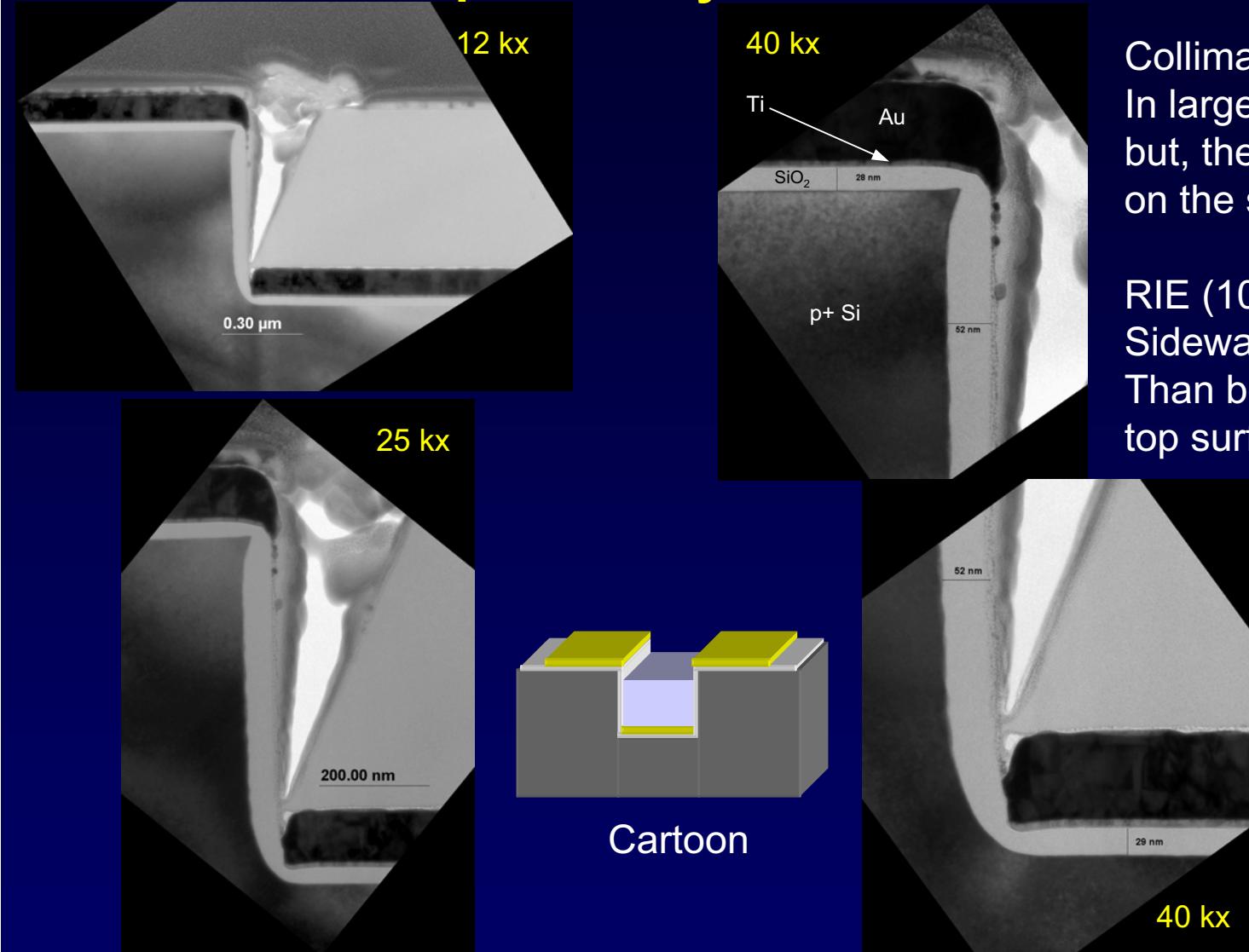
Channel dimensions depend
on which set of structures are chosen
as defined by mask sets



Two approaches:

1. RIE using (100) p+ Si
(note difficult to RIE vertical sidewalls in n+ Si, too much lateral etching)
2. Wet chemical etch into (110) n+ Si
(note can't wet etch into p+ Si)

TEM Images of RIE Trench with Bottom Electrode Deposited By Collimated Source

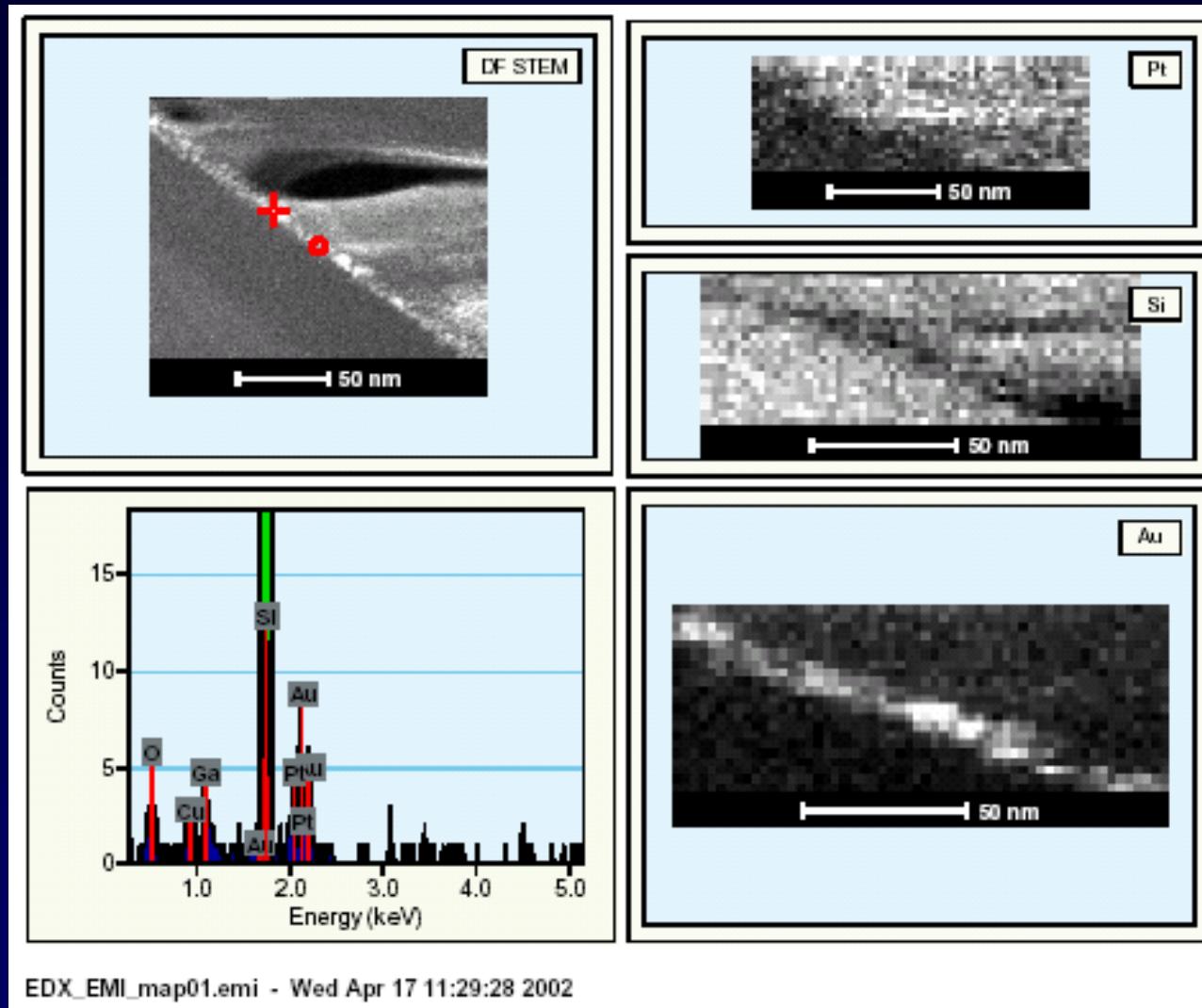


Collimation :

In large part, it is good
but, there are particulates
on the sidewall

RIE (100)
Sidewall ~1.8x thicker
Than bottom and
top surface

EDS Data of Gold Electrode in RIE Trenches

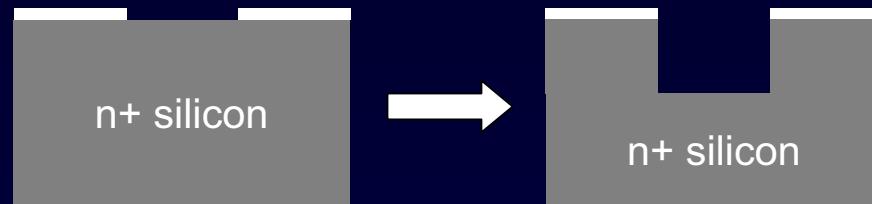


Pt is used to FIB
the structure

Sidewall is rotated
from
12 to 4'oclock
in images

Au is on sidewall
although not
continuous

(110) Trenches: KOH Anisotropic Etch



Alignment within $\pm 0.1^\circ$ necessary

- wafer flat cut accurate to $\pm 0.5^\circ$
- Two stage process: alignment pattern first be etched to accurately locate $\{-1,1,1\}$

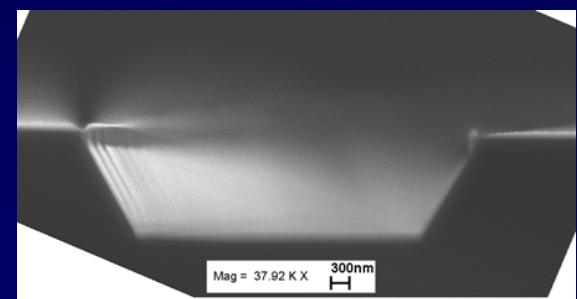
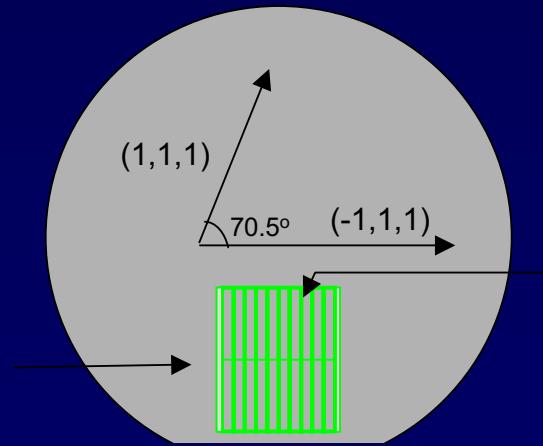
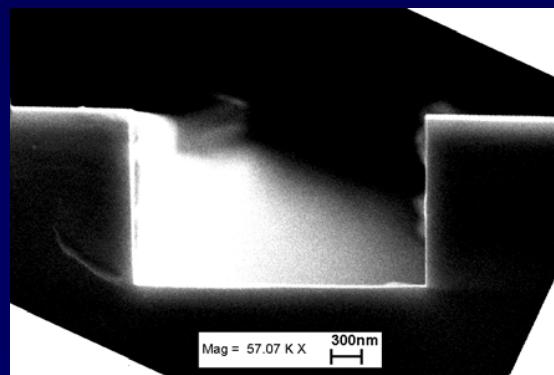
Small misalignment produces:

- Lower aspect ratio (h/L)
- Non-vertical sidewalls

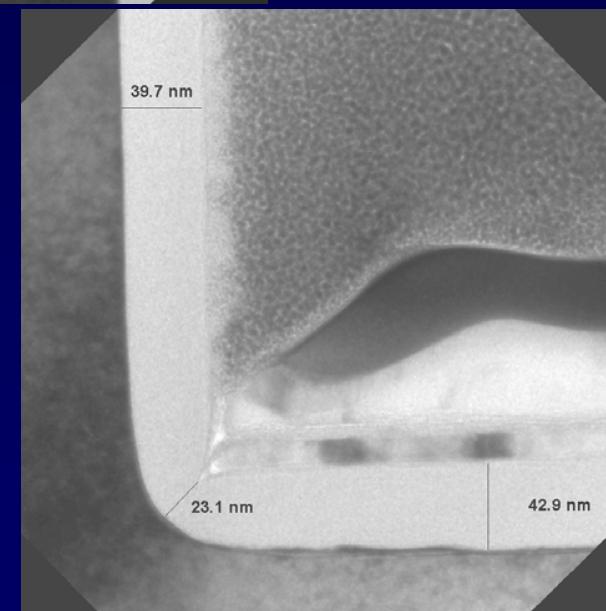
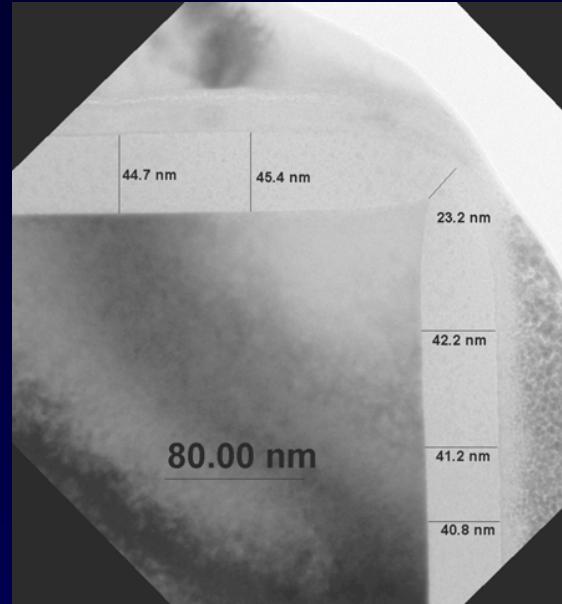
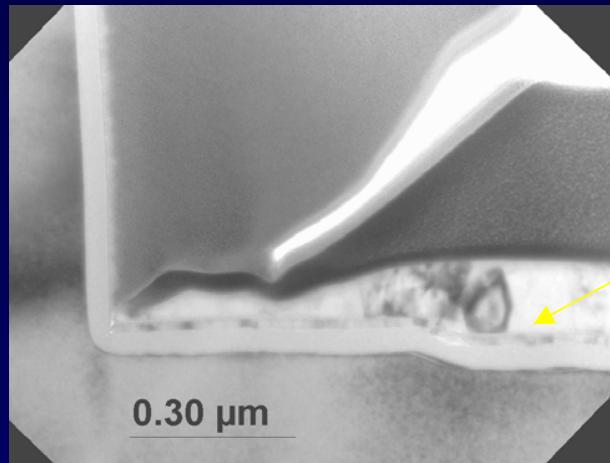
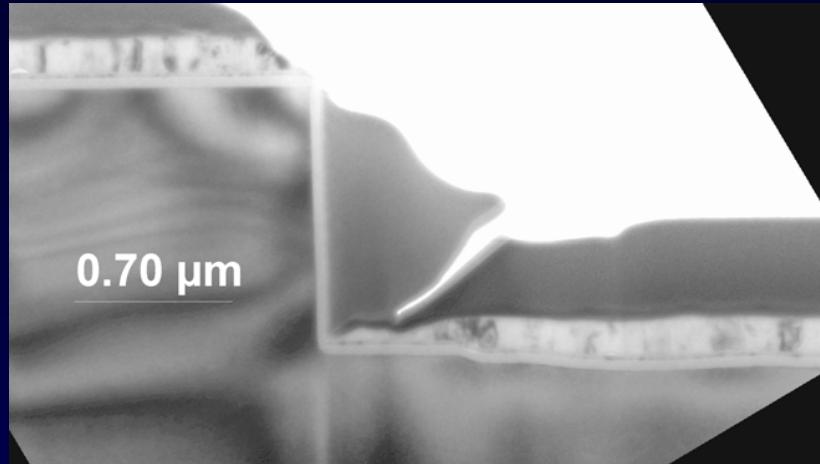
Additional requirements for high aspect ratio and finish:

- High KOH concentration = 44% (isopropanol added to improve surface finish)
- Rate and finish strongly dependent on:
 - Temperature of bath
 - Agitation (avoid bubble formation at Si surface)

Alignment of mask with the $\{-1,1,1\}$ plane is critical



(110) Trench After Oxidation

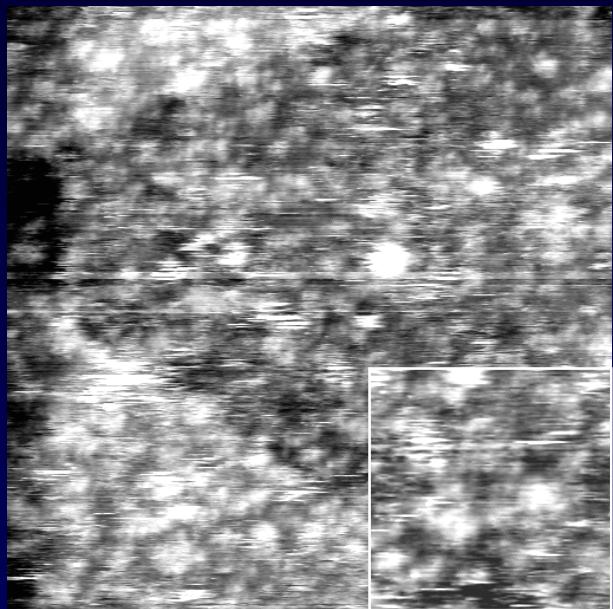


Aim: 30 nm oxidation, always greater in n+ Si than on n, p, or p+ Si

Conclusion: $t_{\text{oxide}}(\text{sidewall}) \sim t_{\text{oxide}}(\text{top/bottom})$

STM of 1,1'-biphenyl-4,4'-dithiol and hexanethiol Assembled on Flame-Annealed Au/Mica

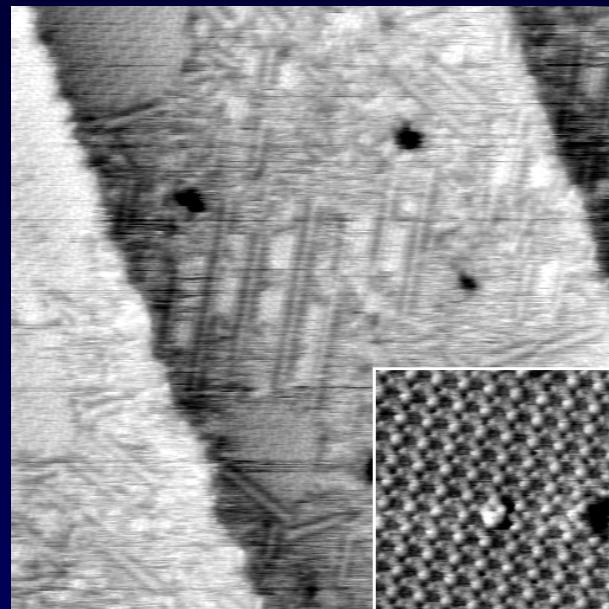
1,1'-biphenyl-4,4'-dithiol



60 nm

5 nm

hexanethiol

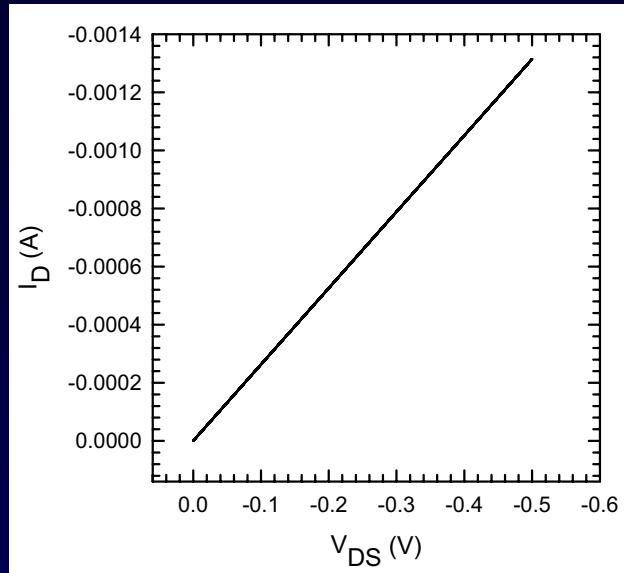


50 nm

10 nm

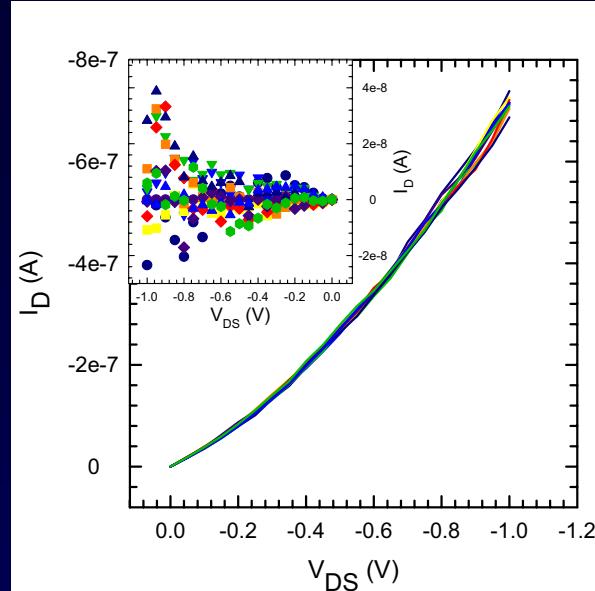
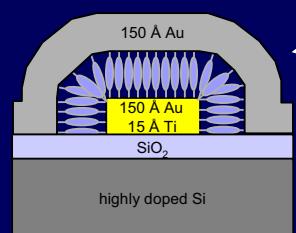
- biphenyldithiol bound to surface, but not well-ordered
- disorder in dithiols consistent with literature
- disorder in biphenylthiols consistent with literature

Trench Structure with 1,1'-biphenyl-4,4'-dithiol



“Monolayer”

characteristics of hundreds of devices
in the trench structure
and thousands in the planar structure



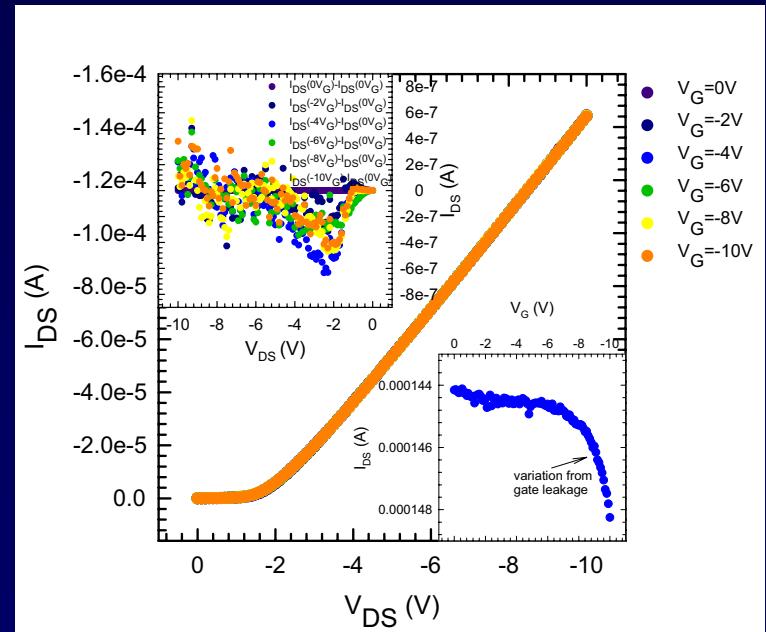
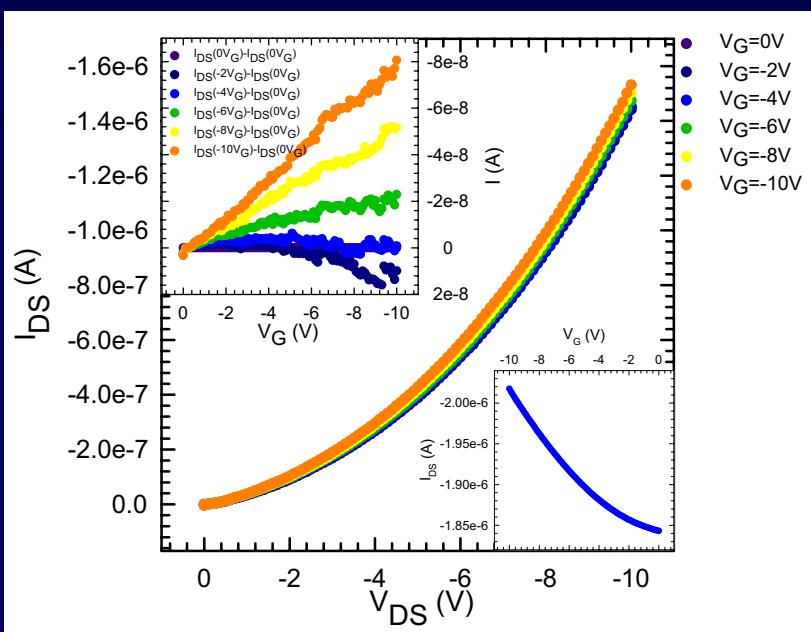
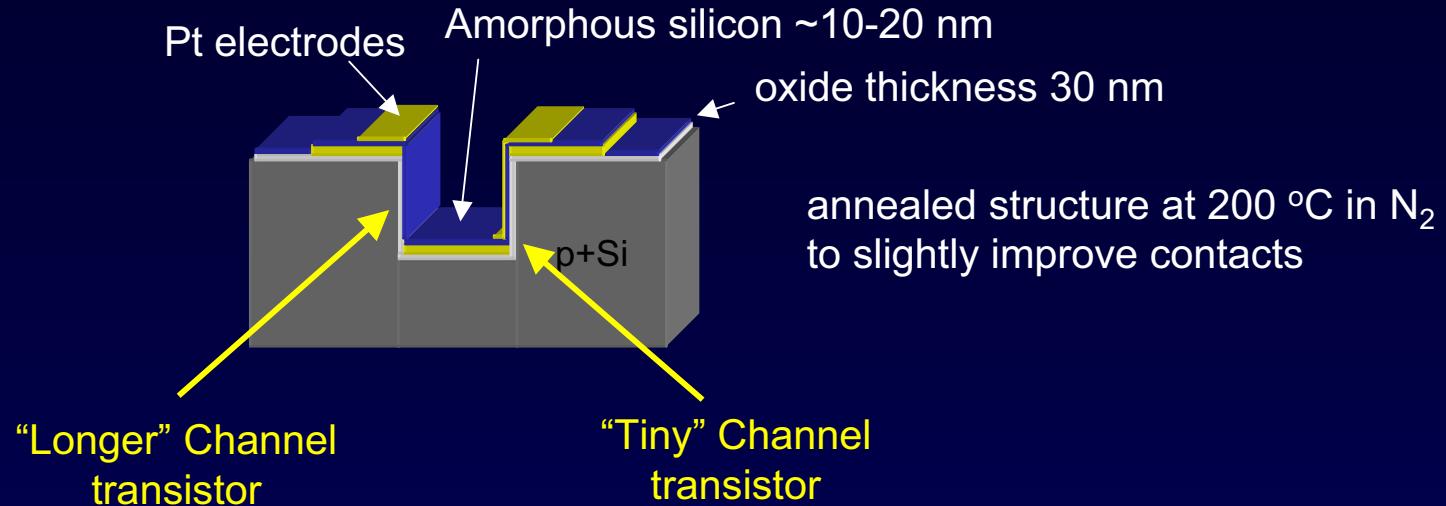
“Multilayer”

representative of ~1% of devices
solution for assembly allowed
to dry on surface

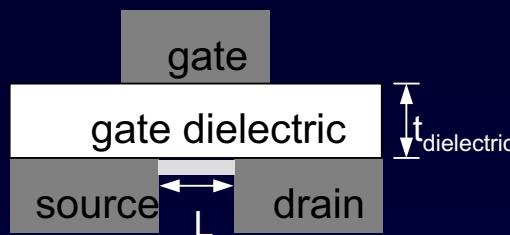
- Devices do not turn OFF
- No observed gate effect

Trench Structure with an Amorphous Silicon Channel

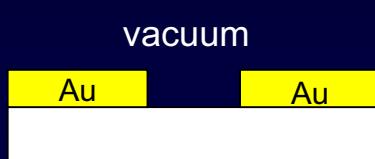
The Sanity Check



Key Requirements for Molecular Devices: The Off State

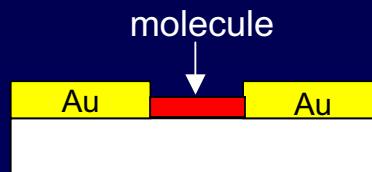


How small can L be?



$\phi_{\text{Au}} \sim 5 \text{ eV}$
assuming no
barrier lowering

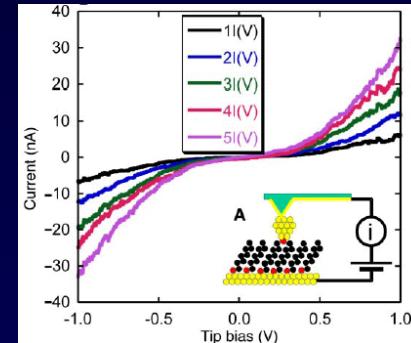
For $L = 1.2 \text{ nm}$, device area = $8 \times 10^6 \text{ \AA}^2$
At 0.5 V $I_{\text{tunneling}} \sim 5 \text{ nA}$



$I_{\text{tunneling}}$ higher

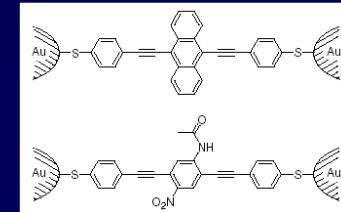
- If $E_{\text{HOMO}} - E_{\text{LUMO}} \sim 4 \text{ eV}$, $E_F - E_{\text{HOMO}} \sim 0.98 \text{ eV}$ I increase by $\sim 4.5 \times 10^6$
- hybridization typically creates finite density of molecular states at E_F [Lang, PRB (2001)]
- lowering of the workfunction of the metal electrodes

Conductive Probe AFM



At 0.5 V
 $I \sim 1 \text{ nA}$
[Lindsay group]

Break Junction Measurements



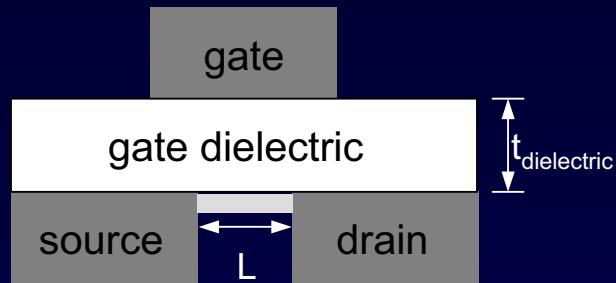
At 0.5 V
25- 200 nA

[Reichert et. al. PRL (2002)]
[Reed, Science (1997)]

- Design molecules $\gtrsim 2\text{-}3 \text{ nm long}$
- Tunnel barriers to tune coupling between molecule and electrode

Scaled to
device dimensions
 $I \sim \text{mA}$

Key Requirements for Molecular FETs: Gate Modulation of the Conductance



In Si MOSFETs,
 $L \gtrsim 1.5 t_{\text{dielectric}}$

to attain a gate field
not dominated
by the drain field

as described by Poisson's
equation

Scaling to Molecular Dimensions

$$t_{\text{dielectric}} \lesssim L$$

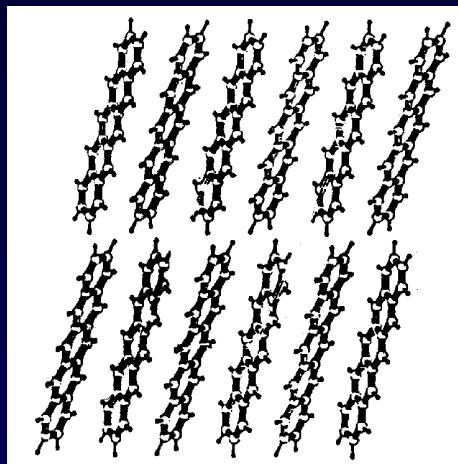
yet $t_{\text{dielectric}}$ cannot be leaky

even for an anisotropic molecule,
the component of the drain field in
the direction of the gate field
may dominate

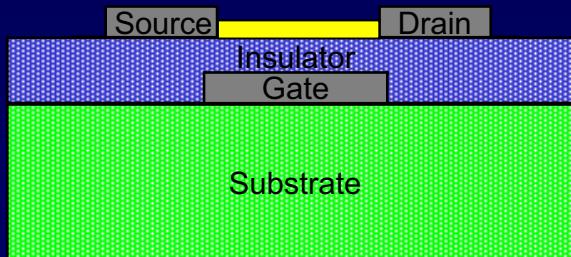
Many mechanisms for
molecular switching may
be envisioned but the device
electrostatics must work

Organic Thin Film Transistors

Intermolecular Charge
Transport

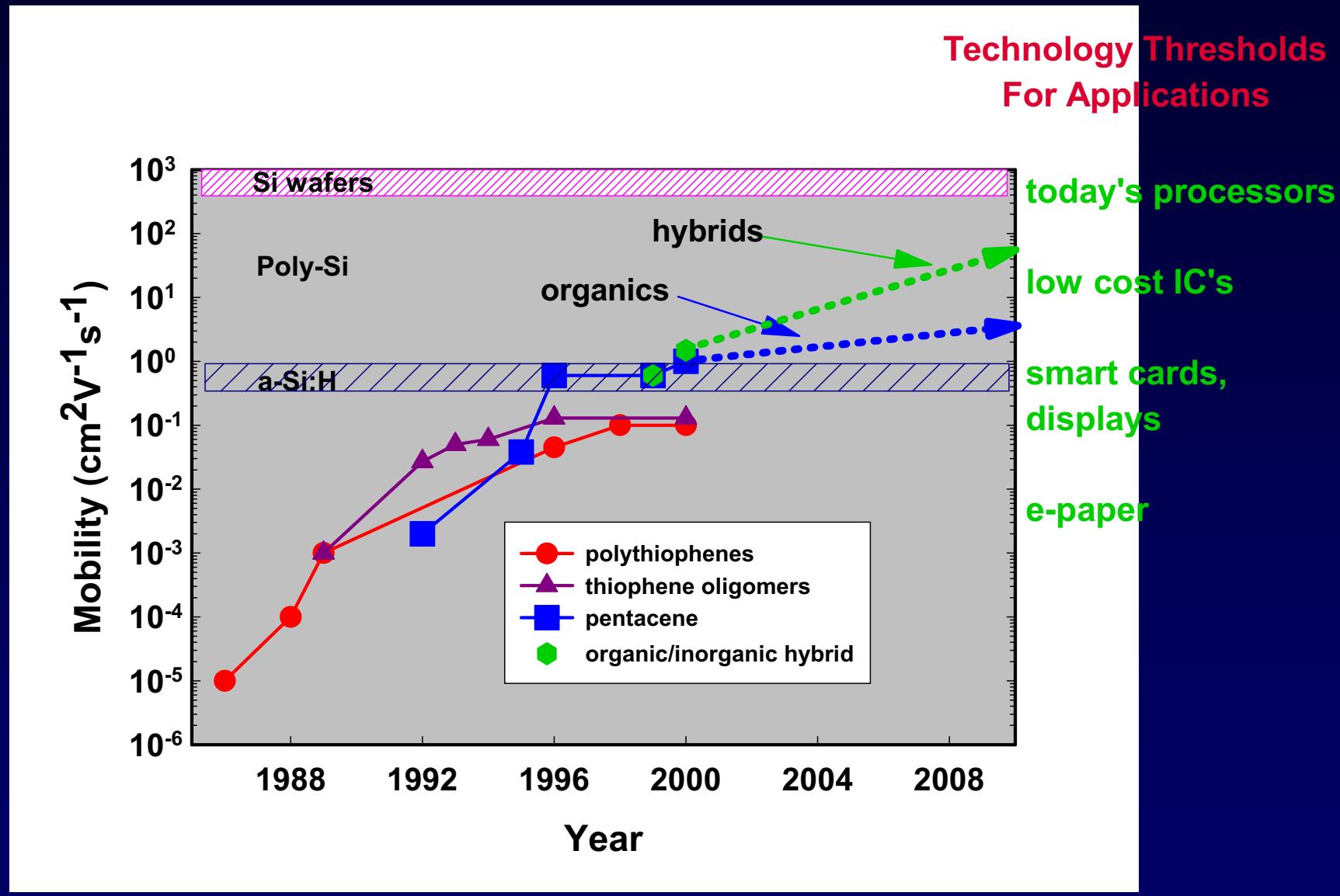


Collective property of
molecules



Channel Lengths ~ μm

Organic Semiconductor Performance Trends



Where New Materials May Impact Technology



Head-mounted
Display



IBM Watchpad



Palm Pilot



IBM ThinkPad



RFID Tags

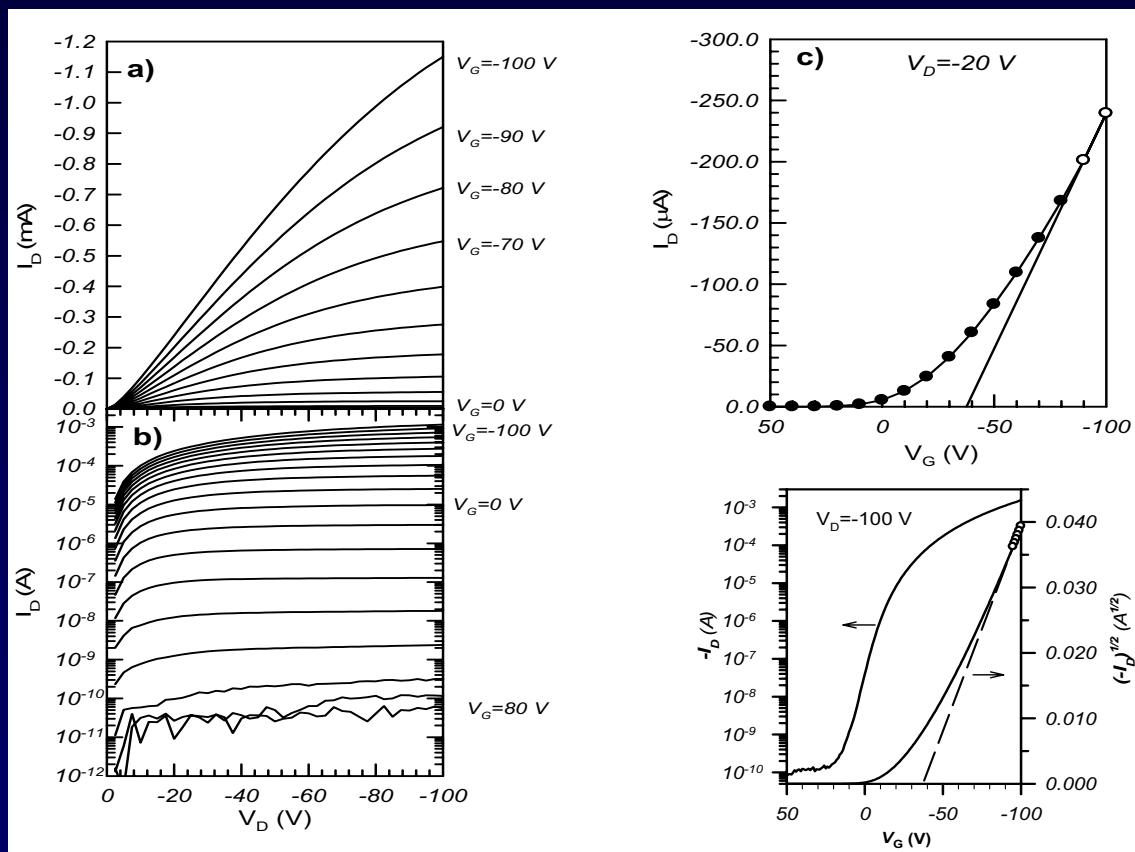


Smartcards



Electronic Newspaper
R. Steinbugler, IBM

Synthesis of a Pentacene precursor via Hetero Diels-Alder Reaction

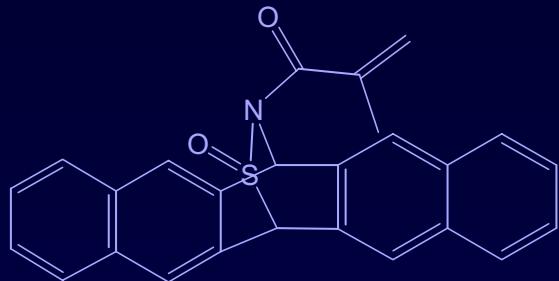


$$\mu_{\text{sat}} \sim 0.5 \text{ cm}^2/\text{V}\cdot\text{sec}$$

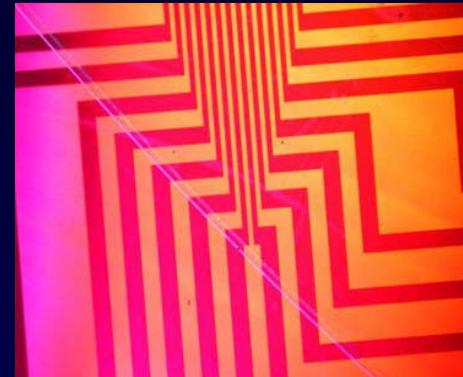
$$I_{\text{ON}}/I_{\text{OFF}} \sim 10^7$$

A. Afzali, C. D. Dimitrakopoulos, T. L. Breen, JACS **124**, 8812 (2002).

Device Stability of Photoimageable Pentacene Precursor

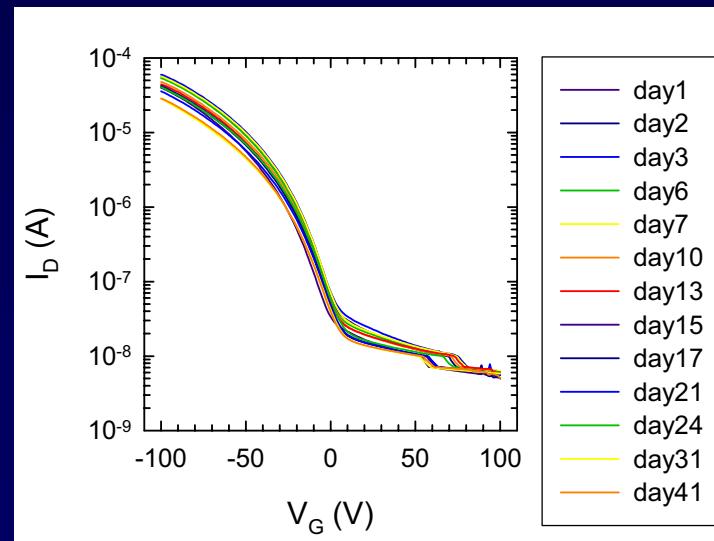
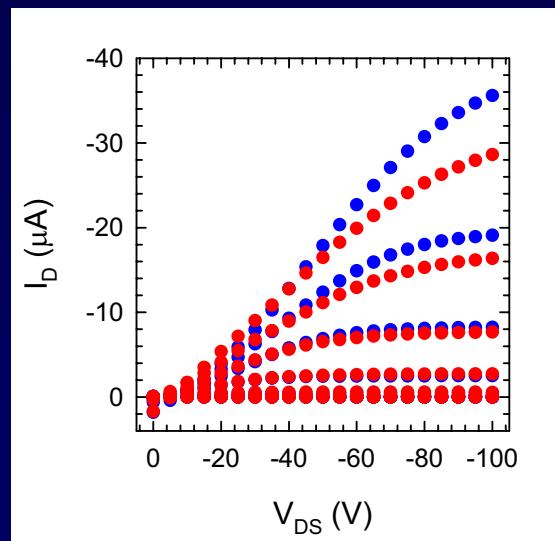


N-sulfinylmethylacrylamide
pentacene adduct



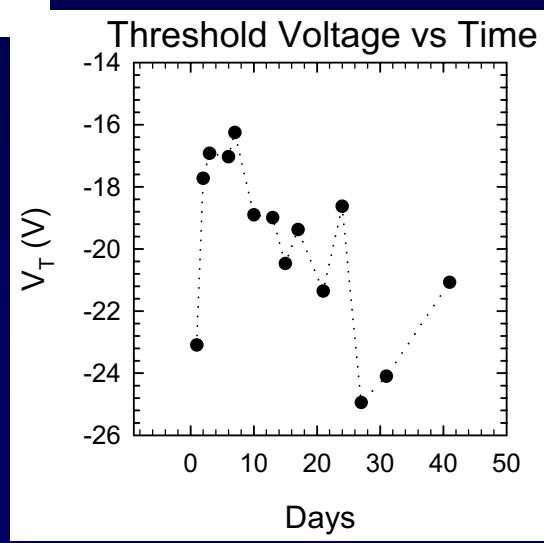
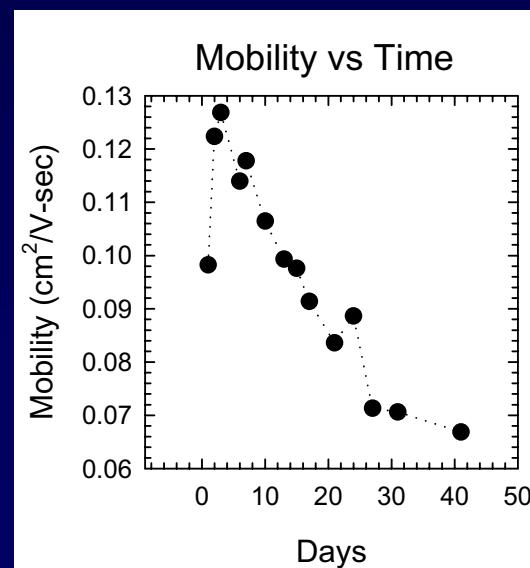
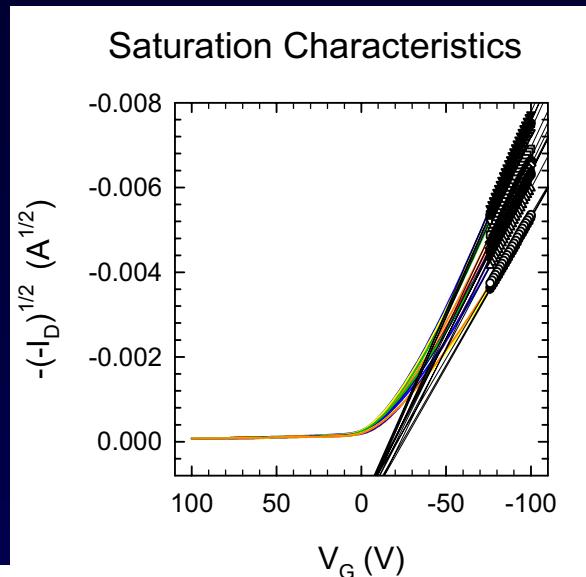
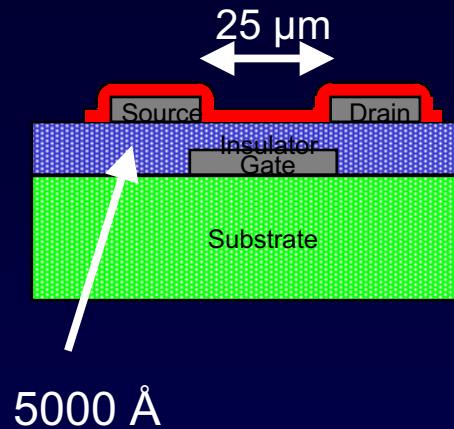
Photoimageable
precursor

A. Afzali, C. D. Dimitrakopoulos, T. O. Graham, Adv. Mat. (in press).



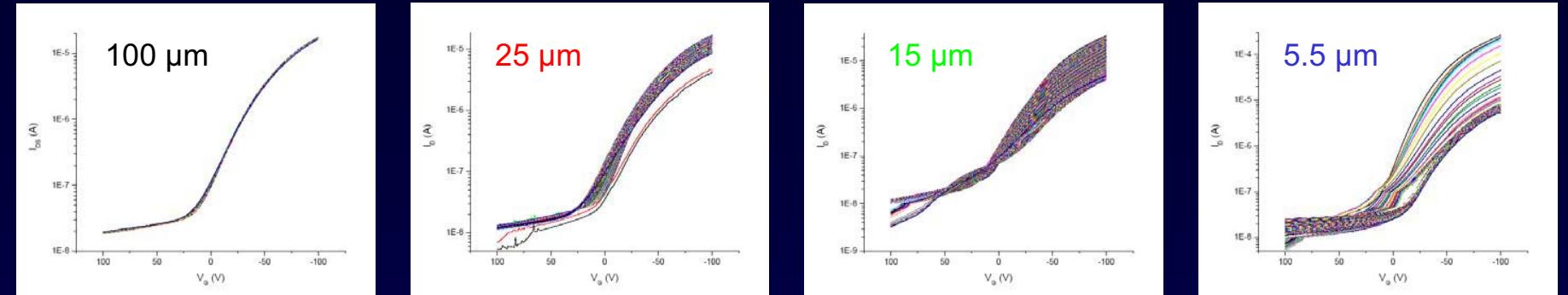
Device measured and stored in ambient

Important Device Characteristics Beyond Mobility and On-Off Ratio



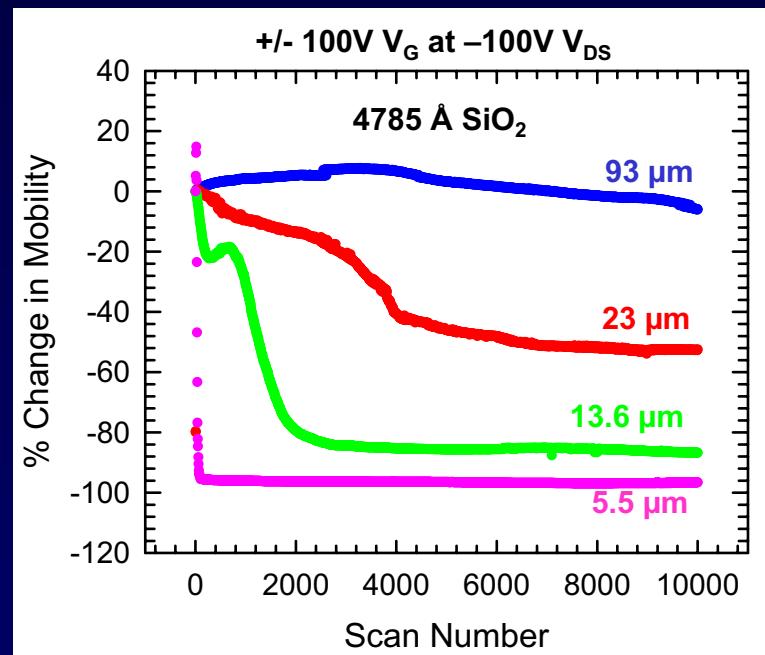
Cycling Devices

Channel Length Dependent Stability



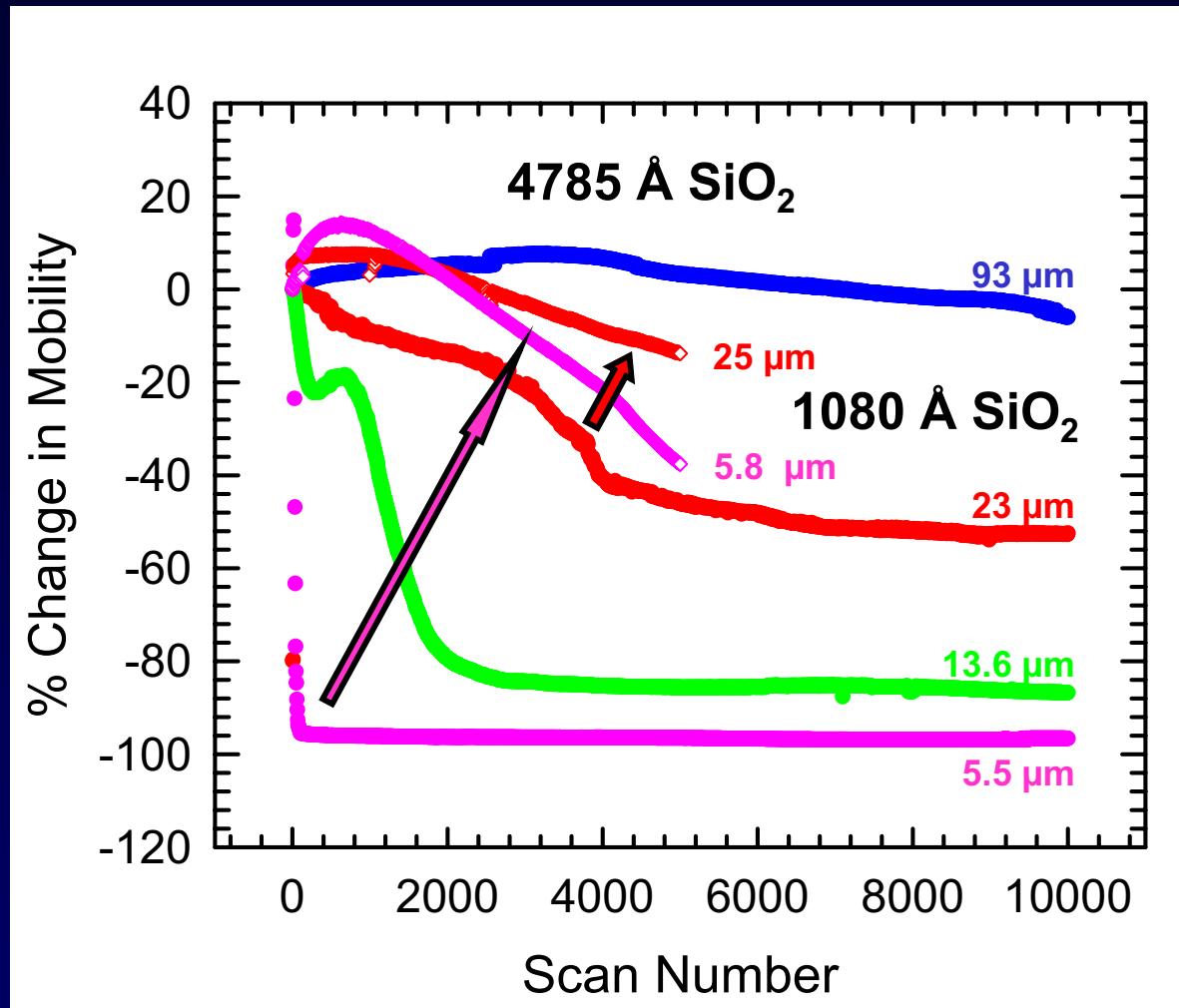
Cycle Devices 10001x

V_G +/- 100V @ -100 V V_{DS}



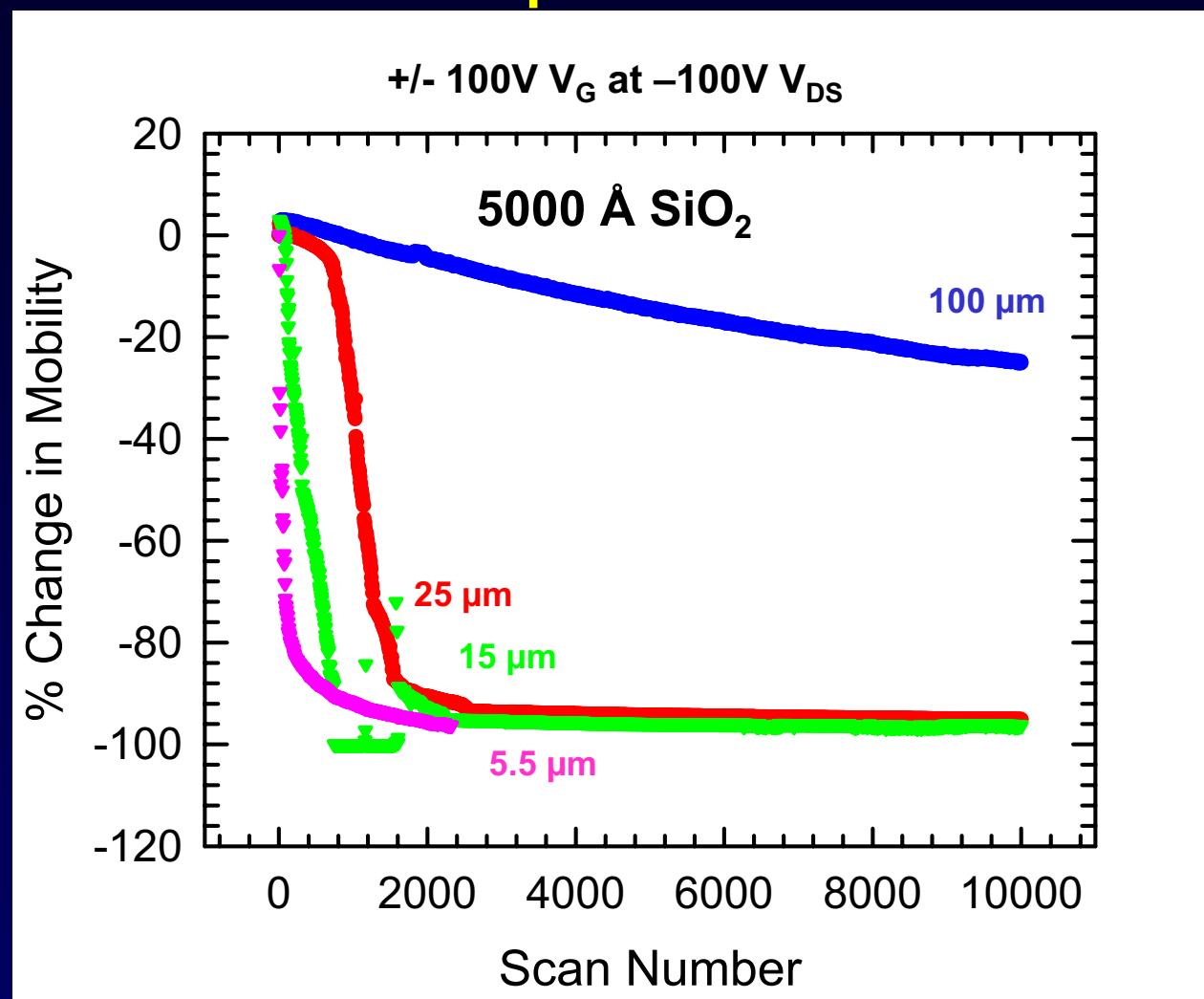
Mobility drops dramatically with decreasing channel length
Mobility varies between ~0.015-0.06 cm²/V-sec in these devices

Oxide Thickness Dependence of Carrier Mobility



Fields not perfectly scaled, but lower V reduces decay in device mobility

Vacuum Evaporated Pentacene

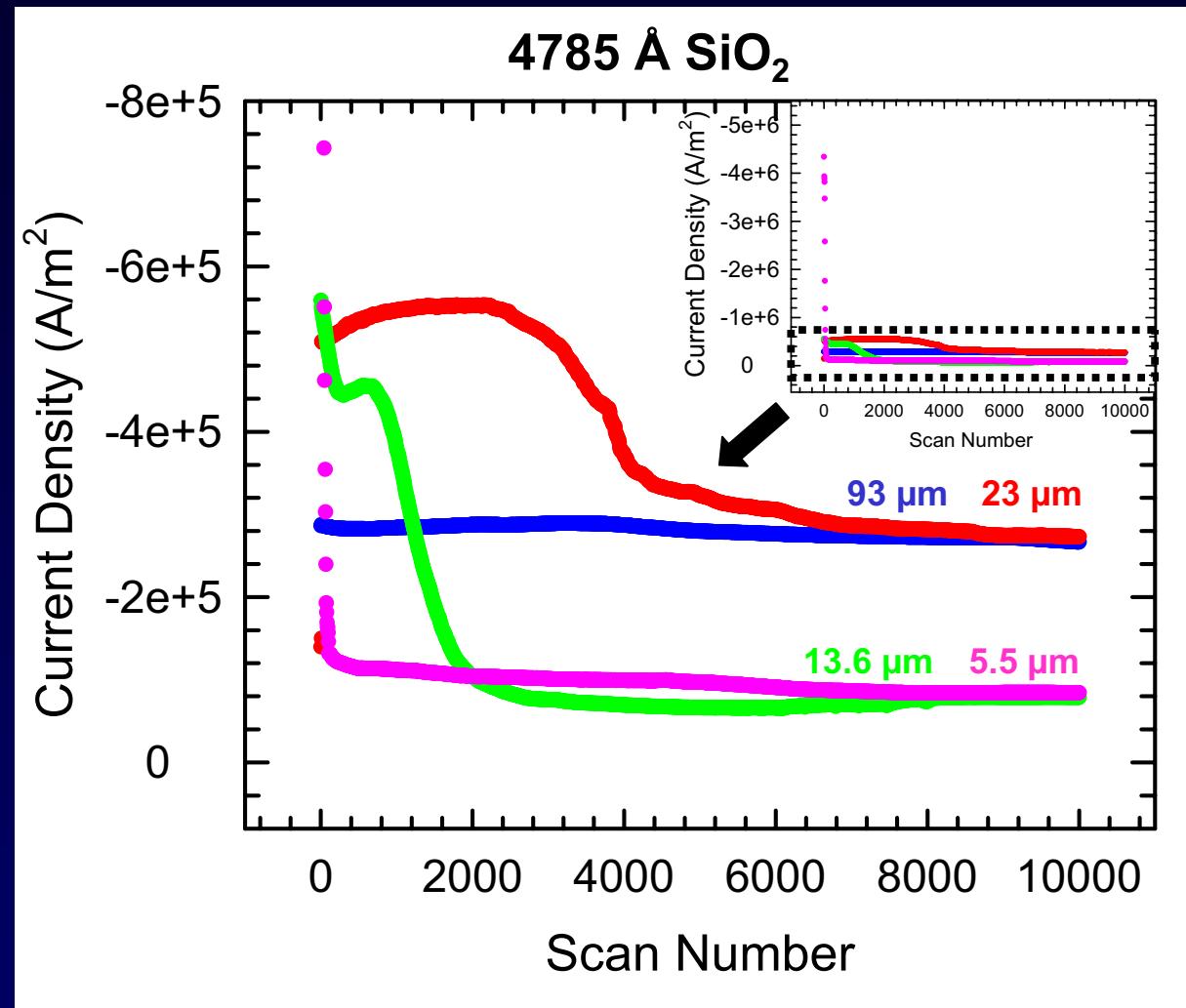


Mobility of solution deposited films 0.015-0.06 cm²/V-sec

Mobility of vacuum deposited film 0.6 cm²/V-sec

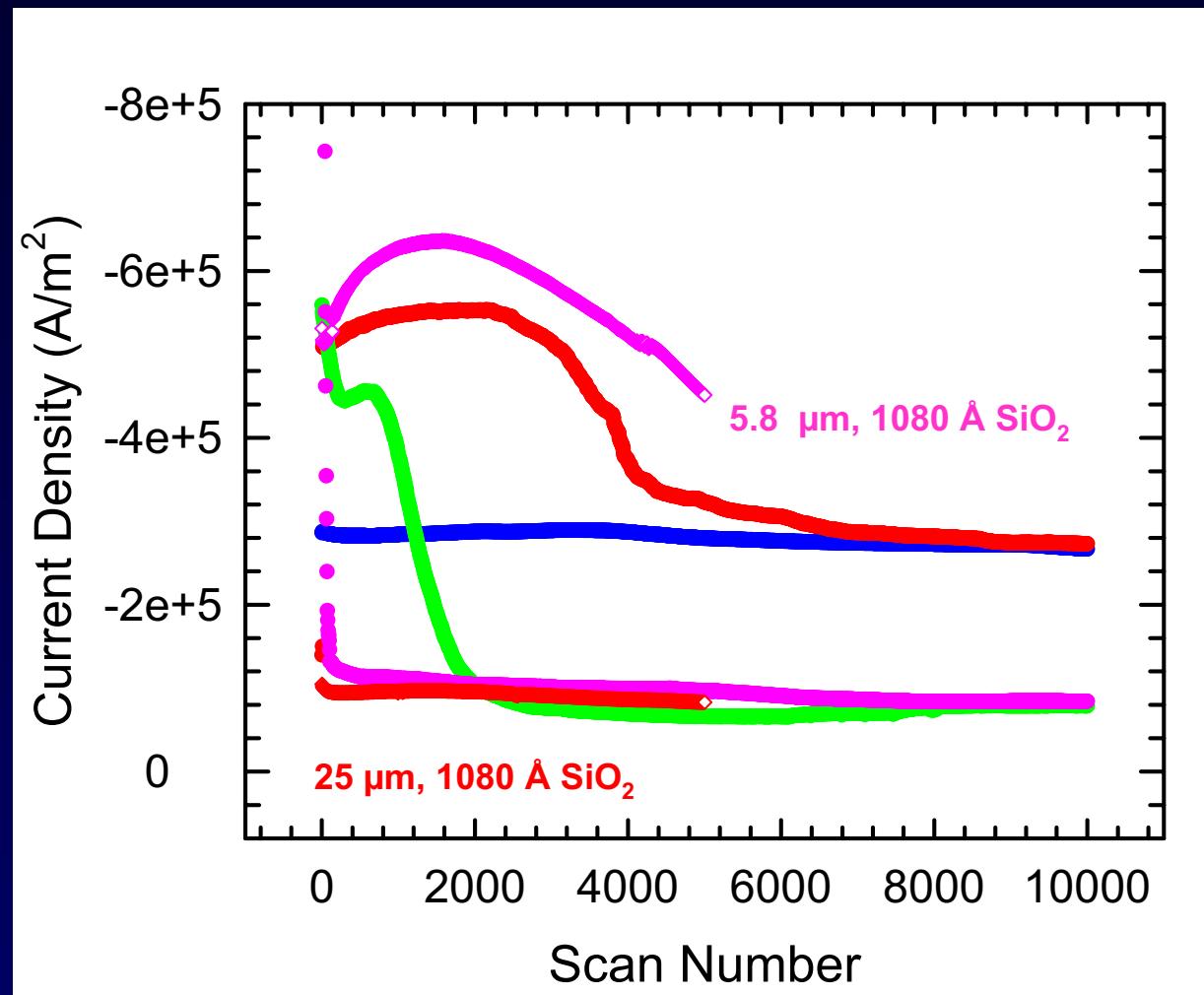
Vacuum deposited film less stable – power density limitation of evaporated film or
chemical stability/morphology of soluble precursor

Channel Length Dependent Current Density



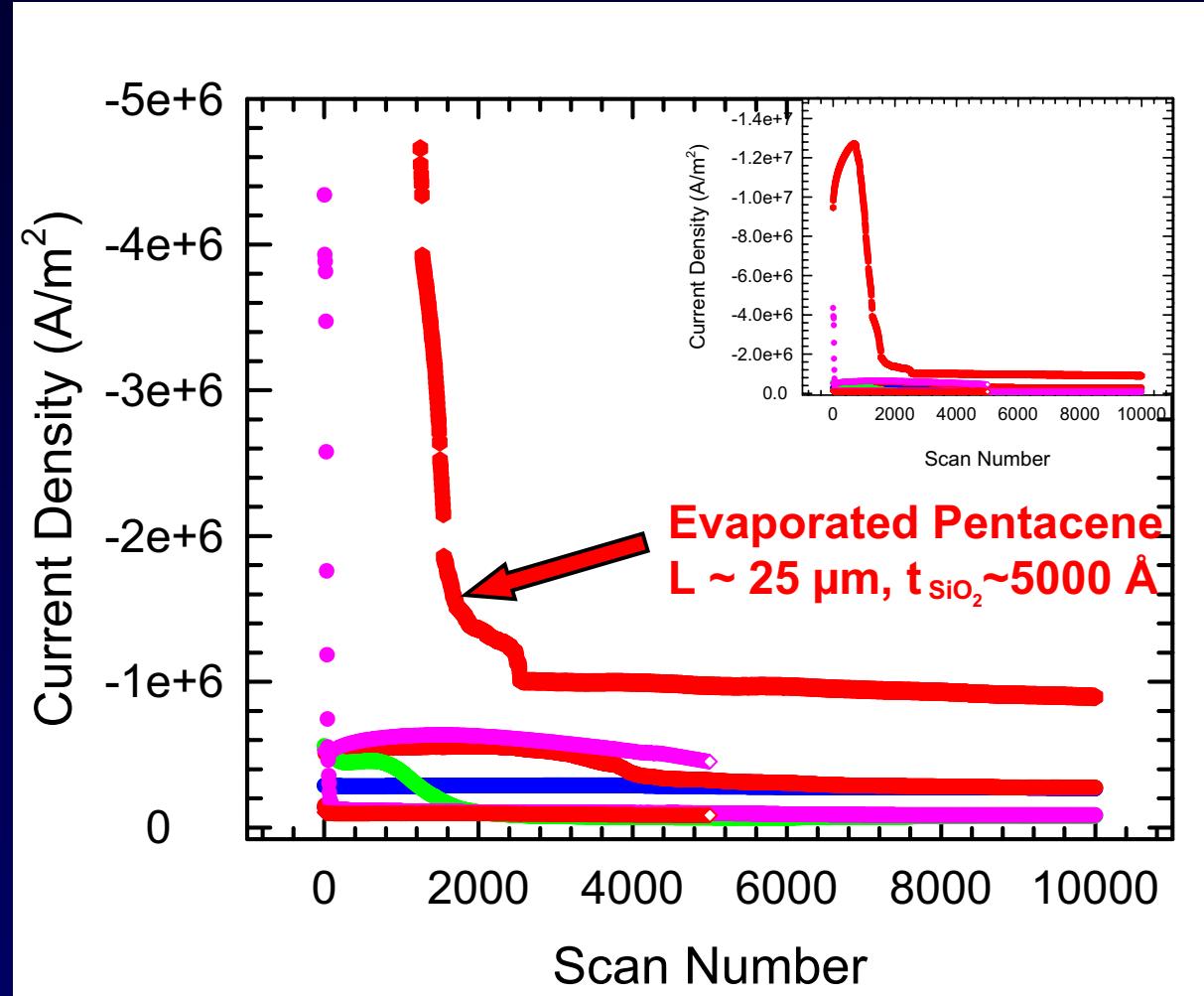
At same voltages (various source-drain fields), higher current densities not maintained
As number of scans increased current density drops and plateaus

Oxide Thickness Dependence of Current Density



At lower voltages, source-drain fields, device can maintain a higher current density
suggests stability is limited by power density and
scaling devices may be used to achieve desired current densities

Solution versus Vacuum Evaporated Pentacene Achievable Current Density



Evaporated film current density drops more dramatically,
but plateaus at high level